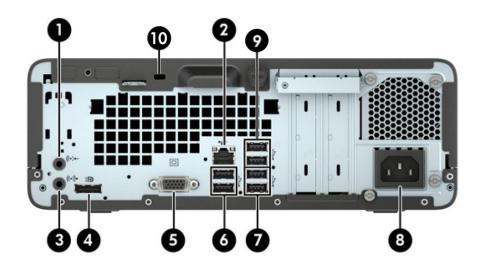
#### **HP ProDesk 400 G4 Small Form Factor Business PC**



- 1. Slim Optical Drive (optional)
- 2. SD card 3.0 reader (optional)
- 3. USB 3.1 Gen 1 port (5 Gbit/s data speed)
- 4. USB 3.1 Gen 1 port (5 Gbit/s data speed)

- 5. Universal Audio Jack with CTIA headset support
- 6. Hard drive activity light
- 7. Dual-state power button

#### **HP ProDesk 400 G4 Small Form Factor Business PC**



- Audio-in connector
- 2. RJ-45 (network) jack
- 3. Audio-out connector
- 4. Dual-Mode DisplayPort™ 1.2 (DP++) connector
- 5. VGA monitor connector

- 6. (2) USB 2.0 ports (black), allows for wake from S4/S5 with keyboard/mouse when connected and enabled in BIOS
- 7. (2) USB 3.1 Gen 1 ports (5 Gbit/s data speed)
- 8. Power cord connector
- 9. (2) USB 2.0 ports
- 10. Cable lock slot

NOTE: The serial port is no longer standard to the chassis. A serial port and PS/2 port PCIe combination are available.

#### **Not Shown**

Slots (1) PCI Express x16 graphics connector

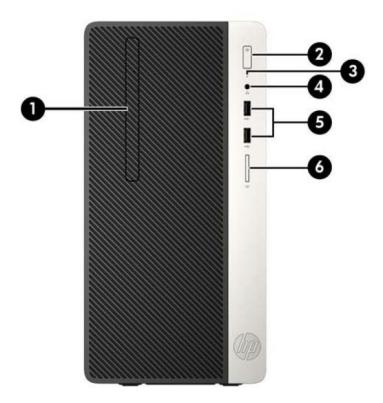
(1) PCI Express x4 graphics connector Internal M.2 PCIex1 connector for optional wireless NIC

Bays (1) 3.5" internal storage drive bay or 2.5" internal storage drive bay

(1) 9.5mm slim optical drive bay



#### HP ProDesk 400 G4 and 480 G4\* Microtower Business PC

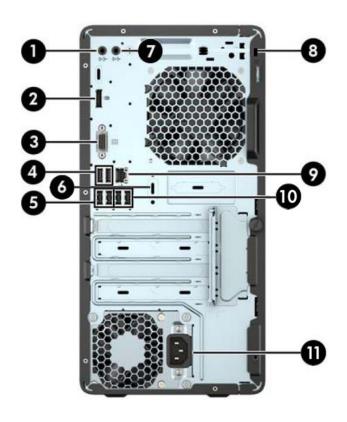


- 1. Slim Optical Drive (optional)
- 2. Dual-state power button
- 3. Hard drive activity light
- 4. Universal Audio Jack with CTIA headset support

\*480 G3 model not available in all regions.

- 5. (2) USB 3.1 Gen 1 ports (5 Gbit/s data speed)
- 6. SD card 3.0 reader (optional)

#### HP ProDesk 400 G4 and 480 G4\* Microtower Business PC



- 1. Audio-out connector
- 2. Dual-Mode DisplayPort™ 1.2 (DP++) connector
- 3. VGA monitor connector
- 4. (2) USB 2.0 ports (black), allows for wake from S4/S5 with keyboard/mouse when connected and enabled in BIOS
- 5. (2) USB 3.1 Gen 1 ports (5 Gbit/s data speed)
- 6. Optional serial port

- 7. Audio-in connector
- 8. Cable lock slot
- 9. RJ-45 (network) jack
- 10. (2) USB 2.0 ports
- 11. Power cord connector

NOTE: The serial port is no longer standard to the chassis. Single serial port or serial port plus PS/2 port combination is available from HP. PCA currently does not support more than one serial port add on card.
\*480 G3 model not available in all regions.

#### Not Shown

Slots (2) PCI Express x16 graphics connectors; one wired as an x4

(1) PCI Express x1 accessory connector

(1) internal M.2 PCIe x1 connector for optional wireless NIC

NOTE: 480 MT model will offer (1) PCI connector instead of (1) PCI Express x1 accessory connectors

Bays (1) 3.5" internal storage drive bay or 2.5" internal storage drive bay

(1) 3.5" internal storage drive bay

(1) 9.5mm internal optical drive bay



# HP ProDesk 400 G3 DM, HP ProDesk 400 G4 MT/SFF and HP ProOne 400 G3 Business Desktops PCs

Overview

### **AT A GLANCE**

- Choice of four form factors: Desktop Mini, Small Form Factor, Microtower and All-in-One (touch and non-touch configurations available)
- New commercial design on 400 G4 MT, 400 G4 SFF and 400 G3 DM
- HP-developed and engineered UEFI BIOS supporting security, manageability and software image stability
- H270 chipset supporting both Intel®7th generation Core™ processors and Intel® 6th generation Core™ processors
- Integrated Intel® HD Graphics; optional discrete graphics option available for MT and SFF form factors
- Processor support up to 65W for MT/SFF and up to 35W for Desktop Mini and AiO
- Realtek RTL8111 HSH GbE LOM Network Connection (standard)
- DDR4 Synchronous Dynamic Random Access Memory (SDRAM)
- Standard and high efficiency energy saving power supply options
- ENERGY STAR® certified models available
- EPEAT® Gold registered in the United States. Registration may vary by country. See http://www.epeat.net for registration status in your country.
- Arsenic-free
- Dust filter available for all platforms (except AiO)

NOTE: See important legal disclosures for all listed specs in their respective features sections.



## QuickSpecs

Overview

#### OPERATING SYSTEMS

#### **Preinstalled**

Windows 10 Pro 641

Windows 10 Pro 64 (National Academic License)3

Windows 10 Home 641

Windows 10 Home Single Language 641

Windows 7 Professional 64 (available through downgrade rights from Windows 10 Pro)<sup>2, 4</sup> Windows 7 Professional 32 (available through downgrade rights from Windows 10 Pro)<sup>2, 4</sup>

#### Pre-installed (other)

FreeDOS 2.0 NeoKylin Linux® 64<sup>5</sup>

#### **Web-supported only**

Windows 10 Enterprise 64<sup>1</sup> Windows 7 Enterprise 64<sup>4</sup>

- 1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.
- 2. This system is preinstalled with Windows 7 Pro software and also comes with a license and media for Windows 10 Pro software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.
- 3. Some devices for academic use will automatically be updated to Windows 10 Pro Education with the Windows 10 Anniversary Update. Features vary; see https://aka.ms/ProEducation for Windows 10 Pro Education feature information.
- 4. Only available with 6th generation (Intel) processors
- 5. Not available in all regions/countries.

#### **CHIPSET**

Intel® H270, Intel® B250 (Optional on 480 G4 MT)

## PROCESSORS\*, \*\*

\*NOTE: In accordance with Microsoft's support policy, HP does not support the Windows® 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows® 8 or Windows 7 drivers on http://www.support.hp.com

\*\*NOTE: Multi-Core is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering is not a measurement of higher performance.

Intel® 7th Generation Core™ i7 Processors	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT
<u>Intel® Core™ i7-7700 Processor</u> 65W			X	X	Х



# HP ProDesk 400 G3 DM, HP ProDesk 400 G4 MT/SFF and HP ProOne 400 G3 Business Desktops PCs

Up to 4.2 GHz Max. Turbo Frequency (3.6 GHz base frequency) 8 MB cache, 4 cores, 8 threads Intel® HD Graphics 630 Supports DDR4 memory up to 2400 MT/s data rate				
Intel® Core™ i7-7700T Processor 35W Up to 3.8 GHz Max. Turbo Frequency (2.9 GHz base frequency) 8 MB cache, 4 cores, 8 threads Intel® HD Graphics 630 Supports DDR4 memory up to 2400 MT/s data rate	х	х		

Intel® 7th Generation Core™ i5 Processors	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT
Intel® Core™ i5-7500 Processor			Х	Х	X
65W					
Up to 3.8 GHz Max. Turbo Frequency (3.4 GHz base frequency)					
6 MB cache, 4 cores, 4 threads					
Intel® HD Graphics 630					
Supports DDR4 memory up to 2400 MT/s data rate					
Intel® Core™ i5-7500T Processor	Х	X			
35W					
Up to 3.3 GHz Max. Turbo Frequency (2.7 GHz base frequency)					
6 MB cache, 4 cores, 4 threads					
Intel® HD Graphics 630					
Supports DDR4 memory up to 2400 MT/s data rate					
Intel® Core™ i5-7600 Processor			X	X	X
65W					
Up to 4.1 GHz Max. Turbo Frequency (3.5 GHz base frequency)					
6 MB cache, 4 cores, 4 threads					
Intel® HD Graphics 630					
Supports DDR4 memory up to 2400 MT/s data rate					
Intel® Core™ i5-7600T Processor	Х	X			
35W					
Up to 3.7 GHz Max. Turbo Frequency (2.8 GHz base frequency)					
6 MB cache, 4 cores, 4 threads					
Intel® HD Graphics 630					
Supports DDR4 memory up to 2400 MT/s data rate					

Intel® 7th Generation Core™ i3 Processors	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT
Intel® Core™ i3-7100 Processor			Х	Х	X
51W					
3.9 GHz base frequency					
3 MB cache, 2 cores, 4 threads					
Intel® HD Graphics 630					
Supports DDR4 memory up to 2400 MT/s data rate					
Intel® Core™ i3-7100T Processor	Х	Х			
35W					
3.4 GHz base frequency					
3 MB cache, 2 cores, 4 threads					
Intel® HD Graphics 630					
Supports DDR4 memory up to 2400 MT/s data rate					
Intel® Core™ i3-7300 Processor			Х	Х	X
51W					



## QuickSpecs

4.0 GHz base frequency 4 MB cache, 2 cores, 4 threads Intel® HD Graphics 630					
Supports DDR4 memory up to 2400 MT/s data rate					
Intel® Core™ i3-7300T Processor	X	X			
35W					
3.5 GHz base frequency					
4 MB cache, 2 cores, 4 threads					
Intel® HD Graphics 630					
Supports DDR4 memory up to 2400 MT/s data rate					
<u>Intel® Core™ i3-7320 Processor</u>			X	X	X
51W					
4.1GHz base frequency					
4 MB cache, 2 cores, 4 threads					
Intel® HD Graphics 630					
Supports DDR4 memory up to 2400 MT/s data rate					

Intel® 7th Generation Pentium® Processors	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT
Intel® Pentium® G4560 Processor			Х	Х	Х
54W					
3.5 GHz Base Frequency					
3 MB cache, 2 cores, 4 threads					
Intel® HD Graphics 610					
Supports DDR4 memory up to 2400 MT/s data rate					
Intel® Pentium® G4560T Processor	Х	X			
35W					
2.9 GHz Base Frequency					
3 MB cache, 2 cores, 4 threads					
Intel® HD Graphics 610					
Supports DDR4 memory up to 2400 MT/s data rate					
Intel® Pentium® G4600 Processor			Х	Х	Х
51W					
3.6 GHz Base Frequency					
3 MB cache, 2 cores, 4 threads					
Intel® HD Graphics 630					
Supports DDR4 memory up to 2400 MT/s data rate					
Intel® Pentium® G4600T Processor	Х	X			
35W					
3.0 GHz Base Frequency					
3 MB cache, 2 cores, 4 threads					
Intel® HD Graphics 630					
Supports DDR4 memory up to 2400 MT/s data rate					
Intel® Pentium® G4620 Processor			X	X	Х
51W					
3.7 GHz Base Frequency					
3 MB cache, 2 cores, 4 threads					
Intel® HD Graphics 630					
Supports DDR4 memory up to 2400 MT/s data rate					

Intel® 7th Generation Celeron® Processors	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT
Intel® Celeron ® G3930 Processor			Х	Х	Х
51W					



2.9 GHz Base Frequency 2 MB cache, 2 cores, 2 threads Intel® HD Graphics 610					
Supports DDR4 memory up to 2133 MT/s data rate					
Intel® Celeron ® G3930T Processor	Х	X			
35W					
2.7 GHz Base Frequency					
2 MB cache, 2 cores, 2 threads					
Intel® HD Graphics 610					
Supports DDR4 memory up to 2133 MT/s data rate					
Intel® Celeron ® G3950 Processor			X	Х	X
51W					
3.0 GHz Base Frequency					
2 MB cache, 2 cores, 2 threads					
Intel® HD Graphics 610					
Supports DDR4 memory up to 2133 MT/s data rate					

Intel® 6th Generation Core™ i7 Processors	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT
Intel® Core™ i7-6700 Processor			Х	Х	Х
65W					
Up to 4.0 GHz Max. Turbo Frequency (3.4 GHz base frequency)					
8 MB cache, 4 cores, 8 threads					
Intel® HD Graphics 530					
Supports DDR4 memory up to 2133 MT/s data rate					
Intel® Core™ i7-6700T Processor	Х	Х			
35W					
Up to 3.6 GHz Max. Turbo Frequency (2.8 GHz base frequency)					
8 MB cache, 4 cores, 8 threads					
Intel® HD Graphics 530					
Supports DDR4 memory up to 2133 MT/s data rate					

Intel® 6th Generation Core™ i5 Processors	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT
Intel® Core™ i5-6500 Processor			X	Х	X
65W					
Up to 3.6 GHz Max. Turbo Frequency (3.2 GHz base frequency)					
6 MB cache, 4 cores, 4 threads					
Intel® HD Graphics 530					
Supports DDR4 memory up to 2133 MT/s data rate					
<u>Intel® Core™ i5-6600T Processor</u>	X	X			
35W					
Up to 3.5 GHz Max. Turbo Frequency (2.7 GHz base frequency)					
6 MB cache, 4 cores, 4 threads					
Intel® HD Graphics 530					
Supports DDR4 memory up to 2133 MT/s data rate					
<u>Intel® Core™ i5-6500T Processor</u>	X	X			
35W					
Up to 3.1 GHz Max. Turbo Frequency (2.5 GHz base frequency)					
6 MB cache, 4 cores, 4 threads					
Intel® HD Graphics 530					
Supports DDR4 memory up to 2133 MT/s data rate					



Intel® 6th Generation Core™ i3 Processors	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT
Intel® Core™ i3-6100 Processor			Х	Х	X
51W					
3.7 GHz base frequency					
3 MB cache, 2 cores, 4 threads					
Intel® HD Graphics 530					
Supports DDR4 memory up to 2133 MT/s data rate					
Intel® Core™ i3-6100T Processor	Х	Х			
35W					
3.2 GHz base frequency					
3 MB cache, 2 cores, 4 threads					
Intel® HD Graphics 530					
Supports DDR4 memory up to 2133 MT/s data rate					

Intel® 6th Generation Pentium® Processors	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT
Intel® Pentium® G4500 Processor			Х	Х	Х
51W					
3.5 GHz Base Frequency					
3 MB cache, 2 cores, 2 threads					
Intel® HD Graphics 530					
Supports DDR4 memory up to 2133 MT/s data rate					
Intel® Pentium ® G4400 Processor			X	Х	Х
54W					
3.3 GHz Base Frequency					
3 MB cache, 2 cores, 2 threads					
Intel® HD Graphics 510					
Supports DDR4 memory up to 2133 MT/s data rate					
Intel® Pentium ® G4400T Processor	Х	Х			
35W					
2.9 GHz Base Frequency					
3 MB cache, 2 cores, 2 threads					
Intel® HD Graphics 510					
Supports DDR4 memory up to 2133 MT/s data rate					

Intel® 6th Generation Celeron® Processors	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT
Intel® Celeron ® G3900 Processor			Х	X	X
51W					
2.8 GHz Base Frequency					
2 MB cache, 2 cores, 2 threads					
Intel® HD Graphics 510					
Supports DDR4 memory up to 2133 MT/s data rate					
Intel® Celeron ® G3900T Processor	Х	Х			
35W					
2.6 GHz Base Frequency					
2 MB cache, 2 cores, 2 threads					
Intel® HD Graphics 510					
Supports DDR4 memory up to 2133 MT/s data rate					



#### **MEMORY\***

Form Factor	Туре	Maximum	Number of Slots
400 G3 DM	DDR4-2400 (Transfer rates up to 2400 MT/s)	32 GB	2 SODIMM
400 G3 AiO	DDR4-2400 (Transfer rates up to 2400 MT/s)	32 GB	2 SODIMM
400 G4 SFF	DDR4-2400 (Transfer rates up to 2400 MT/s)	32 GB	2 DIMM
400 G4 MT	DDR4-2400 (Transfer rates up to 2400 MT/s)	32 GB	2 DIMM
480 G4 MT	DDR4-2400 (Transfer rates up to 2400 MT/s)	32 GB	2 DIMM

#### Both slots are customer accessible / upgradeable.

- 2,048 MB (2048 MB x 1)
- 4,096 MB (4096 MB x 1)
- 8,192 MB (8192 MB x 1)
- 16,384 MB (16,384 MB x 1)

Memory modules support data transfer rates up to 2400 MT/s; actual data rate is determined by the system's configured processor. See processor specifications for supported memory data rate.

### **STORAGE\***

2.5 inch 7.2k RPM Hard Disk Drives	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT
1TB SATA	Х	Х	Х	Х	Х
500GB SATA	Χ	Х	Х	Х	Х
3.5" SATA 7.2k RPM Hard Disk Drives	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT
500GB 7200RPM 3.5in			Х	Х	Х
1TB 7200RPM 3.5in			X	Х	Х
2TB 7200RPM 3.5in			Х	Х	Х
2.5 inch Solid State Hybrid Drives (SSHD)	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT
1TB 5400RPM 2.5in 8GB Hybrid	Χ	Х	Х	Х	Х
500GB 5400RPM 2.5in 8GB Hybrid	Х	Х	Х	Х	Х
3.5 inch Solid State Hybrid Drives (SSHD)	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT
1TB 7200RPM 3.5in SSHD (SSHD)			Х	Х	Х
2.5 inch Self-encrypting Drives (SED HDD)	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT
500GB 7200RPM 2.5in SED 0PAL2	X	Х	Х	Х	Х
2.5 inch Self-encrypting Drives (SED SSD)	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT
256GB TLC SED SSD Opal 2 Drive	Х	Х	Х	Х	Х



<sup>\*</sup> Full availability of 4 GB or more of memory requires a 64-bit operating system. With Windows 32-bit operating systems, the amount of usable memory is dependent upon your configuration, so that above 3 GB all memory may not be available due to system resource requirements.

Standard Features and Configurable Components

512GB TLC SED SSD Opal 2 Drive	X	X	X	X	X

PCIe NMVe SSD Drives	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT
HP 256GB Turbo Drive G2 PCIe TLC SSD Drive	Х		Х	Х	Х
HP 512GB Turbo Drive G2 PCIe TLC SSD Drive	Х		Х	Х	Х
HP 1TB Turbo Drive G2 PCIe TLC SSD Drive	Х		Х	Х	Х
HP 256GB PCIe NVMe SSD Drive		Х			
HP 512GB PCIe NVMe SSD Drive		Х			
HP 128GB PCIe NVMe TLC SSD Drive	Χ				
HP 256GB PCIe NVMe TLC SSD Drive		Х			
HP 512GB PCIe NVMe TLC SSD Drive		Х			
HP 1TB PCIe NVMe TLC SSD Drive		Х			

2.5 SATA SSD Drives	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT
HP SATA 128GB SSD Drive	Х		Х	X	Х
HP SATA 256GB SSD Drive	Х		Х	Х	Х
HP 256GB TLC SSD Drive	Х	Х	Х	X	Х
HP 512GB TLC SSD Drive	Х	Х	Х	Х	Х

2.5 SATA SSD FIPS Drives	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT
HP 256GB FIPS SSD Drive		Х			
HP 512GB FIPS SSD Drive		Х			

<sup>\*</sup>For storage drives, GB = 1 billion bytes, TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30GB of system disk is reserved for system recovery software.

Optical Disc Drives	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT
HP 9.5mm G3 800/600/400 SFF G4 400 Microtower DVD-Writer*			Х	X	Х
HP 9.5mm G3 800/600/400 SFF G4 400 Microtower DVD-ROM			Х	Х	Х
HP 9.5mm ProOne AIO 400 G3 Ultra Slim DVD-Writer*		Х			
HP 9.5mm ProOne AIO 400 G3 Ultra Slim DVD-ROM		Х			

<sup>\*</sup>HD-DVD discs cannot be played on this drive. No support for DVD-RAM. Actual speeds may vary. Don't copy copyright-protected materials. Double Layer discs can store more data than single layer discs. Discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

Media Card Reader	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT
(Optional)* SD3 with 5-in-1 Interface			Х	Х	Х
from SD option to PCA is USB					



# HP ProDesk 400 G3 DM, HP ProDesk 400 G4 MT/SFF and HP ProOne 400 G3 Business Desktops PCs

Standard Features and Configurable Components

(Supports SD, SDXC, SDHC, UHS-I, UHS-II)			
(Standard)* SD3 with 4-in1 Interface (Supports SD, SDXC, SDHC, UHS-I)	Х		

<sup>\*</sup>Card sold separately



### **GRAPHICS**

System Integrated Graphics	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT
Intel® HD Graphics 530 (integrated on 6 <sup>th</sup> gen Core i7/i5/i3 processors)	Х	Х	Х	Х	Х
Intel® HD Graphics 630 (integrated on 7 <sup>th</sup> gen Core i7/i5/i3 processors and Pentium G4620, 4600, 4600T )	Х	Х	Х	Х	Х
Intel® HD Graphics 610 (integrated on Pentium G4560, G4560T, Celeron G3950, G3930, G3930T)	Х	Х	Х	Х	Х

### **Optional Discrete Graphics Solutions**

(optional and RX 460 device must be configured at

purchase)	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT
AMD Radeon™ R7 430 2GB LP 2DP PCIe x16 GF card			Х	Х	Х
AMD Radeon™ R7 450 4GB FH PCIe x16*				Х	Х
AMD Radeon™ RX 460 2GB FH PCIe x16*				Х	Х
NVIDIA® GeForce® GT730 1GB PCIe x8 HDMI			Х	Х	Х
NVIDIA® GeForce® GT730 2GB PCIe x8 DP			Χ	Х	Х

<sup>\*</sup>Requires 310W chassis

2 <sup>nd</sup> Graphics Cards	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT
AMD Radeon™ R7 450 4GB FH PCIe x16 G5 2 <sup>nd**</sup>				Х	Х
NVIDIA® GeForce® GT730 1GB PCIe x8 HDMI 2 <sup>nd***</sup>				Х	Х
NVIDIA® GeForce® GT730 2GB PCIe x8 DP 2nd****				Х	Х

<sup>\*\*</sup>Available only with AMD Radeon™ R7 450.

# DISPLAY (ALL-IN-ONE MODELS ONLY) WEBCAM & MIC (ALL-IN-ONE MODELS ONLY)

20" diagonal TN widescreen WLED backlit anti-glare LCD display

Orientation designed to operate in portrait or landscape mode (Additional stand or mount needed for AiO to be used in portrait mode.)

Non-touch or optional touch

Projected Capacitive Touch supports up to 10 touch-points

•		
Display Panel	Туре	TN WLED Backlit LCD
	Viewable image area (mm)	442.8 x 249.075
	Touch Active Area (mm)	442.8 x 249.075*
	Screen opening (mm)	444.8 x 251.2**
	Native Resolution (HxV)	1600 x 900
	Aspect ratio	16:9
	Pixel pitch (HxV)(mm)	0.276 x 0.276
	Contrast ratio (typical)	1000:1



<sup>\*\*\*</sup>Available only with NVIDIA® GeForce® GT730 1GB.

<sup>\*\*\*\*</sup>Available only with NVIDIA® GeForce® GT730 2GB

Standard Features and Configurable Components

Brightness (typical) Touch - 225nits (cd/m2)/ Non-Touch 250nits (cd/m2)

Viewing angle (typical) (HxV) 170° x 160°

Backlight lamp life (to half 30

brightness)

30,000 hours minimum

Color support Over 16 million colors

Color gamut (typical) 72%

Anti-glare Yes (non-touch model only)

Default color temperature Warm (6500K)
Response time 5 ms (max 10 ms)

\*With Projected Capacitive Touch Panel
\*\*Without Projected Capacitive Touch Panel

NOTE: All performance specifications represent the typical specifications provided by HP's

component manufacturers; actual performance may vary either higher or lower.

Easel Stand Tilt Angle +10° to +70°

Adjustable Height Stand: Vertical/Landscape 125 mm (±3 mm)

Adjustment

Tilt Angle  $-5^{\circ}$  to  $+20^{\circ}(\pm 3^{\circ})$  in landscape and portrait

Rotation 360° swivel and portrait or landscape orientation

## WEBCAM & MIC (ALL-IN-ONE MODELS ONLY)

Optional integrated 1 MP webcam & microphone; maximum resolution of 1280 x 720; up to 30 frames/sec

## **AUDIO/MULTIMEDIA**

	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT
Conexant CX20632 Audio Codec	X		Х	Х	Х
Conexant CX5001 codec		Х			
Headset* front connector (3.5mm)	Х		X	Х	Х
Headset side connector * (3.5mm)		X			
Headphone front connector (3.5mm)	Х				
Line-out and Line-In rear connectors* (3.5mm)			X	Х	Х
Multi-streaming capable**	Х	X	X	Х	Х
Internal speaker (standard)	Х		X	Х	X
High performance integrated stereo speakers		Х			

<sup>\*</sup>The DM, SFF, MT front headset connector supports CTIA style headsets. The AIO side headset connector supports both CTIA and OMTP style headsets. Headset connectors are retaskable to function as a Line-In, Microphone-In, Line-out or Headphone-out port. . External speakers must be powered externally.

<sup>\*\*</sup>Multi-streaming can be enabled in the audio control panel to allow independent audio streams to be sent to/from the separate connectors or internal speakers. This allows for different audio applications to use separate audio ports on the system. For



example, the front connector could be used with a headset for a communications application while the rear connector is being used with external speakers and a multimedia application.

## **NETWORKING/COMMUNICATIONS\***

Ethernet (RJ-45) Integrated	400 G3	400 G3	400 G4	400 G4	480 G4
	DM	AiO	SFF	MT	MT
Realtek RTL8111 HSH GbE LOM Network Connection (standard)	Х	Χ	Χ	Χ	Χ
Ethernet (RJ-45) Optional	400 G3	400 G3	400 G4	400 G4	480 G4
	DM	Ai0	SFF	MT	MT
Intel® Ethernet I210-T1 PCIe x1 Gb Network Interface Card (optional)			Х	Х	Х

Wireless LAN (optional and all except for 7265 for SFF/TWR must be bought at purchase)	400 G3 DM	400 G3 Ai0	400 G4 SFF	400 G4 MT	480 G4 MT
Intel® 7265 802.11AC 2x2 Wi-Fi +Bluetooth® M.2 Combo Card non-VPro	Х	Х	Х	Х	Х
Intel® 3168 802.11AC 2x2 Wi-Fi +Bluetooth® M.2 Combo Card non-VPro	Х	Χ	Χ	Х	Χ
Intel® 7260 802.11 a,b,g,n 2x2 M.2 Bluetooth® Disabled NIC**	Х				
Realtek RTL8723BE 802.11bgn 1x1 Wi-Fi + BT4.0 Combo Adapter	Х				

<sup>\*</sup> Wireless access point and Internet service required and not included. Availability of public wireless access points limited.

### **SLOTS**

	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT
Turbo Drive (M.2 PCIe)	1 ea. M.2 PCIe x1- 2230 (for WLAN) 1 ea. M.2 PCIe x4- 2280/2230 (for storage)	1 ea. M.2 PCIe x1- 2230 (for WLAN) 1 ea. M.2 PCIe x4- 2280/2230 (for storage)	1 ea. M.2 PCIe x1- 2230 (for WLAN)	1 ea. M.2 PCIe x1- 2230 (for WLAN)	1 ea. M.2 PCIe x1- 2230 (for WLAN)
PCI Express x1 (v3.0)	N/A	N/A	N/A	1 ea. 4.2" full height 6.6" length 10W max. power	N/A
PCI Express x 4 (v3.0)	N/A	N/A	1 ea. 2.5" low profile 6.6" length 35W max. power	N/A	N/A
PCI Express x16 (v3.0) (wired as a x4)	N/A	N/A	N/A	1 ea. 4.2" full height 6.6" length 35W max. power	1 ea. 4.2" full height 6.6" length 35W max. power



<sup>\*\*</sup>Wake on Lan feature is not available.

Standard Features and Configurable Components

PCI Express x16 (v3.0)	N/A		6.6" length	4.2" full height 6.6" length	1 ea. 4.2" full height 6.6" length 75W max. power
PCI	N/A	N/A	N/A		1 ea. 4.2" full height 6.6" length

### **PORTS**

#### I/O Ports - Standard

	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT
USB 2.0	2 (rear)	2 (rear)	4 (rear)	4 (rear)	4 (rear)
	2 (front) including 1 fast charging 2 (rear)	2 (side) including 1 fast charging, 2 (rear)	2 (front); 2 (rear)	2 (front); 2 (rear)	2 (front); 2 (rear)
USB Type-C™3.0 port	N/A	N/A	N/A	N/A	N/A
PS/2	N/A	Optional (see I/O Ports Optional below)	Optional (see I/O Ports Optional below)	Ports Optional	Optional (see I/O Ports Optional below)
Video	1* DisplayPort™ 1.2 1* port (choice of DisplayPort™ 1.2, HDMI or VGA)	1 DisplayPort™ 1.2	1DisplayPort™ 1.2; 1 VGA		1 DisplayPort™ 1.2; 1 VGA
Audio	Front: 1 Headset 1 Headphone	Side: 1 Headset	II · · · · · · · · · · · · · · · · · ·	Rear: 1 Audio-out	Front: 1 Headset; Rear: 1 Audio-out 1 Audio-in
Network Interface	RJ-45	RJ-45	RJ-45	RJ-45	RJ-45

I/O Ports – Optional	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT
Serial (RS-232)	1 standard; 1 optional*	N/A	N/A	1 (optional) (rear)	1 (optional) (rear)
Serial (RS-232) and PS/2 combination	N/A	1 (optional) (rear)	1 (optional)	1 (optional)	1 (optional)
HP PCIe x1 Parallel Port Card			1 (optional)	1 (optional)	

<sup>\*</sup>Replaces 1 of the optional video ports

#### I/O Ports — Internal

ports	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT
DM SATA storage connector	1	N/A	N/A	N/A	N/A



# HP ProDesk 400 G3 DM, HP ProDesk 400 G4 MT/SFF and HP ProOne 400 G3 Business Desktops PCs

Standard Features and Configurable Components

Internal SATA storage	N/A	2	2	3	3
connector(s)	17/1		_		



### **BAYS**

	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT
5.25" Half Height ODD	N/A	N/A	N/A	N/A	N/A
9mm Slim ODD	N/A	1 ea.	1 ea.	1 ea.	1 ea.
Secure Digital (SD) 3 Reader	N/A	1 ea.	1 ea.	1 ea.	1 ea.
2.5" internal storage drive	1 ea.	1 ea.	1 ea.*	1 ea.*	1 ea.*
3.5" internal storage drive	N/A	N/A	1 ea.*	2 ea.*	2 ea.*

<sup>\*</sup>SFF can be configured with either (1) 3.5" or (1) 2.5" internal storage drive; MT can be configured with either (2) 3.5" or (1) 3.5" and (1) 2.5" internal storage drive.

## **KEYBOARDS AND POINTING DEVICES**

Keyboards	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT
HP Conferencing Keyboard	Х	X	X	X	X
HP USB PS/2 Washable Keyboard*	Х	X	X	X	X
HP USB Business Slim CCID SmartCard Keyboard	Х	X	X	X	X
HP USB Business Slim Keyboard	Х	Х	Х	Х	Х
HP PS/2 Business Slim Keyboard		Х	Х	Х	Х
HP USB Business Slim Keyboard (China only)	Х	Х	Х	Х	Х
HP USB Business Slim Grey Keyboard	Х	Х	Х	Х	Х
HP USB Standalone Wired Keyboard		X			

Mice	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT
HP PS/2 Mouse*		X	Х	Х	X
HP USB 1000dpi Laser Mouse	X	X	X	X	X
HP Grey V2 Mouse	X	X	Х	Х	X
HP USB Mouse	Х	Х	Х	Х	Х
HP USB PS/2 Washable Mouse*	X	X	Х	Х	X
HP USB Mouse (China only)	X	X	Х	Х	X
HP USB Hardened Mouse	Х	Х	Х	Х	X
HP Antimicrobial USB Mouse		Х			

Combo	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT
HP Wireless Business Slim Keyboard and Mouse*	X	X	X	X	X
HP USB Keyboard and Mouse (China only)	X	X	X	X	X
HP USB Keyboard and Mouse Healthcare Edition		X			

Other 400 G3 DM 400 G3 AiO 400 G4 SFF 400 G4 MT 480 G4 MT



Standard Features and Configurable Components

HP Mouse Pad	Х	Х	Х	Х	Х
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<sup>\*</sup>Note Optional HP Internal Serial/PS/2 Ports is required to support this device.

## **ADAPTERS AND CABLES**

	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT
HP DisplayPort™ 1.2 Cable	Х	Х	X	Х	X
HP DisplayPort™ 1.2 to DVI-D Adapter	Х	Х	Х	Х	Х
HP DisplayPort™ 1.2 to HDMI 4K Adapter	Х	Х	Х	Х	Х
HP DisplayPort™ 1.2 to VGA Adapter	Х	Х	Х	X	Х
HP DVI Cable	Х	Х	Х	Х	Х
HP 700mm DisplayPort™ 1.2 Cable Kit	Х				
HP USB to Serial Port Adapter	Х	X			

## **AIO STANDS (OPTIONAL)**

	<u>DM</u>	<u>SFF</u>	<u>TWR</u>	<u>AiO</u>
HP 400 G3 AIO no stand (Ships with cosmetic VESA cover)				Х
HP 400 G3 AIO Adjustable Height Stand				Х
HP 400 G3 AIO Easel Stand				Х

### **DUST FILTERS**

	<u>DM</u>	<u>AiO</u>	<u>SFF</u>	<u>MT</u>
G3 600 SFF/ G4 SFF Dust Filter			Х	
HP G3 Mini Dust Filter	X			
G4 400 MT Dust Filter				Х

## **DESKTOP MINI ACCESSORIES (OPTIONAL)**

	<u>DM</u>	<u>AiO</u>	<u>SFF</u>	<u>MT</u>
HP Desktop Mini DVD-Writer ODD Expansion Module	Х			
HP Desktop Mini 500GB HDD/ I/O Expansion Module	Х			
HP Desktop Mini I/O Expansion Module	Х			
HP Desktop Mini Security/Dual VESA Sleeve	Х			
HP DM VESA Power Supply Holder	Х			
HP DM VESA Quick Deploy Adhesive	Х			
HP Desktop Mini Vertical Chassis Stand	Х			
HP Desktop Mini Port Cover Kit	Х			
HP Quick Release Bracket	Х			
HP DM Antenna/Wiring WLAN Kit	Х			



# HP ProDesk 400 G3 DM, HP ProDesk 400 G4 MT/SFF and HP ProOne 400 G3 Business Desktops PCs

Standard Features and Configurable Components

HP PC Mounting Bracket for Monitors	X		



Standard Features and Configurable Components

### SOFTWARE COMPONENTS AND APPLICATIONS WITH WINDOWS

#### BIOS

HP BIOSphere Gen3<sup>1</sup>
HP DriveLock | HP Automatic DriveLock
BIOS Update via Network
Master Boot Record Security
Power On Authentication
Secure Erase<sup>2</sup>
Absolute Persistence Module<sup>3</sup>
Pre-boot Authentication
HP LAN-WLAN Protection
HP Wireless Wakeup

#### Multi Media

CyberLink Power Media Player (select models only)
CyberLink Power2Go (select models only)

#### **Communication / Connectivity**

Native Miracast Support<sup>4</sup>

#### **HP Value Add Software**

HP ePrint Driver + JetAdvantage<sup>5</sup>
HP Hotkey Support - CMIT
HP Recovery Manager
HP Recovery Disc Creator (Windows 7 only)
HP Jumpstart
HP Support Assistant
HP Noise Cancellation Software
HP Velocity
HP Notifications

#### **3rd Party**

Foxit PhantomPDF Express for HP (Windows 7 only)

#### **Microsoft Products**

Buy Office Bing Search Skype<sup>6</sup>

#### Manageability

HP Driver Packs<sup>7</sup>
HP SoftPaq Download Manager (SDM)
HP System Software Manager (SSM)<sup>7</sup>
HP BIOS Config Utility (BCU)<sup>8</sup>
HP Client Catalog<sup>7</sup>
HP Manageability & Integration Kit (MIK)<sup>7</sup>
LANDESK Management<sup>8</sup>

For more information on HP Client Management Solutions refer to: http://www.hp.com/go/clientmanagement



# HP ProDesk 400 G3 DM, HP ProDesk 400 G4 MT/SFF and HP ProOne 400 G3 Business Desktops PCs

Standard Features and Configurable Components

#### **Client Security Software**

**HP Client Security** 

- HP Security Manager (including Credential Manager and Password Manager)
- HP Drive Lock
- HP Password Manager
- Absolute Persistence Module
- · Power On Authentication

Microsoft Security Essentials<sup>9</sup> (Windows 7 only) Microsoft Defender (Windows 10 only) HP WorkWise (requires Bluetooth®)<sup>10</sup>

#### Standard

Trusted Platform Module (TPM) 2.0 (Infineon SLB9670). Common Criteria EAL4+ Certified.

Downgradeable to TPM 1.2. Convertible to FIPS 140-2 Certified mode. (TPM 2.0 is not available for Win 7 32-bit.) Restrictions apply; contact your account manager for more details.

For more information on HP Client Security Software Suite, refer to http://www.hp.com/go/clientsecurity.

- 1 HP BIOSphere Gen 3 requires Intel® or AMD 7th generation processors.
- 2 For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88.
- 3 Absolute agent is shipped turned off, and will be activated when customers activate a purchased subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit: http://www.absolute.com/company/legal/agreements/ computrace-agreement. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software.
- 4 Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming media players that also support Miracast. You can use Miracast to share what you're doing on your PC and present a slide show. For more information:
- http://windows.microsoft.com/en-us/windows-8/project-wireless-screen-miracast
- 5 Requires an Internet connection to HP web-enabled printer and HP ePrint account registration (for a list of eligible printers, supported documents and image types and other HP ePrint details, see www.hp.com/go/eprintcenter). Print times and connection speeds may vary.
- 6 Skype is not offered in China.
- 7 Not preinstalled, however available for download at http://www.hp.com/go/clientmanagement
- 8 Subscription required.
- 9 Opt in and internet connection required for updates.
- 10 HP WorkWise smartphone app is available as a free download on the App Store and Google Play. Requires Windows 10 Build 1607 or higher).

#### **HP BIOS**

Key features of the HP BIOS include:

- Deployment and manageability HP BIOS provides several technologies that help integrate the Business PC into the enterprise, such as PXE, remote configuration, and F10 Setup support for 14 languages.
- Update your BIOS via the cloud or standardize on a BIOS version hosted on Enterprise network.
- Stability HP BIOS supports the HP stable product roadmap by releasing only critical BIOS changes to the factory and advanced change notification.
- UEFI specification 2.5
- Absolute Persistence agent For tracking and tracing services, available in select countries, separate software and purchase of a subscription is required.
- Thermal and power management The HP BIOS provides and enables thermal and power management technologies so component temperatures are managed for high reliability and to assist in operating the HP Business Desktop computer in any enterprise environment.



# HP ProDesk 400 G3 DM, HP ProDesk 400 G4 MT/SFF and HP ProOne 400 G3 Business Desktops PCs

Standard Features and Configurable Components

- Acoustic performance Industry leading acoustic emissions across the range of operating conditions.
- Serviceability HP BIOS provides diagnostic and detailed service information.
- Upgrades and recovery HP BIOS provides numerous ways to upgrade HP Business Desktop computers, including BIOS updates from within Windows (HPBIOSUPDREC), HP Client Manager, and fail-safe recovery. In addition, the HP BIOS Configuration Utility enables replication of BIOS settings within Windows while the Replicated Setup feature provides the same capability within F10 setup. The BIOS Configuration Utility is available from the support website.
- HP BIOS uses PKI signing of the BIOS for trusted BIOS upgrades and recovery.

#### Additional HP BIOS Features:

- Power-On password Helps prevent an unauthorized user from powering on the system.
- Administrator password Also known as the setup password, this helps prevent unauthorized changes to the system
  configuration. If the administrator password is not known, the BIOS version cannot be changed and changes cannot be
  made to BIOS settings using F10 setup or under the OS.
- Advanced Configuration and Power Interface (ACPI) Represents a significant innovation in power and configuration
  management, allowing operating systems and applications to manage power based on activity and usage. HP Pro
  models use ACPI to provide power conservation features.

S5 Max Power Savings setting supports EU Lot6 requirement and allows the computer to power down below 0.5W in S5 (when turned off). When S5 Max Power Savings feature is enabled below features are turned off:

- Power to slots
- Wake events other than power buttons (such as Wake on LAN)
- USB charging ports

#### HARDWARE SECURITY

SATA 0,1 port disablement (via BIOS)
Serial, USB enable/disable (via BIOS)
Hood Sensor for DM (integrated in the PCA, can be enabled/disabled through BIOS)
Support for chassis padlocks and cable lock devices



## **POWER SUPPLY**

	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT
Standard Efficiency	65W 89% average efficiency at 115Vac & 230Vac	90W active PFC 89%/230Vac & 88%/115Vac average efficiency			
80 PLUS Bronze	N/A	N/A	180W active PFC 82/85/82% efficient at 20/50/100% load(115V)	180W active PFC 82/85/82% efficient at 20/50/100% load(115V) 310W active PFC 82/85/82% efficient at 20/50/100% load(115V)	180W active PFC 82/85/82% efficient at 20/50/100% load(115V) 310W active PFC 82/85/82% efficient at 20/50/100% load(115V)
Operating Voltage Range	90 - 264VAC	90 - 264VAC	90 - 264VAC	90 - 264VAC	90 - 264VAC
Rated Voltage Range	100 - 240VAC	100 - 240VAC	100 - 240VAC	100 - 240VAC	100 - 240VAC
Rated Line Frequency	50 - 60HZ	50 - 60HZ	50 - 60HZ	50 - 60HZ	50 - 60HZ
Operating Line Frequency	47 - 63HZ	47 - 63HZ	47 - 63HZ	47 - 63HZ	47 - 63HZ
Rated Input Current	65W/1.6A 90W/1.4A	90W/1.4A	180W/2.3A	180W/2.3A 310W/4A	180W/2.3A 310W/4A
Rated Input Current with Energy Efficient* Power Supply	90W/1.4A	90W/1.4A	180W/2.3A	180W/2.3A 310W/4A	180W/2.3A 310W/4A
DC Output	+19.5V	+19.5V	+12V	+12V	+12V
Current Leakage (NFPA 99: 2102)	current at 120 Vac with the ground wire disconnected, as required for Non-patient Electrical Appliances and Equipment used in a patient care facility or that contact patients in normal use. Per section 10.3.5.1.	micro amps of leakage current at 120 Vac with the ground wire disconnected, as required for Non- patient Electrical Appliances and Equipment used in a patient care facility or that	Less than 500 micro amps of leakage current at 120 Vac with the ground wire disconnected, as required for Nonpatient Electrical Appliances and Equipment used in a patient care facility or that contact patients in normal use. Per section 10.3.5.1.  Less than 100 micro amps of leakage	Less than 500 micro amps of leakage current at 120 Vac with the ground wire disconnected, as required for Nonpatient Electrical Appliances and Equipment used in a patient care facility or that contact patients in normal use. Per section 10.3.5.1.	Less than 500 micro amps of leakage current at 120 Vac with the ground wire disconnected, as required for Nonpatient Electrical Appliances and Equipment used in a patient care facility or that contact patients in normal use. Per section 10.3.5.1.



Standard Features and Configurable Components

	current at 120 Vac with the ground wire intact with normal polarity, as required for Non-patient Electrical Appliances and Equipment used in a patient care facility or that contact patients in normal use. Per section 10.3.5.1.	micro amps of leakage current at 120 Vac with the ground wire intact with normal polarity, as required for Non- patient Electrical Appliances and Equipment used in	current at 120 Vac with the ground wire intact with normal polarity, as required for Non-patient Electrical Appliances and Equipment used in a patient care facility or that contact patients in normal use. Per section 10.3.5.1.	intact with normal polarity, as required for Non-patient	Less than 100 micro amps of leakage current at 120 Vac with the ground wire intact with normal polarity, as required for Non-patient Electrical Appliances and Equipment used in a patient care facility or that contact patients in normal use. Per section 10.3.5.1.
Power Supply Fan	N/A	N/A	70mm variable speed	70mm variable speed	70mm variable speed
Power cord length		6.0 ft. (1.83 m) (Power cord only)	6.0 ft. (1.83 m)	6.0 ft. (1.83 m)	6.0 ft. (1.83 m)
	External Power Adapt	er		_	
Dimensions	55x30x114mm (60W)	58x32x135 (90W)	N/A	N/A	N/A
Total Cord Length	6 ft	6 ft	N/A	N/A	N/A

<sup>\*</sup>High efficiency power supply is a requirement for ENERGY STAR® certification in conjunction with a select range of processors and modules

The harmonic input current requirements must be met under the following operating conditions:

Load Requirements: 50% and 100%

Input Voltage: 230Vac/50Hz.

For active power factor correction the power factor at 50% &100% loads shall be greater than 0.9 over the entire nominal input voltage range (100-127VAC and 200-240VAC).

Condition	Standard Efficiency	82/85/82%	85/88/85%	87/90/87%	90/92/89%	Input Voltage
10% of Rated Load	•	75%	81%	84%	84%	115Vac/60HZ
20% of Rated Load	-	82%	85%	87%	90%	115Vac/60HZ
50% of Rated Load	ı	85%	88%	90%	92%	115Vac/60HZ
50% of Rateu Load	PF>0.9	PF>0.9	PF>0.9	PF>0.9	PF>0.95	113Vac/60HZ
100% of Rated Load	70%	82%	85%	87%	89%	115Vac/60HZ
100% of Rateu Load	PF>0.9	PF>0.9	PF>0.9	PF>0.9	PF>0.9	230Vac/50HZ



### **WEIGHTS & DIMENSIONS**

(Configured with 2TB HDD, Wi-Fi card, graphics card)

(comigarea with ETB	wi-ri caru, graphics caru)				
	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT
Chassis (W x D x H)	6.97 x 6.88 x 1.35 in 177 x 174.7 x 34.2 mm	See table below.		6.69 x 10.79 x 13.3 in 170 x 274 x 338 mm	6.69 x 10.79 x 13.3 in 170 x 274 x 338 mm
System Volume	64 cu in 1.06 L		463 cu in 7.6 L	960 cu in 15.74 L	960 cu in 15.74 L
System Weight*	2.67 lb 1.21 kg		10.14 lb 4.6 kg	12.06 lb 5.47 kg	12.06 lb 5.47 kg
Max Supported Weight (desktop orientation)	N/A		77 lb 35 kg	77 lb 35 kg	77 lb 35 kg
Packaging (W x D x H)	9.1 x 19.6 x 5.7 in 497.8 x 144.8 x 231.1 mm		15.71 x 9.06 x 19.65 in 399 x 230 x 499 mm	15.35 x 11.73 x 19.65 x in 390 x 298 x 499 mm	15.35 x 11.73 x 19.65 x in 390 x 298 x 499 mm
Shipping Weight	6.1 lb 2.8 kg			20.26 lb. 9.2 kg	20.26 lb. 9.2 kg
Packaging (with Expansion Pack, W x D x H)	10.0 x 19.6 x 7.8 in 255 x 497.8 x 198 mm				
Multi-Unit Packaging (10 units)	20.28 x 16.54 x 25 in 515 x 420 x 636 mm				
Shipping Weight	68 lbs /31 kg				
Shipping Weight (fully loaded)	11.5 lbs / 5.22 kg				
Palletization Profile	20-units per layer 4 layer max 80-units per pallet Footprint-39.21 x 46.61 in (996 x 1184 mm)		10 layer max 60 per pallet 47.24 x 39.37 x 94.49 in (including	6-units per layer 7 layer max 42 per pallet 47.24 x 39.37 x 86.85 in (including pallet)	6-units per layer 7 layer max 42 per pallet 47.24 x 39.37 x 86.85 in (including pallet)
	Dependent on 40-Ft Stnd. Sea Container or 40-Ft High-cube Sea Container is used)				



### **ALL-IN-ONE WEIGHTS AND DIMENSIONS**

Weight with Touch Panel	Without Stand	With Easel Stand	With Adjustable Height Stand (without VESA cover)
System Weight	12.37 lb	13.85 lb	19.21 lb
	5.61 kg	6.282 kg	8.715 kg
Shipping Weight	17.085 lbs	18.55 lbs	26.31 lbs
	7.75 kg	8.42 kg	11.93 kg

Weight without Touch Panel	Without Stand	With Easel Stand	With Adjustable Height Stand (without VESA cover)
System Weight	12.16 lb	13.64 lb	19 lb
	5.514 kg	6,186 kg	8.619 kg
Shipping Weight	14.881 lbs	17.52 lbs	25.27 lbs
	6.75 kg	7.42 kg	11.46 kg

#### Dimensions (W x D x H)

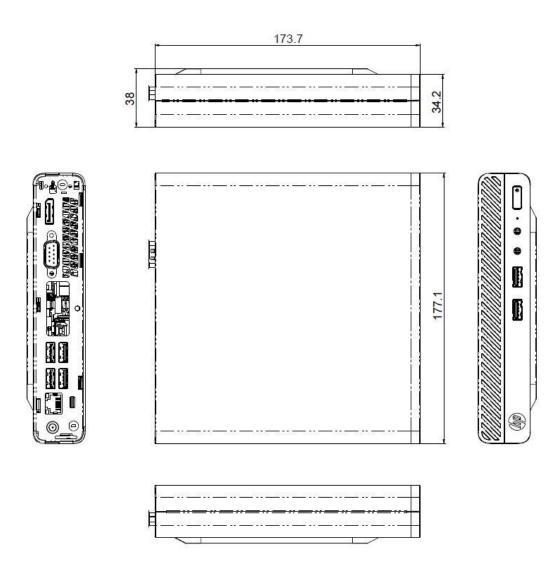
Product Dimensions	Without Stand 19.6 x 13.68 x 2.32 in 497.72 x 347.51 x 58.89 mm	Easel Stand 19.55 x 13.68 x 6.35 in 496.71 x 347.5 x 161.45 mm	Adjustable Height Stand (maximum) 19.55 x 21.707 x 8.27 in 496.71 x 551.373 x 209.95 mm
			Adjustable Height Stand (minimum) 19.55 x 15.217 x 8.27 in 496.71 x 386.53 mm

### **Shipping Dimensions**

Shipping Dimensions Boxed	Without Stand 22.72 x 7.36 x 17.80(H) in 577 x 187 x 452(H) mm	Easel Stand 22.72 x 7.36 x 17.80(H) in 577 x 187 x 452(H) mm	Adjustable Height Stand 22.83 x 11.50 x 18.31(H) in 580 x 292 x 465(H) mm
Shipping Dimensions Pallet	Without Stand (40 units) 48 x 40 x 76.89(H) in 1219 x 1016 x 1953(H) mm	Easel Stand (40 units) 48 x 40 x 76.89(H) in 1219 x 1016 x 1953(H) mm	Adjustable Height Stand (24 units) 48 x 40 x 78.94(H) in 1219 x 1016 x 2005(H) mm

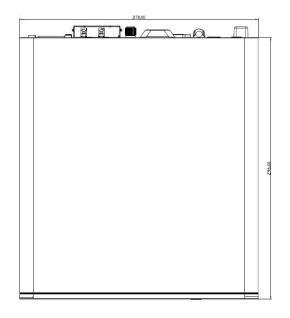


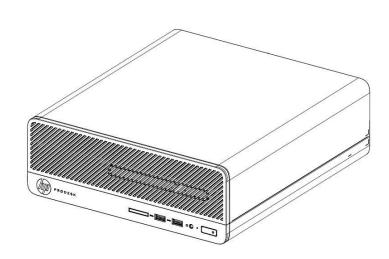
## **Desktop Mini Dimensions**

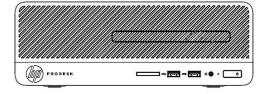


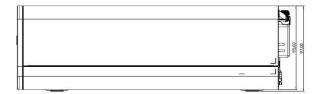


### **Small Form Factor Dimensions**

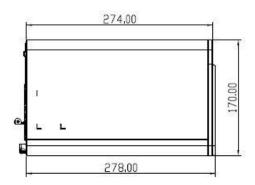


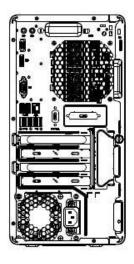


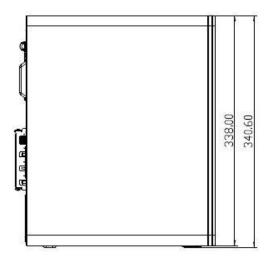


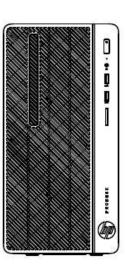


### **Mictrotower Dimensions**





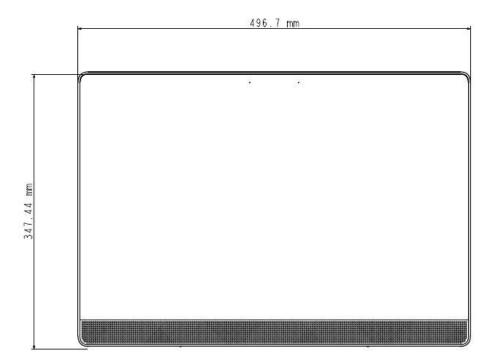




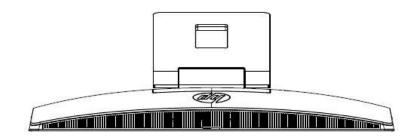
### All-in-One Touch Dimensions - No Stand

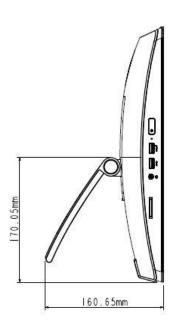


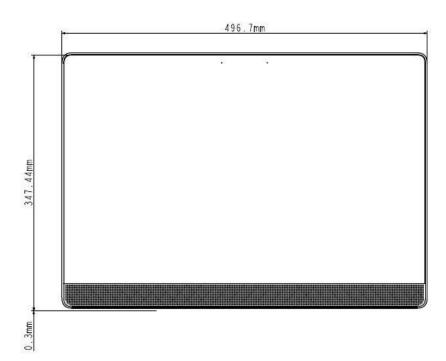




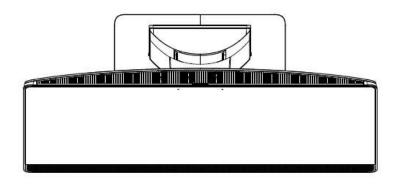
### All-in-One Touch Dimensions – Easel Stand

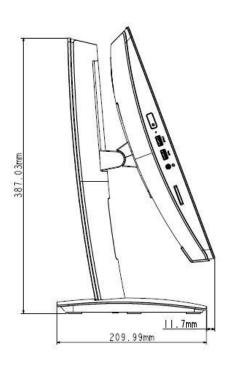


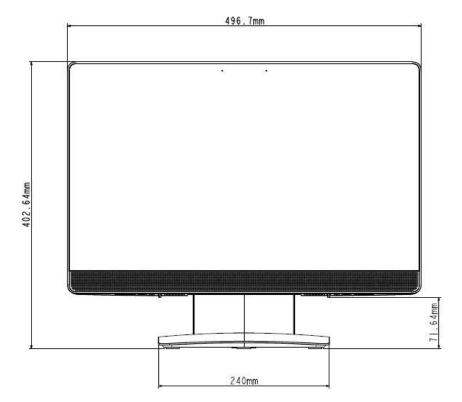




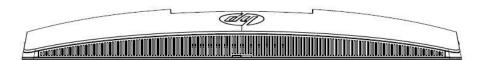
## All-in-One Touch Dimensions - Adjustable Stand



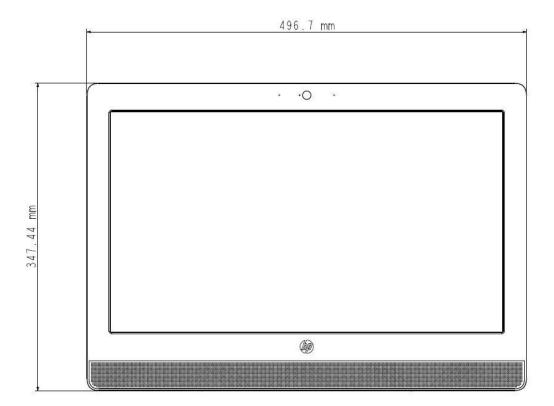




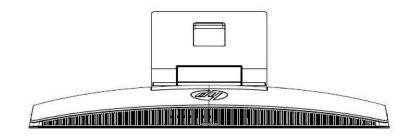
## All-in-One Non-Touch Dimensions - No Stand

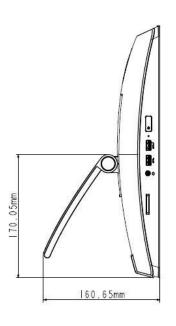


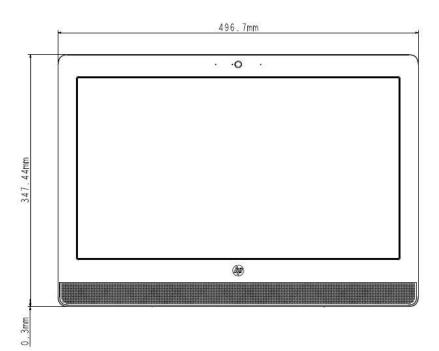




### All-in-One Non-Touch Dimensions – Easel Stand

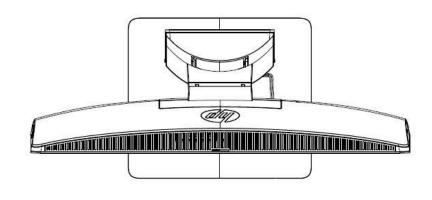


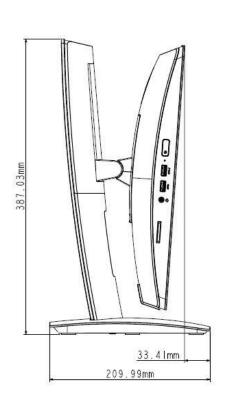


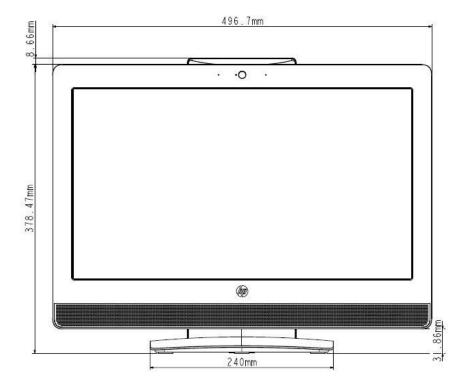


Standard Features and Configurable Components

#### All-in-One Non-Touch Dimensions - Adjustable Stand







Technical Specifications – Environmental

#### **ENVIRONMENTAL & INDUSTRY**

#### **HP EliteDesk 400 G4 Small Form Factor Business PC**

Eco-Label Certifications	This product has received or is in the process of being certified to the following approvals and may			
k declarations	be labeled with one or more of these marks:			
	IT ECO declaration			
	US ENERGY STAR®			
	<ul> <li>EPEAT<sup> </sup></li></ul>	the United States. Registration	varies by country. See	
		registration status in your coun		
System Configuration	The configuration used for the Ene	ergy Consumption and Declared I	Noise Emissions data for the	
	Desktop model is based on a typic		ard disk drive, a high efficiency	
	power supply, and a Microsoft Win	dows® operating system.		
inergy Consumption				
in accordance with US				
NERGY STAR® test				
nethod)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz	
Normal Operation (Short dle)	14.26 W	14.19 W	14.22 W	
Normal Operation (Long	13.31 W	13.03 W	13.28 W	
dle)				
Sleep	0.75 W	0.83 W	0.75 W	
Off	0.63 W	0.71 W	0.63 W	
	Note: Energy efficiency data listed is for family . HP computers marked with Environmental Protection Agency family does not offer ENERGY STA for a typically configured PC featu	h the ENERGY STAR® Logo are co (EPA) ENERGY STAR® specificatio R® compliant configurations, the ring a hard disk drive, a high effic	ompliant with the applicable U.S ons for computers. If a model en energy efficiency data listed i	
	Energy efficiency data listed is for family . HP computers marked wit Environmental Protection Agency family does not offer ENERGY STA	h the ENERGY STAR® Logo are co (EPA) ENERGY STAR® specificatio R® compliant configurations, the ring a hard disk drive, a high effic	ompliant with the applicable U.S ons for computers. If a model en energy efficiency data listed i	
	Energy efficiency data listed is for family . HP computers marked wit Environmental Protection Agency family does not offer ENERGY STA for a typically configured PC featu Microsoft Windows® operating sys	h the ENERGY STAR® Logo are co (EPA) ENERGY STAR® specificatio R® compliant configurations, the ring a hard disk drive, a high effic	ompliant with the applicable U.S ons for computers. If a model en energy efficiency data listed i	
Normal Operation (Short	Energy efficiency data listed is for family . HP computers marked wit Environmental Protection Agency family does not offer ENERGY STA for a typically configured PC featu Microsoft Windows® operating sys	h the ENERGY STAR® Logo are co (EPA) ENERGY STAR® specification R® compliant configurations, the ring a hard disk drive, a high effic stem.	ompliant with the applicable U.S ons for computers. If a model en energy efficiency data listed i ciency power supply, and a	
Normal Operation (Short dle) Normal Operation (Long	Energy efficiency data listed is for family . HP computers marked wit Environmental Protection Agency family does not offer ENERGY STA for a typically configured PC featu Microsoft Windows® operating sys	h the ENERGY STAR® Logo are co (EPA) ENERGY STAR® specification R® compliant configurations, the ring a hard disk drive, a high effic stem. 230VAC, 50Hz	ompliant with the applicable U.S ons for computers. If a model en energy efficiency data listed i ciency power supply, and a	
Normal Operation (Short dle) Normal Operation (Long dle)	Energy efficiency data listed is for family . HP computers marked with Environmental Protection Agency family does not offer ENERGY STA for a typically configured PC feature Microsoft Windows® operating systems of the state of	h the ENERGY STAR® Logo are co (EPA) ENERGY STAR® specification R® compliant configurations, the ring a hard disk drive, a high effic stem.  230VAC, 50Hz 49 BTU/hr	ompliant with the applicable U.S ons for computers. If a model en energy efficiency data listed i ciency power supply, and a 100VAC, 50Hz 49 BTU/hr	
Heat Dissipation* Normal Operation (Short dle) Normal Operation (Long dle) Sleep Off	Energy efficiency data listed is for family . HP computers marked with Environmental Protection Agency family does not offer ENERGY STA for a typically configured PC featur Microsoft Windows® operating sys	h the ENERGY STAR® Logo are co (EPA) ENERGY STAR® specifications, the R® compliant configurations, the ring a hard disk drive, a high efficient.  230VAC, 50Hz  49 BTU/hr	ompliant with the applicable U.S cons for computers. If a model en energy efficiency data listed i ciency power supply, and a  100VAC, 50Hz 49 BTU/hr  45 BTU/hr	
Normal Operation (Short dle) Normal Operation (Long dle) Sleep	Energy efficiency data listed is for family . HP computers marked with Environmental Protection Agency family does not offer ENERGY STA for a typically configured PC featur Microsoft Windows® operating syssems    115VAC, 60Hz 49 BTU/hr 46 BTU/hr	h the ENERGY STAR® Logo are co (EPA) ENERGY STAR® specifications, the R® compliant configurations, the ring a hard disk drive, a high efficient.  230VAC, 50Hz 49 BTU/hr 45 BTU/hr 2 BTU/hr	ompliant with the applicable U.S cons for computers. If a model en energy efficiency data listed i ciency power supply, and a  100VAC, 50Hz 49 BTU/hr 45 BTU/hr 2 BTU/hr	
Normal Operation (Short dle) Normal Operation (Long dle) Sleep Off	Energy efficiency data listed is for family . HP computers marked with Environmental Protection Agency family does not offer ENERGY STA for a typically configured PC featured Microsoft Windows® operating syssocial systems and syssocial syssocial syssocial syssocial syssocial syssocial syssocial syssocial syssocial systems and syssocial syssocial systems and systems are systems and systems and systems are systems are systems and systems are systems are systems and systems are systems and systems are systems are systems are systems.	h the ENERGY STAR® Logo are co (EPA) ENERGY STAR® specifications, the R® compliant configurations, the ring a hard disk drive, a high efficient.  230VAC, 50Hz 49 BTU/hr 45 BTU/hr 2 BTU/hr	ompliant with the applicable U.S cons for computers. If a model en energy efficiency data listed i ciency power supply, and a  100VAC, 50Hz 49 BTU/hr 45 BTU/hr 2 BTU/hr	
Normal Operation (Short dle) Normal Operation (Long dle) Sleep Off	Energy efficiency data listed is for family . HP computers marked with Environmental Protection Agency family does not offer ENERGY STA for a typically configured PC featur Microsoft Windows® operating system of the system of	h the ENERGY STAR® Logo are co (EPA) ENERGY STAR® specifications, the R® compliant configurations, the ring a hard disk drive, a high efficient.  230VAC, 50Hz 49 BTU/hr 45 BTU/hr 2 BTU/hr	empliant with the applicable U.S cons for computers. If a model en energy efficiency data listed i ciency power supply, and a  100VAC, 50Hz 49 BTU/hr 45 BTU/hr 2 BTU/hr s, assuming the service level is  Sound Pressure	
Normal Operation (Short dle) Normal Operation (Long dle) Sleep Off  Declared Noise Emissions in accordance with	Energy efficiency data listed is for family . HP computers marked with Environmental Protection Agency family does not offer ENERGY STA for a typically configured PC featur Microsoft Windows® operating system of the system of	h the ENERGY STAR® Logo are co (EPA) ENERGY STAR® specifications, the R® compliant configurations, the ring a hard disk drive, a high efficient.  230VAC, 50Hz 49 BTU/hr 45 BTU/hr 2 BTU/hr	ompliant with the applicable U.S cons for computers. If a model en energy efficiency data listed i ciency power supply, and a  100VAC, 50Hz 49 BTU/hr 45 BTU/hr 2 BTU/hr s, assuming the service level is	
Normal Operation (Short dle) Normal Operation (Long dle) Sleep Off  Declared Noise Emissions in accordance with SO 7779 and ISO 9296) Typically Configured —	Energy efficiency data listed is for family . HP computers marked with Environmental Protection Agency family does not offer ENERGY STA for a typically configured PC featur Microsoft Windows® operating system of the system of	h the ENERGY STAR® Logo are co (EPA) ENERGY STAR® specifications, the R® compliant configurations, the ring a hard disk drive, a high efficient.  230VAC, 50Hz 49 BTU/hr 45 BTU/hr 2 BTU/hr	empliant with the applicable U.S cons for computers. If a model en energy efficiency data listed i ciency power supply, and a  100VAC, 50Hz 49 BTU/hr 45 BTU/hr 2 BTU/hr s, assuming the service level is  Sound Pressure	
Normal Operation (Short dle) Normal Operation (Long dle) Sleep Off  Declared Noise Emissions	Energy efficiency data listed is for family . HP computers marked with Environmental Protection Agency family does not offer ENERGY STA for a typically configured PC featur Microsoft Windows® operating systems of the state of	h the ENERGY STAR® Logo are co (EPA) ENERGY STAR® specifications, the R® compliant configurations, the ring a hard disk drive, a high efficient.  230VAC, 50Hz 49 BTU/hr 45 BTU/hr 2 BTU/hr	empliant with the applicable U.S cons for computers. If a model en energy efficiency data listed i ciency power supply, and a  100VAC, 50Hz 49 BTU/hr 45 BTU/hr 2 BTU/hr s, assuming the service level is  Sound Pressure (L <sub>pAm</sub> , decibels)	



#### Technical Specifications – Environmental

	Batteries used in the product do not contain:     Mercury greater the1ppm by weight     Cadmium greater than 20ppm by weight  Battery size: CR2032 (coin cell)  Battery type: Lithium			
Additional Information	<ul> <li>This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC.</li> <li>This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.</li> <li>This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).</li> <li>This product is in compliance with the IEEE 1680 (EPEAT□) standard at the gold level, see www.epeat.net</li> <li>Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.</li> <li>This product contains 20.3% post-consumer recycled plastic (by wt.)</li> <li>This product is 92.7% recycle-able when properly disposed of at end of life.</li> </ul>			
Packaging Materials	External:	PAPER/Paper	990 g	
		PAPER/Paperboard	210 g	
	Internal:	PLASTIC/Polyethylene Expanded - EPE	121 g	
		PLASTIC/Polyethylene high density - HDPE	19 g	
	The Plastic p	backaging material is made from 80% recycled content		
		ackaging materials contains at least 80% recycled cont		
Material Usage	to the HP Ger			
	<ul> <li>Cert</li> <li>Cert</li> <li>Cadi</li> <li>Chlo</li> <li>Forr</li> <li>Halo</li> <li>Lead</li> <li>Lead</li> <li>Mere</li> <li>Nick</li> <li>hane</li> <li>Ozo</li> <li>Poly</li> <li>Poly</li> <li>Poly</li> <li>Poly</li> </ul>	to the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf):  Asbestos Certain Azo Colorants Certain Brominated Flame Retardants – may not be used as flame retardants in plastics Cadmium Chlorinated Hydrocarbons Chlorinated Paraffins Formaldehyde Halogenated Diphenyl Methanes Lead carbonates and sulfates Lead and Lead compounds Mercuric Oxide Batteries Nickel – finishes must not be used on the external surface designed to be frequently handled or carried by the user. Ozone Depleting Substances Polybrominated Biphenyls (PBBs) Polybrominated Biphenyl Ethers (PBBEs) Polybrominated Biphenyl Oxides (PBBOs)		



#### Technical Specifications – Environmental

	<ul> <li>Polyvinyl Chloride (PVC) – except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.</li> <li>Radioactive Substances</li> <li>Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)</li> </ul>
Packaging Usage	<ul> <li>HP follows these guidelines to decrease the environmental impact of product packaging:</li> <li>Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.</li> <li>Eliminate the use of ozone-depleting substances (ODS) in packaging materials.</li> <li>Design packaging materials for ease of disassembly.</li> <li>Maximize the use of post-consumer recycled content materials in packaging materials.</li> <li>Use readily recyclable packaging materials such as paper and corrugated materials.</li> <li>Reduce size and weight of packages to improve transportation fuel efficiency.</li> <li>Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.</li> </ul>
End-of-life Management and Recycling	Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: <a href="http://www.hp.com/go/reuse-recycle">http://www.hp.com/go/reuse-recycle</a> or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.  The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: <a href="http://www.hp.com/go/recyclers">http://www.hp.com/go/recyclers</a> .  These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.
HP, Inc. Corporate Environmental Information	For more information about HP's commitment to the environment:  Global Citizenship Report     http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html Eco-label certifications     http://www8.hp.com/us/en/hp-information/environment/ecolabels.html ISO 14001 certificates:     http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/PC_GBU_Product_Design_ISO_14K_Certificate.pdf     and     http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf

ENERGY STAR® certified models available

EPEAT® registered where applicable/supported. See <a href="http://www.epeat.net">http://www.epeat.net</a> for registration status by country.

TAA compliant models available



Technical Specifications – Environmental

#### **ENVIRONMENTAL DATA**

#### HP ProOne 400 G3 DM PC

Eco-Label Certifications	This product has received or is in the process of being certified to the following approvals and may				
k declarations	be labeled with one or more of these marks:				
	<ul> <li>IT ECO declaration</li> </ul>				
	US ENERGY STAR®				
			http://www.epeat.net for registration		
	status in your cou				
System Configuration	Desktop model is based or		eclared Noise Emissions data for the ring a hard disk drive, a high efficiency 1.		
Energy Consumption (in accordance with US ENERGY STAR® test	11FWAC 60H-	220MAC FOH-	10000 500-		
nethod)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz		
Normal Operation (Short dle)	8.56 W	9.25 W	8.78 W		
Normal Operation (Long dle)	7.70 W	8.08 W	7.88 W		
Sleep	1.16 W	1.22 W	1.19 W		
Off	0.85 W	0.90 W	0.96 W		
	family . HP computers mar Environmental Protection family does not offer ENER for a typically configured F	ked with the ENERGY STAR® Log Agency (EPA) ENERGY STAR® spo RGY STAR® compliant configurat PC featuring a hard disk drive, a l	liant product if offered within the mode to are compliant with the applicable U.S ecifications for computers. If a model ions, then energy efficiency data listed nigh efficiency power supply, and a		
	Energy efficiency data lister family . HP computers man Environmental Protection family does not offer ENEF for a typically configured F Microsoft Windows® opera	ked with the ENERGY STAR® Log Agency (EPA) ENERGY STAR® spo RGY STAR® compliant configurat PC featuring a hard disk drive, a l ting system.	o are compliant with the applicable U.S ecifications for computers. If a model ions, then energy efficiency data listed nigh efficiency power supply, and a		
	Energy efficiency data lister family . HP computers mare Environmental Protection family does not offer ENERF for a typically configured Form of Microsoft Windows® operations.	ked with the ENERGY STAR® Log Agency (EPA) ENERGY STAR® spo RGY STAR® compliant configurat PC featuring a hard disk drive, a l ting system.	o are compliant with the applicable U.S ecifications for computers. If a model ions, then energy efficiency data listed nigh efficiency power supply, and a		
Normal Operation (Short dle)	Energy efficiency data lister family . HP computers mare Environmental Protection family does not offer ENERF for a typically configured Form of Microsoft Windows® operations of the STAN STAN STAN STAN STAN STAN STAN STAN	ked with the ENERGY STAR® Log Agency (EPA) ENERGY STAR® spo AGY STAR® compliant configurat PC featuring a hard disk drive, a h ting system.  230VAC, 50Hz 32 BTU/hr	go are compliant with the applicable U.S ecifications for computers. If a model ions, then energy efficiency data listed nigh efficiency power supply, and a 100VAC, 50Hz 30 BTU/hr		
Normal Operation (Short dle) Normal Operation (Long dle)	Energy efficiency data liste family . HP computers mar Environmental Protection family does not offer ENER for a typically configured F Microsoft Windows® opera 115VAC, 60Hz 29 BTU/hr	ked with the ENERGY STAR® Log Agency (EPA) ENERGY STAR® spo AGY STAR® compliant configurat PC featuring a hard disk drive, a l ting system.  230VAC, 50Hz 32 BTU/hr 28 BTU/hr	o are compliant with the applicable U.S ecifications for computers. If a model ions, then energy efficiency data listed nigh efficiency power supply, and a		
Normal Operation (Short dle) Normal Operation (Long dle) Sleep	Energy efficiency data liste family . HP computers mar Environmental Protection family does not offer ENER for a typically configured F Microsoft Windows® opera 115VAC, 60Hz 29 BTU/hr 26 BTU/hr 4 BTU/hr	ked with the ENERGY STAR® Log Agency (EPA) ENERGY STAR® spo RGY STAR® compliant configurat PC featuring a hard disk drive, a l ting system.  230VAC, 50Hz 32 BTU/hr 28 BTU/hr	go are compliant with the applicable U.S ecifications for computers. If a model ions, then energy efficiency data listed nigh efficiency power supply, and a  100VAC, 50Hz 30 BTU/hr 27 BTU/hr		
Normal Operation (Short dle) Normal Operation (Long dle) Sleep	Energy efficiency data liste family . HP computers mar Environmental Protection family does not offer ENER for a typically configured F Microsoft Windows® opera 115VAC, 60Hz 29 BTU/hr	ked with the ENERGY STAR® Log Agency (EPA) ENERGY STAR® spo AGY STAR® compliant configurat PC featuring a hard disk drive, a l ting system.  230VAC, 50Hz 32 BTU/hr 28 BTU/hr	go are compliant with the applicable U.S ecifications for computers. If a model ions, then energy efficiency data listed high efficiency power supply, and a 100VAC, 50Hz 30 BTU/hr		
Normal Operation (Short dle) Normal Operation (Long dle) Sleep	Energy efficiency data lister family . HP computers mare Environmental Protection family does not offer ENER for a typically configured Foundation of Microsoft Windows® operation of the State of the S	Red with the ENERGY STAR® Log Agency (EPA) ENERGY STAR® spo RGY STAR® compliant configurate PC featuring a hard disk drive, a liting system.  230VAC, 50Hz 32 BTU/hr 28 BTU/hr 4 BTU/hr 3 BTU/hr	go are compliant with the applicable U.S ecifications for computers. If a model ions, then energy efficiency data listed nigh efficiency power supply, and a  100VAC, 50Hz 30 BTU/hr 27 BTU/hr		
Normal Operation (Short dle) Normal Operation (Long dle) Sleep Off	Energy efficiency data liste family . HP computers mar Environmental Protection family does not offer ENER for a typically configured F Microsoft Windows® opera 115VAC, 60Hz 29 BTU/hr 26 BTU/hr 4 BTU/hr 3 BTU/hr *NOTE: Heat dissipation is	ked with the ENERGY STAR® Log Agency (EPA) ENERGY STAR® spo Agency (EPA) ENERGY STAR® spo AGY STAR® compliant configurate C featuring a hard disk drive, a leading system.  230VAC, 50Hz  32 BTU/hr  28 BTU/hr  4 BTU/hr  3 BTU/hr  calculated based on the measur	go are compliant with the applicable U.S ecifications for computers. If a model ions, then energy efficiency data listed nigh efficiency power supply, and a  100VAC, 50Hz 30 BTU/hr 27 BTU/hr 4 BTU/hr 3 BTU/hr		
Normal Operation (Short dle) Normal Operation (Long dle) Sleep Off	Energy efficiency data liste family . HP computers mar Environmental Protection family does not offer ENER for a typically configured F Microsoft Windows® opera 29 BTU/hr 26 BTU/hr 4 BTU/hr 3 BTU/hr *NOTE: Heat dissipation is attained for one hour.	ked with the ENERGY STAR® Log Agency (EPA) ENERGY STAR® spo Agency (EPA) ENERGY STAR® spo AGY STAR® compliant configurate C featuring a hard disk drive, a leading system.  230VAC, 50Hz  32 BTU/hr  28 BTU/hr  4 BTU/hr  3 BTU/hr  calculated based on the measur	go are compliant with the applicable U.S ecifications for computers. If a model ions, then energy efficiency data listed nigh efficiency power supply, and a  100VAC, 50Hz 30 BTU/hr 27 BTU/hr 4 BTU/hr 3 BTU/hr ed watts, assuming the service level is		
Normal Operation (Short dle) Normal Operation (Long dle) Sleep Off  Declared Noise Emissions in accordance with	Energy efficiency data liste family . HP computers mar Environmental Protection family does not offer ENER for a typically configured F Microsoft Windows® opera  115VAC, 60Hz 29 BTU/hr 26 BTU/hr 4 BTU/hr 3 BTU/hr *NOTE: Heat dissipation is attained for one hour.	ked with the ENERGY STAR® Log Agency (EPA) ENERGY STAR® spo Agency (EPA) ENERGY STAR® spo AGY STAR® compliant configurate Of featuring a hard disk drive, a leading system.  230VAC, 50Hz  32 BTU/hr  28 BTU/hr  4 BTU/hr  3 BTU/hr  calculated based on the measur	go are compliant with the applicable U.S ecifications for computers. If a model ions, then energy efficiency data listed nigh efficiency power supply, and a  100VAC, 50Hz 30 BTU/hr 27 BTU/hr 4 BTU/hr 3 BTU/hr ed watts, assuming the service level is  Sound Pressure		
Heat Dissipation* Normal Operation (Short dle) Normal Operation (Long dle) Sleep Off  Declared Noise Emissions in accordance with SO 7779 and ISO 9296) Typically Configured — dle	Energy efficiency data liste family . HP computers mar Environmental Protection family does not offer ENER for a typically configured F Microsoft Windows® opera  115VAC, 60Hz 29 BTU/hr 26 BTU/hr 4 BTU/hr 3 BTU/hr *NOTE: Heat dissipation is attained for one hour.	ked with the ENERGY STAR® Log Agency (EPA) ENERGY STAR® spo Agency (EPA) ENERGY STAR® spo AGY STAR® compliant configurate Of featuring a hard disk drive, a leading system.  230VAC, 50Hz  32 BTU/hr  28 BTU/hr  4 BTU/hr  3 BTU/hr  calculated based on the measur	go are compliant with the applicable U.S ecifications for computers. If a model ions, then energy efficiency data listed nigh efficiency power supply, and a  100VAC, 50Hz 30 BTU/hr 27 BTU/hr 4 BTU/hr 3 BTU/hr ed watts, assuming the service level is  Sound Pressure		
Normal Operation (Short dle) Normal Operation (Long dle) Sleep Off  Declared Noise Emissions in accordance with SO 7779 and ISO 9296) Typically Configured —	Energy efficiency data liste family . HP computers mar Environmental Protection family does not offer ENER for a typically configured F Microsoft Windows® opera 115VAC, 60Hz 29 BTU/hr 26 BTU/hr 3 BTU/hr 3 BTU/hr *NOTE: Heat dissipation is attained for one hour.  Sound Power (LwAd, bels)	ked with the ENERGY STAR® Log Agency (EPA) ENERGY STAR® spo Agency (EPA) ENERGY STAR® spo AGY STAR® compliant configurate Of featuring a hard disk drive, a leading system.  230VAC, 50Hz  32 BTU/hr  28 BTU/hr  4 BTU/hr  3 BTU/hr  calculated based on the measur	go are compliant with the applicable U.S ecifications for computers. If a model ions, then energy efficiency data listed high efficiency power supply, and a  100VAC, 50Hz 30 BTU/hr 27 BTU/hr 4 BTU/hr 3 BTU/hr ed watts, assuming the service level is  Sound Pressure (LpAm, decibels)		



Technical Specifications – Environmental

	<ul> <li>6 USB ports</li> <li>2 memory slots</li> <li>1 Mini PCIe half-length slot</li> <li>1 MXM 3.0 Type A - 35W slot</li> <li>1 mSATA slot</li> <li>1 2.5" internal bay supporting up to Two 2.5" hard drives (HDD/SSD/SED/SSHD)</li> <li>1 5.25" external supporting optical drive</li> </ul> Spare parts are available throughout the warranty period and or for up to "5" years after the end of production.		
Batteries	This battery(s) in this product comply with EU Directive 2006/66/EC		
	Batteries used in the product do not contain:     Mercury greater the1ppm by weight     Cadmium greater than 20ppm by weight  Battery size: CR2032 (coin cell) Battery type: Lithium		
Additional Information	<ul> <li>This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC.</li> <li>This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.</li> <li>This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).</li> <li>This product is in compliance with the IEEE 1680 (EPEAT) standard at the <gold> level, see www.epeat.net</gold></li> <li>Plastics parts weighing over 25 grams used in the product are marked per IS011469 and IS01043.</li> <li>This product contains 24.1% post-consumer recycled plastic (by wt.)</li> <li>This product is 91.4% recycle-able when properly disposed of at end of life.</li> </ul>		
Packaging Materials	External:	PAPER/Corrugated	443 g
		PLASTIC/Polyethylene Expanded - EPE PLASTIC/Polyethylene high density - HDPE Dackaging material is made from 0% recycled content. Backaging materials contains at least 80% recycled content.	38 g 4 g ent.
Material Usage	to the HP Gei http://www.l	does not contain any of the following substances in exc neral Specification for the Environment at np.com/hpinfo/globalcitizenship/environment/pdf/gse. estos ain Azo Colorants ain Brominated Flame Retardants – may not be used as mium orinated Hydrocarbons orinated Paraffins maldehyde ogenated Diphenyl Methanes d carbonates and sulfates	pdf):



#### Technical Specifications – Environmental

	Lead and Lead compounds     Mayania Ouida Battariaa
	Mercuric Oxide Batteries     Nickel Finishes must not be used on the external surface designed to be frequently.
	<ul> <li>Nickel – finishes must not be used on the external surface designed to be frequently handled or carried by the user.</li> </ul>
	Ozone Depleting Substances
	Polybrominated Biphenyls (PBBs)
	Polybrominated Biphenyl Ethers (PBBEs)
	Polybrominated Biphenyl Oxides (PBBOs)
	Polychlorinated Biphenyl (PCB)
	Polychlorinated Terphenyls (PCT)
	Polyvinyl Chloride (PVC) — except for wires and cables, and certain retail packaging has
	been voluntarily removed from most applications.
	Radioactive Substances
	Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin 0xide (TBT0)
Packaging Usage	HP follows these guidelines to decrease the environmental impact of product packaging:
	Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in
	packaging materials.
	Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
	Design packaging materials for ease of disassembly.
	Maximize the use of post-consumer recycled content materials in packaging materials.
	<ul> <li>Use readily recyclable packaging materials such as paper and corrugated materials.</li> </ul>
	Reduce size and weight of packages to improve transportation fuel efficiency.
	<ul> <li>Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.</li> </ul>
End-of-life Management and Recycling	Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: <a href="http://www.hp.com/go/reuse-recycle">http://www.hp.com/go/reuse-recycle</a> or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.
	The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: <a href="http://www.hp.com/go/recyclers">http://www.hp.com/go/recyclers</a> . These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.
Hewlett-Packard	For more information about HP's commitment to the environment:
Corporate	
Environmental	Global Citizenship Report
Information	http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html Eco-label certifications
	http://www8.hp.com/us/en/hp-information/environment/ecolabels.html
	ISO 14001 certificates:
	http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/PC_GBU_Product_Design_
	ISO_14K_Certificate.pdf
	and
	http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf



Technical Specifications – Environmental

#### **ENVIRONMENTAL DATA**

#### HP ProOne 400 G3 Non-Touch All-in-One Business PC

	This product has received or is in the process of being certified to the following approvals and m				
Eco-Label Certifications & declarations	be labeled with one or more of these marks:				
a decidi ations	IT ECO declaration	ese marks.			
	_	n the United States. See http://wv	ww.epeat.net for registration		
	status in your country.				
System Configuration	The configuration used for the En	ergy Consumption and Declared N	Noise Emissions data for the		
	Desktop model is based on a typic	cally configured PC featuring a ha	rd disk drive, a high efficiency		
	power supply, and a Microsoft Wir	ndows® operating system.			
	power supply, and a microsoft windows operating system.				
Energy Consumption					
(in accordance with US					
ENERGY STAR® test					
method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz		
Normal Operation (Short	16.93 W	17.01 W	16.64 W		
-	10.93 W	17.01 W	10.04 W		
idle)	7.0014	7.00.11	0.00.111		
Normal Operation (Long	7.98 W	7.99 W	8.00 W		
idle)					
Sleep	0.66 W	0.68 W	0.65 W		
Off	0.51 W	0.58 W	0.55 W		
	Note: Energy efficiency data listed is for family . HP computers marked wit Environmental Protection Agency family does not offer ENERGY STA for a typically configured PC feature.	th the ENERGY STAR® Logo are co (EPA) ENERGY STAR® specificatio AR® compliant configurations, the uring a hard disk drive, a high effic	mpliant with the applicable U.S ons for computers. If a model on energy efficiency data listed i		
	Energy efficiency data listed is for family . HP computers marked wit Environmental Protection Agency family does not offer ENERGY STA	th the ENERGY STAR® Logo are co (EPA) ENERGY STAR® specificatio AR® compliant configurations, the uring a hard disk drive, a high effic	mpliant with the applicable U.S ons for computers. If a model on energy efficiency data listed i		
	Energy efficiency data listed is for family . HP computers marked wit Environmental Protection Agency family does not offer ENERGY STA for a typically configured PC featu	th the ENERGY STAR® Logo are co (EPA) ENERGY STAR® specificatio AR® compliant configurations, the uring a hard disk drive, a high effic	mpliant with the applicable U.S ons for computers. If a model on energy efficiency data listed i		
<b>Heat Dissipation*</b> Normal Operation (Short idle)	Energy efficiency data listed is for family . HP computers marked wit Environmental Protection Agency family does not offer ENERGY STA for a typically configured PC featu Microsoft Windows® operating sys	th the ENERGY STAR® Logo are co (EPA) ENERGY STAR® specification AR® compliant configurations, the uring a hard disk drive, a high effic stem.	mpliant with the applicable U.S ons for computers. If a model on energy efficiency data listed i ciency power supply, and a		
Normal Operation (Short idle)	Energy efficiency data listed is for family . HP computers marked wit Environmental Protection Agency family does not offer ENERGY STA for a typically configured PC featu Microsoft Windows® operating systems.  115VAC, 60Hz 58 BTU/hr	th the ENERGY STAR® Logo are co (EPA) ENERGY STAR® specification AR® compliant configurations, the aring a hard disk drive, a high effic stem.  230VAC, 50Hz 58 BTU/hr	mpliant with the applicable U.S ons for computers. If a model en energy efficiency data listed i ciency power supply, and a  100VAC, 50Hz 57 BTU/hr		
Normal Operation (Short idle) Normal Operation (Long	Energy efficiency data listed is for family . HP computers marked wit Environmental Protection Agency family does not offer ENERGY STA for a typically configured PC featu Microsoft Windows® operating sys	th the ENERGY STAR® Logo are co (EPA) ENERGY STAR® specification AR® compliant configurations, the uring a hard disk drive, a high effic stem. 230VAC, 50Hz	mpliant with the applicable U.S ons for computers. If a model on energy efficiency data listed i ciency power supply, and a		
Normal Operation (Short idle) Normal Operation (Long idle)	Energy efficiency data listed is for family . HP computers marked wit Environmental Protection Agency family does not offer ENERGY STA for a typically configured PC featu Microsoft Windows® operating system of the state of the	th the ENERGY STAR® Logo are co (EPA) ENERGY STAR® specification (RP compliant configurations, the uring a hard disk drive, a high efficient stem.  230VAC, 50Hz 58 BTU/hr	mpliant with the applicable U.S ons for computers. If a model en energy efficiency data listed i ciency power supply, and a  100VAC, 50Hz 57 BTU/hr  27 BTU/hr		
Normal Operation (Short dle) Normal Operation (Long dle) Sleep	Energy efficiency data listed is for family . HP computers marked wit Environmental Protection Agency family does not offer ENERGY STA for a typically configured PC featu Microsoft Windows® operating systems of the state of th	th the ENERGY STAR® Logo are co (EPA) ENERGY STAR® specification (RP compliant configurations, the uring a hard disk drive, a high efficient stem.  230VAC, 50Hz 58 BTU/hr 27 BTU/hr	mpliant with the applicable U.S ons for computers. If a model en energy efficiency data listed i ciency power supply, and a  100VAC, 50Hz 57 BTU/hr 27 BTU/hr		
Normal Operation (Short idle) Normal Operation (Long idle)	Energy efficiency data listed is for family . HP computers marked wit Environmental Protection Agency family does not offer ENERGY STA for a typically configured PC featu Microsoft Windows® operating system of the state of the	th the ENERGY STAR® Logo are co (EPA) ENERGY STAR® specification AR® compliant configurations, the uring a hard disk drive, a high efficients stem.  230VAC, 50Hz 58 BTU/hr 27 BTU/hr 2 BTU/hr	mpliant with the applicable U.S ons for computers. If a model on energy efficiency data listed i ciency power supply, and a  100VAC, 50Hz 57 BTU/hr 27 BTU/hr 2 BTU/hr 2 BTU/hr		
Normal Operation (Short dle) Normal Operation (Long dle) Sleep Off	Energy efficiency data listed is for family . HP computers marked wit Environmental Protection Agency family does not offer ENERGY STA for a typically configured PC featu Microsoft Windows® operating system of the system of th	th the ENERGY STAR® Logo are co (EPA) ENERGY STAR® specification AR® compliant configurations, the uring a hard disk drive, a high efficients stem.  230VAC, 50Hz 58 BTU/hr 27 BTU/hr 2 BTU/hr	mpliant with the applicable U.S ons for computers. If a model en energy efficiency data listed i ciency power supply, and a  100VAC, 50Hz 57 BTU/hr 27 BTU/hr 2 BTU/hr 2 BTU/hr 5, assuming the service level is		
Normal Operation (Short idle) Normal Operation (Long idle) Sleep Off	Energy efficiency data listed is for family . HP computers marked wit Environmental Protection Agency family does not offer ENERGY STA for a typically configured PC featu Microsoft Windows® operating system of the system of th	th the ENERGY STAR® Logo are co (EPA) ENERGY STAR® specification AR® compliant configurations, the uring a hard disk drive, a high efficients stem.  230VAC, 50Hz 58 BTU/hr 27 BTU/hr 2 BTU/hr	mpliant with the applicable U.S ons for computers. If a model en energy efficiency data listed i ciency power supply, and a  100VAC, 50Hz 57 BTU/hr 27 BTU/hr 2 BTU/hr 2 BTU/hr 5, assuming the service level is  Sound Pressure		
Normal Operation (Short dle) Normal Operation (Long dle) Sleep Off  Declared Noise Emissions	Energy efficiency data listed is for family . HP computers marked wit Environmental Protection Agency family does not offer ENERGY STA for a typically configured PC featu Microsoft Windows® operating system of the system of th	th the ENERGY STAR® Logo are co (EPA) ENERGY STAR® specification AR® compliant configurations, the uring a hard disk drive, a high efficients stem.  230VAC, 50Hz 58 BTU/hr 27 BTU/hr 2 BTU/hr	mpliant with the applicable U.S ons for computers. If a model en energy efficiency data listed i ciency power supply, and a  100VAC, 50Hz 57 BTU/hr 27 BTU/hr 2 BTU/hr 2 BTU/hr 5, assuming the service level is		
Normal Operation (Short idle) Normal Operation (Long idle) Sleep Off  Declared Noise Emissions (in accordance with	Energy efficiency data listed is for family . HP computers marked wit Environmental Protection Agency family does not offer ENERGY STA for a typically configured PC featu Microsoft Windows® operating system of the system of th	th the ENERGY STAR® Logo are co (EPA) ENERGY STAR® specification AR® compliant configurations, the uring a hard disk drive, a high efficients stem.  230VAC, 50Hz 58 BTU/hr 27 BTU/hr 2 BTU/hr	mpliant with the applicable U.S ons for computers. If a model on energy efficiency data listed i ciency power supply, and a  100VAC, 50Hz 57 BTU/hr 27 BTU/hr 2 BTU/hr 2 BTU/hr 5, assuming the service level is  Sound Pressure		
Normal Operation (Short idle) Normal Operation (Long idle) Sleep Off  Declared Noise Emissions (in accordance with	Energy efficiency data listed is for family . HP computers marked wit Environmental Protection Agency family does not offer ENERGY STA for a typically configured PC featu Microsoft Windows® operating systems of the state of th	th the ENERGY STAR® Logo are co (EPA) ENERGY STAR® specification AR® compliant configurations, the uring a hard disk drive, a high efficients stem.  230VAC, 50Hz 58 BTU/hr 27 BTU/hr 2 BTU/hr	mpliant with the applicable U.S ons for computers. If a model in energy efficiency data listed i ciency power supply, and a  100VAC, 50Hz 57 BTU/hr 27 BTU/hr 2 BTU/hr 2 BTU/hr 5, assuming the service level is  Sound Pressure (L <sub>pAm</sub> , decibels)		
Normal Operation (Short dle) Normal Operation (Long dle) Sleep Off  Declared Noise Emissions (in accordance with 150 7779 and 150 9296) Typically Configured —	Energy efficiency data listed is for family . HP computers marked wit Environmental Protection Agency family does not offer ENERGY STA for a typically configured PC featu Microsoft Windows® operating system of the system of th	th the ENERGY STAR® Logo are co (EPA) ENERGY STAR® specification AR® compliant configurations, the uring a hard disk drive, a high efficients stem.  230VAC, 50Hz 58 BTU/hr 27 BTU/hr 2 BTU/hr	mpliant with the applicable U.S ons for computers. If a model en energy efficiency data listed i ciency power supply, and a  100VAC, 50Hz 57 BTU/hr 27 BTU/hr 2 BTU/hr 2 BTU/hr 5, assuming the service level is  Sound Pressure		
Normal Operation (Short dle) Normal Operation (Long dle) Sleep Off  Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296) Typically Configured — dle	Energy efficiency data listed is for family . HP computers marked wit Environmental Protection Agency family does not offer ENERGY STA for a typically configured PC featured Microsoft Windows® operating systems.  115VAC, 60Hz 58 BTU/hr 27 BTU/hr 2 BTU/hr 2 BTU/hr *NOTE: Heat dissipation is calcula attained for one hour.  Sound Power (LwAd, bels)	th the ENERGY STAR® Logo are co (EPA) ENERGY STAR® specification AR® compliant configurations, the uring a hard disk drive, a high efficients stem.  230VAC, 50Hz 58 BTU/hr 27 BTU/hr 2 BTU/hr	mpliant with the applicable U.S ons for computers. If a model en energy efficiency data listed i ciency power supply, and a  100VAC, 50Hz 57 BTU/hr 27 BTU/hr 2 BTU/hr 2 BTU/hr 5, assuming the service level is  Sound Pressure (LpAm, decibels)		
Normal Operation (Short dle) Normal Operation (Long dle) Sleep Off  Declared Noise Emissions (in accordance with SO 7779 and ISO 9296) Typically Configured – dle Fixed Disk – Random	Energy efficiency data listed is for family . HP computers marked wit Environmental Protection Agency family does not offer ENERGY STA for a typically configured PC featu Microsoft Windows® operating systems of the state of th	th the ENERGY STAR® Logo are co (EPA) ENERGY STAR® specification AR® compliant configurations, the uring a hard disk drive, a high efficients stem.  230VAC, 50Hz 58 BTU/hr 27 BTU/hr 2 BTU/hr	mpliant with the applicable U.S ons for computers. If a model in energy efficiency data listed i ciency power supply, and a  100VAC, 50Hz 57 BTU/hr 27 BTU/hr 2 BTU/hr 2 BTU/hr 5, assuming the service level is  Sound Pressure (L <sub>pAm</sub> , decibels)		
Normal Operation (Short dle) Normal Operation (Long dle) Sleep Off  Declared Noise Emissions (in accordance with	Energy efficiency data listed is for family . HP computers marked wit Environmental Protection Agency family does not offer ENERGY STA for a typically configured PC featured Microsoft Windows® operating systems.  115VAC, 60Hz 58 BTU/hr 27 BTU/hr 2 BTU/hr 2 BTU/hr *NOTE: Heat dissipation is calcula attained for one hour.  Sound Power (LwAd, bels)	th the ENERGY STAR® Logo are co (EPA) ENERGY STAR® specification AR® compliant configurations, the aring a hard disk drive, a high efficient stem.  230VAC, 50Hz 58 BTU/hr 27 BTU/hr 2 BTU/hr 2 BTU/hr ted based on the measured watts	mpliant with the applicable U.S ons for computers. If a model in energy efficiency data listed i ciency power supply, and a  100VAC, 50Hz 57 BTU/hr 27 BTU/hr 2 BTU/hr 2 BTU/hr 3, assuming the service level is  Sound Pressure (L <sub>pAm</sub> , decibels)  22		



#### Technical Specifications – Environmental

	1		
	• 1 2.5" inte • 1 5.25" 9.	<i>i</i> slots	p to 5 years after the end of
Batteries	This batterv(	s) in this product comply with EU Directive 2006/66/EC	
	Batteries use Mercury Cadmiun	ed in the product do not contain: greater the1ppm by weight n greater than 20ppm by weight CR2032 (coin cell)	
Additional Information	dire     This     (WE     This     Drin     This     www     Plas     ISO1     This	product is in compliance with the Restrictions of Hazardoctive - 2011/65/EC.  HP product is designed to comply with the Waste Electric EE) Directive - 2002/96/EC.  product is in compliance with California Proposition 65 (\$\frac{9}{2}\$ king Water and Toxic Enforcement Act of 1986).  product is in compliance with the IEEE 1680 (EPEAT) staw.epeat.net  tics parts weighing over 25 grams used in the product are 1043.  product contains 24.2%post-consumer recycled plastic of product is 96.3% recycle-able when properly disposed of	cal and Electronic Equipment State of California; Safe andard at the gold level, see e marked per ISO11469 and (by wt.)
Packaging Materials	External:	PAPER/Corrugated	1127 g
	Internal:	PLASTIC/Polyethylene Expanded - EPE	574 g
		PLASTIC/Polyethylene low density - LDPE	40 g
		PLASTIC/Other	23 g
	The Plastic p	backaging material is made from 40% recycled content.	-
Material Usage	This product to the HP Ger http://www.l	ackaging materials contains at least 49.8% recycled cont does not contain any of the following substances in exce neral Specification for the Environment at np.com/hpinfo/globalcitizenship/environment/pdf/gse.p estos ain Azo Colorants ain Brominated Flame Retardants – may not be used as f mium orinated Hydrocarbons orinated Paraffins maldehyde ogenated Diphenyl Methanes	ss of regulatory limits (refer df):



#### Technical Specifications – Environmental

	,
	Lead carbonates and sulfates
	Lead and Lead compounds
	Mercuric Oxide Batteries
	Nickel – finishes must not be used on the external surface designed to be frequently
	handled or carried by the user.
	Ozone Depleting Substances
	Polybrominated Biphenyls (PBBs)
	Polybrominated Biphenyl Ethers (PBBEs)
	Polybrominated Biphenyl Oxides (PBBOs)
	Polychlorinated Biphenyl (PCB)
	Polychlorinated Terphenyls (PCT)
	Polyvinyl Chloride (PVC) — except for wires and cables, and certain retail packaging has
	been voluntarily removed from most applications.
	Radioactive Substances
	Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)
Packaging Usage	HP follows these guidelines to decrease the environmental impact of product packaging:
i ackaging obage	Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in
	packaging materials.
	, , , , , , , , , , , , , , , , , , , ,
	Design packaging materials for ease of disassembly.  Maying the use of pack consumer regulad content materials in packaging materials.
	Maximize the use of post-consumer recycled content materials in packaging materials.
	Use readily recyclable packaging materials such as paper and corrugated materials.
	Reduce size and weight of packages to improve transportation fuel efficiency.
	Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.
End-of-life Management	Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic
and Recycling	areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your
and kecycling	nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a
	responsible manner.
	responsible manner.
	The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for
	each product type for use by treatment facilities. This information (product disassembly
	instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers.
	These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM
	customers who integrate and re-sell HP equipment.
HP, Inc. Corporate	For more information about HP's commitment to the environment:
Environmental	
Information	Global Citizenship Report
	http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html
	Eco-label certifications
	http://www8.hp.com/us/en/hp-information/environment/ecolabels.html
	ISO 14001 certificates:
	http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/PC_GBU_Product_Design_
	ISO_14K_Certificate.pdf
	and
	http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf
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Technical Specifications – Environmental

#### **ENVIRONMENTAL DATA**

#### HP ProOne 400 G3 Touch All-in-One Business PC

Eco-Label Certifications & declarations	<ul> <li>ch All-in-One Business PC</li> <li>This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:         <ul> <li>IT ECO declaration</li> <li>US ENERGY STAR®</li> <li>EPEAT<sup>□</sup> Gold registered in the United States. See http://www.epeat.net for registration</li> </ul> </li> </ul>			
	status in your countr			
System Configuration	Desktop model is based on a t	e Energy Consumption and Declared Noi typically configured PC featuring a hard t Windows® operating system.		
Energy Consumption (in accordance with US ENERGY STAR® test	445746 6011-	Energy Consumption (in accordance with US ENERGY STAR® test method)	445046 600-	
method) Normal Operation (Short	<b>115VAC, 60Hz</b> 16.93 W	Normal Operation (Short idle)	<b>115VAC, 60Hz</b> 16.93 W	
dle)				
Normal Operation (Long idle)	7.98 W	Normal Operation (Long idle)	7.98 W	
Sleep	0.66 W	Sleep	0.66 W	
Off	0.51 W	Off	0.51 W	
	family . HP computers marked Environmental Protection Age family does not offer ENERGY for a typically configured PC f	s for an ENERGY STAR® compliant product with the ENERGY STAR® Logo are compency (EPA) ENERGY STAR® specifications STAR® compliant configurations, then eaturing a hard disk drive, a high efficient system.	oliant with the applicable U.S for computers. If a model energy efficiency data listed	
Heat Dissipation*	Energy efficiency data listed in family . HP computers marked Environmental Protection Age family does not offer ENERGY for a typically configured PC f Microsoft Windows® operating	d with the ENERGY STAR® Logo are compency (EPA) ENERGY STAR® specifications STAR® compliant configurations, then eaturing a hard disk drive, a high efficieng system.	oliant with the applicable U.S for computers. If a model energy efficiency data listed ncy power supply, and a	
Normal Operation (Short	Energy efficiency data listed is family . HP computers marked Environmental Protection Age family does not offer ENERGY for a typically configured PC f	d with the ENERGY STAR® Logo are compency (EPA) ENERGY STAR® specifications STAR® compliant configurations, then eaturing a hard disk drive, a high efficien	oliant with the applicable U.S for computers. If a model energy efficiency data listed i	
Normal Operation (Short idle)  Normal Operation (Long	Energy efficiency data listed in family . HP computers marked Environmental Protection Age family does not offer ENERGY for a typically configured PC f Microsoft Windows® operating	d with the ENERGY STAR® Logo are compency (EPA) ENERGY STAR® specifications STAR® compliant configurations, then e eaturing a hard disk drive, a high efficien g system.  Heat Dissipation*	oliant with the applicable U.S for computers. If a model energy efficiency data listed i ncy power supply, and a 115VAC, 60Hz	
Normal Operation (Short dle) Normal Operation (Long dle) Sleep	Energy efficiency data listed is family . HP computers marked Environmental Protection Age family does not offer ENERGY for a typically configured PC f Microsoft Windows® operating 115VAC, 60Hz 58 BTU/hr	d with the ENERGY STAR® Logo are compency (EPA) ENERGY STAR® specifications STAR® compliant configurations, then eaturing a hard disk drive, a high efficiency system.  Heat Dissipation*  Normal Operation (Short idle)	oliant with the applicable U.S for computers. If a model energy efficiency data listed ncy power supply, and a 115VAC, 60Hz 58 BTU/hr	
Normal Operation (Short idle) Normal Operation (Long idle)	Energy efficiency data listed is family . HP computers marked Environmental Protection Age family does not offer ENERGY for a typically configured PC f Microsoft Windows® operating 115VAC, 60Hz 58 BTU/hr	d with the ENERGY STAR® Logo are compency (EPA) ENERGY STAR® specifications STAR® compliant configurations, then e eaturing a hard disk drive, a high efficie g system.  Heat Dissipation* Normal Operation (Short idle)  Normal Operation (Long idle)	oliant with the applicable U.S for computers. If a model energy efficiency data listed ncy power supply, and a  115VAC, 60Hz 58 BTU/hr  27 BTU/hr	
Normal Operation (Short idle) Normal Operation (Long idle) Sleep	Energy efficiency data listed is family . HP computers marked Environmental Protection Age family does not offer ENERGY for a typically configured PC f Microsoft Windows® operating  115VAC, 60Hz  58 BTU/hr  27 BTU/hr  2 BTU/hr	d with the ENERGY STAR® Logo are compency (EPA) ENERGY STAR® specifications STAR® compliant configurations, then e eaturing a hard disk drive, a high efficiency g system.  Heat Dissipation* Normal Operation (Short idle)  Normal Operation (Long idle)  Sleep	oliant with the applicable U.S for computers. If a model energy efficiency data listed ency power supply, and a  115VAC, 60Hz 58 BTU/hr 27 BTU/hr 2 BTU/hr	
Normal Operation (Short idle) Normal Operation (Long idle) Sleep Off	Energy efficiency data listed is family . HP computers marked Environmental Protection Age family does not offer ENERGY for a typically configured PC f Microsoft Windows® operating  115VAC, 60Hz  58 BTU/hr  27 BTU/hr  2 BTU/hr  2 BTU/hr  *NOTE: Heat dissipation is calcattained for one hour.	d with the ENERGY STAR® Logo are compency (EPA) ENERGY STAR® specifications STAR® compliant configurations, then eleaturing a hard disk drive, a high efficiency system.    Heat Dissipation*     Normal Operation (Short idle)     Sleep     Off     culated based on the measured watts, and the compensation of	oliant with the applicable U.S for computers. If a model energy efficiency data listed ency power supply, and a  115VAC, 60Hz 58 BTU/hr 27 BTU/hr 2 BTU/hr	
Normal Operation (Short dle) Normal Operation (Long dle) Sleep Off  Declared Noise Emissions	Energy efficiency data listed is family . HP computers marked Environmental Protection Age family does not offer ENERGY for a typically configured PC f Microsoft Windows® operating  115VAC, 60Hz  58 BTU/hr  27 BTU/hr  2 BTU/hr  *NOTE: Heat dissipation is calcattained for one hour.	d with the ENERGY STAR® Logo are compency (EPA) ENERGY STAR® specifications STAR® compliant configurations, then eleaturing a hard disk drive, a high efficiency system.    Heat Dissipation*     Normal Operation (Short idle)     Normal Operation (Long idle)     Sleep     Off     culated based on the measured watts, and the compensation (Incompliant of the compen	oliant with the applicable U.S for computers. If a model energy efficiency data listed incy power supply, and a  115VAC, 60Hz 58 BTU/hr 27 BTU/hr 2 BTU/hr 2 BTU/hr assuming the service level is  red Noise Emissions accordance with	
Normal Operation (Short idle) Normal Operation (Long idle) Sleep Off  Declared Noise Emissions (in accordance with	Energy efficiency data listed is family . HP computers marked Environmental Protection Age family does not offer ENERGY for a typically configured PC f Microsoft Windows® operating  115VAC, 60Hz  58 BTU/hr  27 BTU/hr  2 BTU/hr  2 BTU/hr  *NOTE: Heat dissipation is calcattained for one hour.	d with the ENERGY STAR® Logo are compency (EPA) ENERGY STAR® specifications STAR® compliant configurations, then eleaturing a hard disk drive, a high efficiency system.    Heat Dissipation*     Normal Operation (Short idle)     Normal Operation (Long idle)     Sleep     Off     culated based on the measured watts, and the compensation (Incompliant of the compen	oliant with the applicable U.S for computers. If a model energy efficiency data listed incy power supply, and a  115VAC, 60Hz 58 BTU/hr 27 BTU/hr 2 BTU/hr 2 BTU/hr assuming the service level is	
Normal Operation (Short idle) Normal Operation (Long idle) Sleep Off  Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296) Typically Configured —	Energy efficiency data listed is family . HP computers marked Environmental Protection Age family does not offer ENERGY for a typically configured PC f Microsoft Windows® operating  115VAC, 60Hz  58 BTU/hr  27 BTU/hr  2 BTU/hr  2 BTU/hr  *NOTE: Heat dissipation is calcattained for one hour.	d with the ENERGY STAR® Logo are compency (EPA) ENERGY STAR® specifications STAR® compliant configurations, then eaturing a hard disk drive, a high efficiency system.    Heat Dissipation*   Normal Operation (Short idle)     Normal Operation (Long idle)     Sleep   Off     culated based on the measured watts, and the compensation (Incompliant of the compensation	oliant with the applicable U.S for computers. If a model energy efficiency data listed i ncy power supply, and a  115VAC, 60Hz 58 BTU/hr 27 BTU/hr 2 BTU/hr 2 BTU/hr assuming the service level is red Noise Emissions accordance with	
idle) Normal Operation (Long idle) Sleep	Energy efficiency data listed is family . HP computers marked Environmental Protection Age family does not offer ENERGY for a typically configured PC f Microsoft Windows® operating  115VAC, 60Hz  58 BTU/hr  27 BTU/hr  2 BTU/hr  2 BTU/hr  *NOTE: Heat dissipation is calcattained for one hour.  Sound Pow (LwAd, bels	d with the ENERGY STAR® Logo are compency (EPA) ENERGY STAR® specifications STAR® compliant configurations, then eleaturing a hard disk drive, a high efficiency g system.  Heat Dissipation* Normal Operation (Short idle)  Normal Operation (Long idle)  Sleep Off  culated based on the measured watts, a  er Declar (in 150 7	oliant with the applicable U.S for computers. If a model energy efficiency data listed incy power supply, and a  115VAC, 60Hz 58 BTU/hr 27 BTU/hr 2 BTU/hr 2 BTU/hr essuming the service level is accordance with 779 and ISO 9296)	



#### Technical Specifications – Environmental

	6 USB por	ts		
	• 2 memory			
	• 1 M.2 223			
	• 1 M.2 2230/80 for NVMe SSD storage			
	<ul><li>1 2.5" internal bay support</li><li>1 5.25" 9.5mm-slim ODD</li></ul>			
	• 15.25"9.	5mm-slim ODD		
	Spare parts are available throughout the warranty period and or for up to 5 years after the end of production.			
Batteries	This battery(	s) in this product comply with EU Directive 2006/66/EC		
	Ratteries use	ed in the product do not contain:		
		greater the1ppm by weight		
		n greater than 20ppm by weight		
		CR2032 (coin cell)		
	Battery type	: Lithium		
Additional Information		product is in compliance with the Restrictions of Hazardor ctive - 2011/65/EC.	us Substances (RoHS)	
		HP product is designed to comply with the Waste Electrica	al and Electronic Equipment	
		EE) Directive – 2002/96/EC.		
		s product is in compliance with California Proposition 65 (St	tate of California; Safe	
		king Water and Toxic Enforcement Act of 1986). $_{ ext{product}}$ product is in compliance with the IEEE 1680 (EPEAT $^\square$ ) star	doud at the cold lovel and	
		oproduct is in compliance with the IEEE 1680 (EPEATS) star w.epeat.net	idard at the gold level, see	
		w.epeat.net stics parts weighing over 25 grams used in the product are	marked per ISO11469 and	
		1043.	marked per 150 11 105 and	
	• This	product contains 25.6%post-consumer recycled plastic (b	ny wt.)	
	• This	product is 96.4% recycle-able when properly disposed of	at end of life.	
Packaging Materials	External:	PAPER/Corrugated	1127 g	
	Internal:	PLASTIC/Polyethylene Expanded - EPE	574 g	
		PLASTIC/Polyethylene low density - LDPE	40 g	
		PLASTIC/Other	23 g	
		packaging material is made from 40% recycled content.		
		ackaging materials contains at least 49.8% recycled conte		
Material Usage		does not contain any of the following substances in excess	s of regulatory limits (refer	
		neral Specification for the Environment at	£).	
	nttp://www.	hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pd	1):	
	• Ash	estos		
		ain Azo Colorants		
	• Cert	ain Brominated Flame Retardants – may not be used as fla	ame retardants in plastics	
		mium		
		orinated Hydrocarbons		
		orinated Paraffins		
		maldehyde		
		ogenated Diphenyl Methanes d carbonates and sulfates		
	- Lea	ט במו טטוומנפט מווע טענומנפט		



#### Technical Specifications – Environmental

	<ul> <li>Lead and Lead compounds</li> <li>Mercuric Oxide Batteries</li> <li>Nickel – finishes must not be used on the external surface designed to be frequently handled or carried by the user.</li> <li>Ozone Depleting Substances</li> <li>Polybrominated Biphenyls (PBBs)</li> <li>Polybrominated Biphenyl Ethers (PBBEs)</li> <li>Polybrominated Biphenyl Oxides (PBBOs)</li> <li>Polychlorinated Biphenyl (PCB)</li> <li>Polychlorinated Terphenyls (PCT)</li> <li>Polyvinyl Chloride (PVC) – except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.</li> <li>Radioactive Substances</li> <li>Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)</li> </ul>
Packaging Usage	<ul> <li>HP follows these guidelines to decrease the environmental impact of product packaging:</li> <li>Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.</li> <li>Eliminate the use of ozone-depleting substances (ODS) in packaging materials.</li> <li>Design packaging materials for ease of disassembly.</li> <li>Maximize the use of post-consumer recycled content materials in packaging materials.</li> <li>Use readily recyclable packaging materials such as paper and corrugated materials.</li> <li>Reduce size and weight of packages to improve transportation fuel efficiency.</li> <li>Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.</li> </ul>
End-of-life Management and Recycling	Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: <a href="http://www.hp.com/go/reuse-recycle">http://www.hp.com/go/reuse-recycle</a> or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.  The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: <a href="http://www.hp.com/go/recyclers">http://www.hp.com/go/recyclers</a> .  These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.
HP, Inc. Corporate Environmental Information	For more information about HP's commitment to the environment:  Global Citizenship Report     http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html Eco-label certifications     http://www8.hp.com/us/en/hp-information/environment/ecolabels.html ISO 14001 certificates:     http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/PC_GBU_Product_Design_ISO_14K_Certificate.pdf     and     http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf



Technical Specifications – Environmental

#### **UNIT ENVIRONMENT AND OPERATING CONDITIONS**

**General Unit Operating Guidelines** 

- Keep the computer away from excessive moisture, direct moisture and the extremes of heat and cold, to ensure that unit is operated within the specified operating range.
- Leave a 10.2 cm (4 in) clearance on all vented sides of the computer to permit the required airflow.
- Never restrict airflow into the computer by blocking any vents or air intakes.
- Do not stack computers on top of each other or place computers so near each other that they are subject to each other's re-circulated or preheated air.
- Occasionally clean the air vents on the front, back, and any other vented side of the computer. Lint, dust and other foreign matter can block the vents and limit the airflow.
- If the computer is to be operated within a separate enclosure, intake and exhaust ventilation must be provided on the enclosure, and the same operating quidelines listed above will still apply.

Temperature Range Operating: 50° to 95° F (10° to 35° C)\*

Non-operating: -22° to 140° F(-30° to 60° C)

Relative Humidity Operating: 10% to 90% (non-condensing at ambient)

Non-operating: 5% to 95% (non-condensing at ambient)

Maximum Operating: 5000m

Altitude (unpressurized) Non-operating: 50000ft (15240 m)

\*Operating temperature is de-rated 1.0 deg C per 300 m (1000 ft) to 3000 m (10,000 ft) above sea level, no direct sustained sunlight. Maximum rate of change is 10 deg C/Hr. The upper limit may be limited by the type and number of options installed.

#### SERVICE AND SUPPORT

On-site Warranty <sup>1</sup>: Available three-year (3-3-3) or one-year (1-1-1) limited warranty delivers three years of on-site, next business day <sup>2</sup> service for parts and labor and complimentary limited technical support. <sup>3</sup> Three-year onsite and labor are not available in all countries. Service offers terms up to 5 years by choosing an optional HP Care Pack. <sup>4</sup> To choose the right level of service for your HP product, visit HP Care Pack Central: www.hp.com/go/cpc

NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply. Other warranty variations may be offered in your region.

NOTE 2: On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.

NOTE 3: Technical telephone support applies only to HP-configured and third-party HP qualified hardware and software.

NOTE 4: Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.



Technical Specifications – Graphics

#### **GRAPHICS**

DisplayPort™ 1.2	Multimode	Multimode capable; supports HDCP, DisplayPort™ 1.2 Audio (2 streams), HBR2 link rates and Multi-									
Display: Of the fire		Stream Technology for a maximum of 2 displays.									
Memory	The BIOS h	as options fo	r selecting 1	the dedica	ated memor	y size of 12	8MB, 256ME	3 or 512MB			
		memory is al y (DVMT), to ¡						leo Memory n memory use.			
Maximum Graphics Memory	Windows 10										
Memory	>4 GB										
		actual amoun upon your co				can be less	than the am	ounts listed above			
Maximum Color Depth	32 bits/pix	el									
Graphics/Video API Support	6th Generation Intel <sup>a</sup> Core Processors 7th Generation Intel <sup>a</sup> Core Proces							sors			
	With Intel <sup>a</sup>	Graphics 580 HD Graphics	), 550, 540	_	_	â HD Graphic					
	<u>DirectX</u>	<u>OpenGL</u>	<u>OpenCL</u>	Intel <sup>a</sup> Quick Sync Video	<u>DirectX</u>	<u>OpenGL</u>	<u>OpenCL</u>	Intel <sup>a</sup> Quick Sync <u>Video</u>			
	12	4.4	2.0	Yes	12	4.4	2.0	Yes			
						ration Intel <sup>a</sup>		<u>sors</u>			
						<sup>â</sup> HD Graphic		1â O . 1 G			
					<u>DirectX</u>	<u>OpenGL</u>	<u>OpenCL</u>	Intel <sup>a</sup> Quick Sync <u>Video</u>			
					12	4.2	1.2	Yes			
Media Playback	6th Genera	ation Intel <sup>a</sup> Co	re Processo	<u>ors</u>	7th Generation Intel <sup>a</sup> Core Processors						
Premium Content & Content protection	4K UHD				4K UHD, BD UHD, UHD-HDR						
	HEAC OF A	IDO			HEVC 8b, VP8, HEVC 10b, VP9 10b Decode, 8b Encode						
HW Codec	HEVC 8b, V	FO			TILVC OU,	VI O, IILVC I	00, VI J 10L	becode, ob Elicoa			

#### **Supported Display Resolutions and Refresh Rates**

Note: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP. For All in One platforms, resolutions higher than the integrated panel resolution are not supported on the integrated panel.



#### Technical Specifications – Graphics

Resolution	Refresh Rate	VGA	DisplayPort™ 1.2	НДМІ	Standard
640 x 480	60, 75, 85	Х	Х	Х	VESA DMT, CVT 0.31M3
720 x 400	70	Х	Х	Х	IBM VGA
800 x 600	60, 75, 85	Х	Х	Х	VESA DMT, CVT0.48M3
1024 x 768	60, 75, 85	Х	Х	Х	VESA DMT, CVT 0.79M3
1152 x 864	60, 75, 85	Х	Х	Х	VESA DMT, CVT 0.83MA
1280 x 720	60, 75, 85	Х	Х	Х	VESA DMT, CVT 0.92M9, CEA-770.3
1280 x 768	60, 60RB, 75, 85	Х	Х	Х	VESA DMT, CVT 0.98M9/0.98M9-R
1280 x 800	60, 75, 85	Х	Х	Х	VESA DMT
1280 x 960	60, 75, 85	Х	Х	Х	VESA DMT
1280 x 1024	60, 75, 85	Х	Х	Х	VESA DMT, CVT 1.31M4
1366 x 768	60, 60RB	Х	Х	Х	VESA DMT
1440 x 900	60, 60RB	Х	Х	Х	VESA DMT
1600 x 900	60, 60RB, 75, 85	Х	Х	Х	VESA DMT
1680 x 1050	60, 60RB, 75	Х	Х	Х	VESA DMT, CVT 1.76MA/1.76MA-R
1920 x 1080	60	Х	Х	Х	VESA DMT, CVT 2.07M9, SMPTE 274M
1920 x 1200	60, 60RB, 75, 85	Х*	Х	Х	DMT, CVT 2.30MA/2.30MA-R
1600 x 1200	60, 75, 85	Х*	Х	Х	VESA DMT, 1.92M3
1920 x 1440	60, 75, 85		Х	Х	VESA DMT, CVT 2.76M3
2048 x 1536	60,75		Х	Х	CVT 3.15M3
2560 x 1440	59.951		Х	Х	CVT 3.69M9-R
2560 x 1600	60, 60RB		Х	Х	VESA DMT, CVT 4.10MA/4.10MA-R
3840 x 2160	24		Х	Х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	25		Х	Х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	30		Х	Х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	50		Х	Х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	60		Х	Х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
4096 x 2160	24		Х	Х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	25		Х	Х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M



#### Technical Specifications – Graphics

4096 x 2160	30	X	Х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	50	Х	Х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	60	х	Х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
1920 x 1080	60	х	Х	VESA (SMPTE 274M)
1920 x 1080	50	х	Х	SMPTE 274M
1920 x 1080	30	х	Х	SMPTE 274M
1920 x 1080	24	х	Х	SMPTE 274M
1280 x 720	60	х	Х	VESA (CEA-770.3)
1280 x 720	50	х	Х	SMPTE 296M
720 x 480	60	х	Х	MHL (CEA-770.2)
720 x 576	50	х	Х	ITU-R BT.1358
640 x 480	60	х	Х	CEA (VESA DMT)

#### AMD Radeon™ R7 430 2GB LP 2DP PCIe x16 GF card

Memory 1GB/2GB GDDR5 or 2GB/4GB DDR3

Controller Clock SpeedAMD® Radeon™ R7 430 GPU operating up to 780MhzMultidisplay SupportA maximum of 2 displays are supported by the card.

**Graphics /API support** DIRECTX® 12, Mantle, OpenGL 4.4, Vulkan™

**Output Connectors** 2x DisplayPort

Resolution	Refresh Rate*	VGA (DVI-VGA adapter)	DisplayPort	Standard
640 x 480	60, 75, 85	Х	Х	VESA DMT, CVT 0.31M3
720 x 400	70	Х	Х	IBM VGA
800 x 600	60, 75, 85	Х	Х	VESA DMT, CVT0.48M3
1024 x 768	60, 75, 85	Х	Х	VESA DMT, CVT 0.79M3
1152 x 864	60, 75, 85	Х	Х	VESA DMT, CVT 0.83MA
1280 x 720	60, 75, 85	Х	Х	VESA DMT, CVT 0.92M9, CEA-770.3
1280 x 768	60, 60RB, 75, 85	Х	Х	VESA DMT, CVT 0.98M9/0.98M9-R
1280 x 800	60, 75, 85	Х	Х	VESA DMT
1280 x 960	60, 75, 85	Х	Х	VESA DMT



#### Technical Specifications – Graphics

1280 x 1024	60, 75, 85	Х	х	VESA DMT, CVT 1.31M4
1366 x 768	60, 60RB	Х	Х	VESA DMT
1440 x 900	60, 60RB	Х	Х	VESA DMT
1600 x 900	60, 60RB, 75, 85	Х	Х	VESA DMT
1680 x 1050	60, 60RB, 75	Х	Х	VESA DMT, CVT 1.76MA/1.76MA-R
1920 x 1080	60	Х	Х	VESA DMT, CVT 2.07M9, SMPTE 274M
1920 x 1200	60, 60RB, 75, 85	Х	Х	DMT, CVT 2.30MA/2.30MA-R
1600 x 1200	60, 75, 85	Х	Х	VESA DMT, 1.92M3
1920 x 1440	60, 75, 85	Х	Х	VESA DMT, CVT 2.76M3
2048 x 1536	60,75	Х	Х	CVT 3.15M3
2560 x 1440	59.951		Х	CVT 3.69M9-R
2560 x 1600	60, 60RB		Х	VESA DMT, CVT 4.10MA/4.10MA-R
3840 x 2160	24		Х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	25		Х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	30		Х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	50		Х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	60		Х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
4096 x 2160	24		Х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	25		Х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	30		Х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	50		Х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	60		Х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
1920 x 1080	60		Х	VESA (SMPTE 274M)
1920 x 1080	50		Х	SMPTE 274M
1920 x 1080	30		х	SMPTE 274M
1920 x 1080	24		Х	SMPTE 274M
1280 x 720	60		х	VESA (CEA-770.3)
1280 x 720	50		х	SMPTE 296M
720 x 480	60		Х	MHL (CEA-770.2)

#### AMD Radeon™ R7 450 4GB PCIe x16 Graphics Card

Memory4GB 128-bit wide frame buffer operating at 1125MHz.Controller Clock SpeedAMD® Radeon™ R9 450 GPU operating at 925 MHz



### QuickSpecs

Technical Specifications – Graphics

Multi-display Support A maximum of 4 displays are supported by the card. A maximum of 2 legacy displays (Native

VGA, DVI, or displays connected with passive DisplayPort™ 1.2 adapters are considered as

legacy)

Graphics / API support DIRECTX 12, Open GL 4.3, Open CL1.2, UVD 3

**Output Connectors** 1 x Dual-Link DVI-I, 1x DisplayPort™ 1.2; 1x HDMI; Includes DVI to VGA adapter

**Supported Display Resolutions and Refresh Rates** 

Note: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution	Refresh Rate*	VGA (DVI-VGA adapter)	DVI-D	DisplayPort™ 1.2	HDMI	Standard
640 x 480	60, 75, 85	Х	Х	Х	Х	VESA DMT, CVT 0.31M3
720 x 400	70	Х	Х	Х	Х	IBM VGA
800 x 600	60, 75, 85	Х	Х	Х	Х	VESA DMT, CVT0.48M3
1024 x 768	60, 75, 85	Х	Х	Х	Х	VESA DMT, CVT 0.79M3
1152 x 864	60, 75, 85	Х	Х	Х	Х	VESA DMT, CVT 0.83MA
1280 x 720	60, 75, 85	Х	Х	Х	Х	VESA DMT, CVT 0.92M9, CEA-770.3
1280 x 768	60, 60RB, 75, 85	Х	Х	Х	Х	VESA DMT, CVT 0.98M9/0.98M9-R
1280 x 800	60, 75, 85	Х	Х	Х	Х	VESA DMT
1280 x 960	60, 75, 85	Х	Х	Х	Х	VESA DMT
1280 x 1024	60, 75, 85	Х	Х	Х	Х	VESA DMT, CVT 1.31M4
1366 x 768	60, 60RB	Х	Х	Х	Х	VESA DMT
1440 x 900	60, 60RB	Х	Х	Х	Х	VESA DMT
1600 x 900	60, 60RB, 75, 85	Х	Х	Х	Χ	VESA DMT
1680 x 1050	60, 60RB, 75	Х	Х	Х	Х	VESA DMT, CVT 1.76MA/1.76MA-R
1920 x 1080	60	Х	Х	Х	Х	VESA DMT, CVT 2.07M9, SMPTE 274M
1920 x 1200	60, 60RB, 75, 85	Х	Х	Х	Х	DMT, CVT 2.30MA/2.30MA-R
1600 x 1200	60, 75, 85	Х	Х	Х	Х	VESA DMT, 1.92M3
1920 x 1440	60, 75, 85	Х	Х	Х	Х	VESA DMT, CVT 2.76M3
2048 x 1536	60,75	Х	Х	Х	Х	CVT 3.15M3
2560 x 1440	59.951		Х	Х	Х	CVT 3.69M9-R
2560 x 1600	60, 60RB		Х	Х	Х	VESA DMT, CVT 4.10MA/4.10MA-R
3840 x 2160	24			Х	Х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M



#### Technical Specifications – Graphics

		-				
3840 x 2160	25			Х	Χ	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	30		Х	Х	Х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	50			Х		CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	60			Х		CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
4096 x 2160	24			Х	Х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	25			Х	Х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	30			Х	Х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	50			Х		CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	60			Х		CVT-RBv1/v2 (8.85M-R), SMPTE 274M
1920 x 1080	60		Х	Х	Х	VESA (SMPTE 274M)
1920 x 1080	50		Х	Х	Х	SMPTE 274M
1920 x 1080	30		Х	Х	Х	SMPTE 274M
1920 x 1080	24		Х	Х	Х	SMPTE 274M
1280 x 720	60		Х	Х	Х	VESA (CEA-770.3)
1280 x 720	50		Х	Х	Х	SMPTE 296M
720 x 480	60		Х	Х	Х	MHL (CEA-770.2)

#### AMD Radeon™ RX 460 2GB FH PCIe x16 Graphics Card

Memory2GB 128-bit wide frame buffer operating at 1750MHz.Controller Clock SpeedAMD® Radeon™ RX 460 GPU operating at up to 1.2GHzMulti-display SupportA maximum of 4 displays are supported by the card.

Graphics / API support DIRECTX 12, Open GL 4.5, Open CL 2.0, AMD Video Coding Engine (VCE) 3.4 and AMD Universal

Video Decoder( UVD)

**Output Connectors** 1 x Dual-Link DVI-D, 1x DisplayPort™ 1.2; 1x HDMI

#### **Supported Display Resolutions and Refresh Rates**

Note: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution	Refresh Rate*	DVI-D	DisplayPort™ 1.2	HDMI	Standard
640 x 480	60, 75, 85	Х	Х	Х	VESA DMT, CVT 0.31M3
720 x 400	70	Х	Х	Х	IBM VGA



#### Technical Specifications – Graphics

800 x 600	60, 75, 85	Х	Х	Х	VESA DMT, CVT0.48M3
1024 x 768	60, 75, 85	Х	Х	Х	VESA DMT, CVT 0.79M3
1152 x 864	60, 75, 85	Х	Х	Х	VESA DMT, CVT 0.83MA
1280 x 720	60, 75, 85	Х	Х	Х	VESA DMT, CVT 0.92M9, CEA-770.3
1280 x 768	60, 60RB, 75, 85	Х	Х	Х	VESA DMT, CVT 0.98M9/0.98M9-R
1280 x 800	60, 75, 85	Х	Х	Х	VESA DMT
1280 x 960	60, 75, 85	Χ	Х	Х	VESA DMT
1280 x 1024	60, 75, 85	Χ	Х	Χ	VESA DMT, CVT 1.31M4
1366 x 768	60, 60RB	Χ	Х	Χ	VESA DMT
1440 x 900	60, 60RB	Χ	Х	Х	VESA DMT
1600 x 900	60, 60RB, 75, 85	Χ	Х	Х	VESA DMT
1680 x 1050	60, 60RB, 75	Χ	Х	Х	VESA DMT, CVT 1.76MA/1.76MA-R
1920 x 1080	60	Χ	Х	Х	VESA DMT, CVT 2.07M9, SMPTE 274M
1920 x 1200	60, 60RB, 75, 85	Χ	Х	Х	DMT, CVT 2.30MA/2.30MA-R
1600 x 1200	60, 75, 85	Χ	Х	Х	VESA DMT, 1.92M3
1920 x 1440	60, 75, 85	Χ	Х	Х	VESA DMT, CVT 2.76M3
2048 x 1536	60, 75	Χ	Х	Χ	CVT 3.15M3
2560 x 1440	59.951	Χ	Х	Х	CVT 3.69M9-R
2560 x 1600	60, 60 RB	Χ	Х	Х	VESA DMT, CVT 4.10MA/4.10MA-R
3840 x 2160	24		Х	Χ	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	25		Х	Х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	30	Χ	Х	Х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	50		Х	Χ	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	60		Х	Χ	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
4096 x 2160	24		Х	Х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	25		Х	Х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	30		Х	Х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	50		Х	Χ	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	60		Х	Χ	CVT-RBv1/v2 (8.85M-R), SMPTE 274M



#### Technical Specifications – Graphics

1920 x 1080	60	Х	Х	Х	VESA (SMPTE 274M)
1920 x 1080	50	Х	Х	Х	SMPTE 274M
1920 x 1080	30	Х	Х	Х	SMPTE 274M
1920 x 1080	24	Х	Х	Х	SMPTE 274M
1280 x 720	60	Х	Х	Х	VESA (CEA-770.3)
1280 x 720	50	Х	Х	Х	SMPTE 296M
720 x 480	60	Х	Х	Х	MHL (CEA-770.2)

#### NVIDIA® GeForce® GT 730 1GB PCIe x8 HDMI Graphics Card

Memory 1GB GDDR5 64-bit wide frame buffer operating at 1.25Ghz.

**Controller Clock Speed** NVIDIA® Kepler™ GPU operating at 901 MHz

Multi-display Support A maximum of 2 displays are supported by the card

Graphics / API support

Supports Microsoft DirectX 12, OpenGL 4.4 and OpenCL 2 API, Shade Model 5 and DirectCompute

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**Output Connectors** 1 x Dual-Link DVI-I; 1x HDMI; Includes DVI to VGA adapter

#### **Supported Display Resolutions and Refresh Rates**

Note: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution	Refresh Rate*	VGA (DVI-VGA adapter)	DVI-D	нрмі	Standard
640 x 480	60, 75, 85	Х	Х	Х	VESA DMT, CVT 0.31M3
720 x 400	70	Х	Х	Χ	IBM VGA
800 x 600	60, 75, 85	Х	Х	Х	VESA DMT, CVT0.48M3
1024 x 768	60, 75, 85	Х	Х	Х	VESA DMT, CVT 0.79M3
1152 x 864	60, 75, 85	Х	Х	Х	VESA DMT, CVT 0.83MA
1280 x 720	60, 75, 85	Х	Х	Х	VESA DMT, CVT 0.92M9, CEA-770.3
1280 x 768	60, 60RB, 75, 85	Х	Х	Х	VESA DMT, CVT 0.98M9/0.98M9-R
1280 x 800	60, 75, 85	Х	Х	Х	VESA DMT
1280 x 960	60, 75, 85	Х	Х	Х	VESA DMT
1280 x 1024	60, 75, 85	Х	Х	Х	VESA DMT, CVT 1.31M4



#### Technical Specifications – Graphics

1366 x 768	60, 60RB	Χ	Х	Х	VESA DMT
1440 x 900	60, 60RB	Х	Х	Х	VESA DMT
1600 x 900	60, 60RB, 75, 85	Х	Х	Х	VESA DMT
1680 x 1050	60, 60RB, 75	Х	Х	Х	VESA DMT, CVT 1.76MA/1.76MA-R
1920 x 1080	60	Х	Х	Х	VESA DMT, CVT 2.07M9, SMPTE 274M
1920 x 1200	60, 60RB, 75, 85	Х	Х	Х	DMT, CVT 2.30MA/2.30MA-R
1600 x 1200	60, 75, 85	Х	Х	Х	VESA DMT, 1.92M3
1920 x 1440	60, 75, 85	Х	Х	Х	VESA DMT, CVT 2.76M3
2048 x 1536	60,75	Х	Х	Х	CVT 3.15M3
2560 x 1440	59.951		Х	Х	CVT 3.69M9-R
2560 x 1600	60, 60RB		Х	Х	VESA DMT, CVT 4.10MA/4.10MA-R
3840 x 2160	24			Х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	25			Х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	30		Х	Х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	50				CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	60				CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
4096 x 2160	24			Х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	25			Х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	30			Х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	50				CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	60				CVT-RBv1/v2 (8.85M-R), SMPTE 274M
1920 x 1080	60		Х	Х	VESA (SMPTE 274M)
1920 x 1080	50		Х	Х	SMPTE 274M
1920 x 1080	30		Х	Х	SMPTE 274M
1920 x 1080	24		Х	Х	SMPTE 274M
1280 x 720	60		Х	Х	VESA (CEA-770.3)
1280 x 720	50		Х	Х	SMPTE 296M
720 x 480	60		Х	Х	MHL (CEA-770.2)

<sup>\* &</sup>gt;60 refresh rates only for analog (VGA) signaling

#### NVIDIA® GeForce® GT 730 2GB DP PCIe x8 Graphics Card



#### Technical Specifications – Graphics

Introduction		Get impressive graphics and high resolution dual-display performance in a low profile, PCI Express x8 graphics add-in card based on the NVIDIA® Kepler™ Graphics Processor. Improve your everyday PC, Web conferencing, and video or photo editing.					
Memory		2GB GD	DR5 64-b	it wide fr	ame buffe	er operating at 1.25Ghz	
Controller Clock S	Speed	NVIDIA	® Kepler™	GPU ope	rating at 9	902 MHz	
Multi-display Sup	port	A maxir	mum of 4	displays a	are suppo	orted by the card.	
Graphics /API sup	port	Supports Microsoft DirectX 12, OpenGL 4.4 and OpenCL 2 APIs, Shade Model 5, UVD 4.2, VCE 2.0, and DirectCompute 11					
Output Connector	rs					™ 1.2; Includes DVI to VGA adapter capable, support Audio, HBR2 and MST	
Resolution	Refresh	Rate*	ADV-IVD) HDV-IVD) ADV	DVI-D	DisplayPort™ 1.2	Standard	
640 x 480	60, 75	, 85	Х	Х	Х	VESA DMT, CVT 0.31M3	
720 x 400	70		Х	Х	Х	IBM VGA	
800 x 600	60, 75, 85		Х	Х	Х	VESA DMT, CVT0.48M3	
1024 x 768	60, 75	, 85	Х	Х	Х	VESA DMT, CVT 0.79M3	
1152 x 864	60, 75	, 85	Х	Х	Х	VESA DMT, CVT 0.83MA	
1280 x 720	60, 75, 85		Х	Х	Х	VESA DMT, CVT 0.92M9, CEA-770.3	
1280 x 768	60, 60RB,	75, 85	Х	Х	Х	VESA DMT, CVT 0.98M9/0.98M9-R	
1280 x 800	60, 75	, 85	Х	Х	Х	VESA DMT	
1280 x 960	60, 75	, 85	Х	Х	Х	VESA DMT	
1280 x 1024	60, 75, 85		Х	Х	Х	VESA DMT, CVT 1.31M4	
1366 x 768	60, 60RB		Х	Х	Х	VESA DMT	
1440 x 900	60, 60RB		Х	Х	Х	VESA DMT	
1600 x 900	60, 60RB, 75, 85		Х	Х	Х	VESA DMT	
1680 x 1050	1680 x 1050 60, 60RB, 75		Х	Х	Х	VESA DMT, CVT 1.76MA/1.76MA-R	
1920 x 1080	60		Х	Х	Х	VESA DMT, CVT 2.07M9, SMPTE 274M	
1920 x 1200	60, 60RB,	75, 85	Х	Х	Х	DMT, CVT 2.30MA/2.30MA-R	
1600 x 1200	60, 75	, 85	Х	Х	Х	VESA DMT, 1.92M3	



#### Technical Specifications – Graphics

1920 x 1440	60, 75, 85	Х	Х	х	VESA DMT, CVT 2.76M3
2048 x 1536	60,75	Х	Х	Х	CVT 3.15M3
2560 x 1440	59.951		Х	Х	CVT 3.69M9-R
2560 x 1600	60, 60RB		Х	Х	VESA DMT, CVT 4.10MA/4.10MA-R
3840 x 2160	24			Х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	25			Х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	30		Х	Х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	60			Х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
4096 x 2160	24			Х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	25			Х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	30			Х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	60			Х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
1920 x 1080	60		Х	Х	VESA (SMPTE 274M)
1920 x 1080	50		Х	Х	SMPTE 274M
1920 x 1080	30		Х	Х	SMPTE 274M
1920 x 1080	24		Х	Х	SMPTE 274M
1280 x 720	60		Х	Х	VESA (CEA-770.3)
1280 x 720	50		Х	Х	SMPTE 296M
720 x 480	60		Х	Х	MHL (CEA-770.2)
720 x 576	50		Х	Х	ITU-R BT.1358
640 x 480	60		Х	Х	CEA (VESA DMT)
* >60 refresh rates	* >60 refresh rates only for analog (VGA) signaling				

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Technical Specifications – Hard Disk and Solid State Storage

#### HARD DISK AND SOLID STORAGE

**NOTE:** For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 16 GB (for Windows 7) and 36 GB (for Windows 8.1/10) of system disk is reserved for the system recovery software.

HP 1 TB 7.2K SATA 6.0Gb/s 2.5" Hard Disk Drive				
Capacity	1,000,204,886,016 bytes	1,000,204,886,016 bytes		
Rotational Speed	7,200 rpm			
Interface	SATA 6 Gb/s			
Buffer Size	32 MB	32 MB		
Logical Blocks	1,953,525,168			
Seek Time (tunical roads	Single Track:	2.0 ms		
Seek Time (typical reads, includes controller overhead, including cottling)	Average:	12 ms		
including settling)	Full-Stroke:	25 ms		
Height (nominal)	0.374 in/9.5 mm	0.374 in/9.5 mm		
Wideh (nominal)	Media diameter: 2.5 in/63.5 mm			
Width (nominal)	Physical size: 2.75 in/70 mm			
<b>Operating Temperature</b> 41° to 131° F (5° to 55° C)		C)		

HP 500 GB 7.2K SATA 6.0Gb/s 2.5" Hard Disk Drive*			
Capacity	500,107,862,016 bytes		
Rotational Speed	7,200 rpm		
Interface	SATA 6 Gb/s		
Buffer Size 16 MB			



#### Technical Specifications – Hard Disk and Solid State Storage

Logical Blocks	976,773,168		
Cook There (Associated associated	Single Track:	2.0 ms	
Seek Time (typical reads, includes controller overhead, including cottling)	Average:	12 ms	
including settling)	Full-Stroke:	25 ms	
Height (nominal)	0.267 in/6.8 mm		
MILIAN (consisted)	Media diameter: 2.5 in/63.5 mm		
Width (nominal)	Physical size: 2.75 in/70 mm		
Operating Temperature	41° to 131° F (5° to 55° C)		

\*NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

500GB* 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive				
Formatted Capacity	500,107,862,016 by	500,107,862,016 bytes		
Spindle Speed	7,200 rpm			
Interface	Serial ATA 3.0 (6.0 G	b/s)		
Buffer Size	16 MB			
Logical Blocks	976,773,168			
	Single Track:	2.0 ms		
Seek Time (average)	Average:	11 ms		
	Full-Stroke:	21 ms		
Height (nominal)	1 in/2.54 cm			
Middle (nominal)	Media diameter: 3.5 in/8.89 cm			
Width (nominal)	Physical size: 4 in/10.2 cm			
Operating Temperature	41° to 131° F (5° to 55° C)			



Technical Specifications – Hard Disk and Solid State Storage

HP 1 TB* 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive*			
Formatted Capacity	1,000,204,886,016 bytes		
Rotational Speed	7,200 rpm		
Interface	Serial ATA 3.0 (6.0 Gb/s)		
Buffer Size	32 MB		
Logical Blocks	1,953,525,168		
	Single Track:	2.0 ms	
Seek Time (average)	Average:	11 ms	
	Full-Stroke: 21 ms		
Height (nominal)	1 in/2.54 cm		
Intidate (	Media diameter: 3.5 in/8.89	cm	
Width (nominal)	Physical size: 4 in/10.2 cm		
Operating Temperature	41° to 131° F (5° to 55° C)		

<sup>\*</sup> For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

HP 2 TB* 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive*			
Formatted Capacity	2 TB		
Rotational Speed	7,200 rpm		
Interface	SATA 6Gb/s NCQ		
Cache, Multisegmented (MB)	64 MB		
Sock Time (average)	Read	<8.5 ms	
Seek Time (average)	Write	<9.5 ms	
Height	1.028 in/26.11 mm		
Width	4.0 in/101.6 mm		
Depth	5.787 in/146.99 mm		
Weight	1.38 lb/626 g		
Operating Temperature	32° to 140° F (0° to 60° C)		



Technical Specifications – Hard Disk and Solid State Storage

HP 1 TB* SATA 6G 2.5" 8GB Solid State Hybrid Drive (SSHD)*				
Formatted Capacity	1 TB	1 TB		
Spindle Speed	5,400 rpm +/- 0.2%			
Drive Type	Solid State Hybrid Dri	ve (SSHD) technology with NAND Flash		
Interface	SATA 6 Gb/s			
Cache Buffer	64 MB			
NAND Flash Commercial Multilevel Cell (cMLC)	8 GB			
Number of Sectors	976,773,168			
Sock Time (turnien) rende)	Single Track:	2.0 ms		
Seek Time (typical reads)	Average:	12 ms		
Height	0.374 +/008 in (9.5	0.374 +/008 in (9.5 +/- 0.2 mm)		
Width	2.750 +/- 0.010 in (69.85 +/- 0.25 mm)			
Length	3.951 +0.008 / -0.010 in (100.35 +0.20 / -0.25 mm)			
Weight	0.254 lb/115 g (max)			
Operating Temperature	32° to 140° F (0° to 60	)° C)		

<sup>\*</sup> For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 16 GB (for Windows 7) and 36 GB (for Windows 8.1/10) of system disk is reserved for the system recovery software.

HP 500 GB SATA 6G 2.5" 8GB Solid State Hybrid Drive (SSHD)*		
Formatted Capacity	500 GB	
Spindle Speed	5,400 rpm +/- 0.2%	
Drive Type	Solid State Hybrid Drive (SSHD) technology with NAND Flash	
Interface	SATA 6 Gb/s	
Cache Buffer	64 MB	
NAND Flash Commercial Multilevel Cell (cMLC)	8 GB	
Number of Sectors	976,773,168	



#### Technical Specifications – Hard Disk and Solid State Storage

	Single Track:	2.0 ms	
Seek Time (typical reads)	Average:	12 ms	
Height	0.268 +/008 in (6.8 +/- 0.2 mm)		
Width	2.750 +/- 0.010 in (69.85 +/- 0.25 mm)		
Length	3.951 +0.008 / -0.010 in (100.35 +0.20 / -0.25 mm)		
<b>Weight</b> 0.209 lb/95 g (max)			
Operating Temperature	41° to 131° F (5° to 55° C)		

HP 1-TB SATA 6G 3.5" 8GB Solid State Hybrid Drive (SSHD)*			
Formatted Capacity	1 TB		
Spindle Speed	7,200 rpm		
Drive Type	Solid State Hybrid Drive	(SSHD) technology with NAND Flash	
Interface	Serial ATA (SATA)		
Cache Buffer	64 MB		
NAND Flash Multilevel Cell (MLC)	8 GB		
Number of Sectors	1,953,525,168		
Cook Time (Austral woods)	Single Track:	2.0 ms	
Seek Time (typical reads)	Average:	11 ms	
Height	0.783 in / 2.01 cm		
Width	4 in / 10.2 cm		
Length	5.79 in / 14.7 cm		
Weight	0.88 lb/400 g		
Operating Temperature	41° to 131° F (5° to 55°	C)	



#### Technical Specifications – Hard Disk and Solid State Storage

500 GB* SATA 2.5" Sel	f-Encrypting (SED) Opal 2	Solid State Drive*		
Unformatted Capacity	500GB			
Architecture	Self-Encrypting (SED) Solid St	Self-Encrypting (SED) Solid State Drive with 25nm MLC NAND Flash and SATA interface		
Interface	Serial ATA 2.0 (3.0 Gb/s)	Serial ATA 2.0 (3.0 Gb/s)		
NAND Flash	25nm MLC NAND Flash	25nm MLC NAND Flash		
Height	.275 in/7mm			
Width	2.75 in/69.85 mm			
Length	3.95 in/100.5 mm			
Weight	0.161 lb (73 g)			
Bandwidth Performance	Sustained Sequential 128k Read:	Up to 450 MB/s		
	Sustained Sequential 128k Write:	Up to 260 MB/s		
	Random 4k Read:	Up to 46K IOPs		
	Random 4k Write:	Up to 56K IOPs		
Latency	Read:	55 μs		
	Write:	55 μs		
Power	SATA power consumption:	160 mW (active average); <85 mW (idle average)		
Useful Drive Life	72TB written, up to 40GB/day	o for 5 years		
	Operating Temperature:	32° to 158° F (0° to 70° C)		



#### Technical Specifications – Hard Disk and Solid State Storage

<b>Environmental</b> (all conditions, non-condensing)	Relative Humidity:	5% to 95%
	Shock:	1,500 G/1 ms

	are CD			
Unformatted Capacity	256 GB			
	500,118,192 (User Addressable Sectors)			
Architecture	Self-Encrypting (SED) Solid State Drive with NAND Flash and SATA interface.			
Architecture	Trusted Computing Group (TCG) OPAL 2.0 compliant encrypted solid state drive			
Interface	Serial ATA (6.0 Gb/s)			
Form Factor	2.5 inch			
Height	6.80 mm ± 0.20			
Width	69.85 mm ± 0.25			
Length	100.20 mm ± 0.25			
Typical Weight	37.4 g			
Bandwidth Performance	Sustained Sequential Read:	Up to 520 MB/s		
	Sustained Sequential Write:	Up to 460 MB/s		
Power	Power consumption: Active: 3.891W; Idle:		: 0.085W	
Mean Time Between Failure (MTBF)	1,500,000 hours			
Environmental (all conditions, non-condensing)	Operating Temperature:		32° to 158° F (0° to 70° C)	
(all conditions, non-condensing)	Relative Humidity:		5% to 95%	
	Shock:		1,500 G/0.5 ms	



### QuickSpecs

#### Technical Specifications – Hard Disk and Solid State Storage

\*NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 16 GB (for Windows 7) and 36 GB (for Windows 8.1/10) of system disk is reserved for the system recovery software.

	512 GB			
Unformatted Capacity	1,000,215,216 (User Addressable Sectors)			
Architecture	Self-Encrypting (SED) Solid State Drive with NAND Flash and SATA interface.			
	Trusted Computing Group (TCG) OPAL 2.0 compliant encrypted solid state drive			
Interface	Serial ATA (6.0 Gb/s)			
Form Factor	2.5 inch			
Height	7 mm ± 0.20			
Width	69.85 mm ± 0.25			
Length	100.20 mm ± 0.25			
Typical Weight	37.4 g			
Bandwidth Performance	Sustained Sequential Read:	Up to 515 MB/s		
	Sustained Sequential Write:	Up to 490 MB/s		
		Maximum active power: ≤4,400mW		
Power	Power consumption:	Average power: 70mW		
	Slumber low power r		mode: 42mW – 52mW	
Mean Time Between Failure (MTBF)	Up to 1,750,000 hours			
Environmental	Operating Temperature:		0°C to 70°C (32°F to 158°F)	
(all conditions, non-condensing)	Non-operating temperature and storage		-55°C to +85°C (-67°F to 185°F	
	Operating and non-oper	rating shock	1,500 G/0.5 ms	



Technical Specifications – Hard Disk and Solid State Storage

128GB PCIE NVME TLC Solid S	itate Drive			
Unformatted Capacity	128 GB			
Architecture	Solid State Drive with TLC NAND Flash and PCIE interface.  Complies with NVMe Standard  Power Saving Modes: L1 substates support  Multi Queue support			
Interface	PCI-E Gen3 x 4			
Form Factor	M.2 2280			
Height	3.73 mm			
Width	22.00 ± 0.15 mm			
Length	88.00 ± 0.15 mm			
Weight	Up to 8 g			
Bandwidth Performance	Sustained Sequential Read:	Up to 1400 MB/s		
	Sustained Sequential Write:	Up to 400 MB/s		
Power	Active: Typical 6.1W; Power consumption: Idle: Typical 80mW L1.2: Typical 5mW		;	
Mean Time Between Failure (MTBF)	1,500,000 hours			
Environmental	Operating Temperature:		32° to 158° F (0° to 70° C)	
(all conditions, non-condensing)	Relative Humidity:		5% to 95%	
	Shock:		1,500 G/0.5 ms	



Technical Specifications – Hard Disk and Solid State Storage

Unformatted Capacity	256 GB			
	Solid State Drive with TLC NAND Flash and PCIE interface.			
Architecture	Complies with NVMe Standard			
	Power Saving Modes: L1 substates support			
	Multi Queue support			
Interface	PCI-E Gen3 x 4			
Form Factor	M.2 2280			
Height	3.73 mm			
Width	22.00 ± 0.15 mm			
Length	80.00 ± 0.15 mm			
Weight	Up to 8 g			
Bandwidth Performance	Sustained Sequential Read:	Up to 2600 MB/s		
	Sustained Sequential Write:	Up to 1000 MB/s		
		Active: Typical 6.1W	;	
Power	Power consumption:	Idle: Typical 80mW		
	L1.2: Typical 5mW			
Mean Time Between Failure (MTBF)	1,500,000 hours			
Environmental	Operating Temperature:		32° to 158° F (0° to 70° C)	
(all conditions, non-condensing)	Relative Humidity:		5% to 95%	
	Shock:		1,500 G/0.5 ms	



Technical Specifications – Hard Disk and Solid State Storage

Unformatted Capacity	512 GB		
	Solid State Drive with TLC NAND Flash and PCIE interface.		
Architecture	Complies with NVMe Standard		
Al cinecetal C	Power Saving Modes: L1 substates support		
	Multi Queue support		
Interface	PCI-E Gen3 x 4		
Form Factor	M.2 2280		
Height	3.73 mm		
Width	22.00 ± 0.15 mm		
Length	80.00 ± 0.15 mm		
Weight	Up to 8 g		
Bandwidth Performance	Sustained Sequential Read:	Up to 2600 MB/s	
	Sustained Sequential Write:	Up to 1200 MB/s	
		Active: Typical 6.1W	;
Power	Power consumption:	Idle: Typical 80mW	
	L1.2: Typical 5mW		
Mean Time Between Failure (MTBF)	1,500,000 hours		
Environmental (all conditions, non-condensing)	Operating Temperature:		32° to 158° F (0° to 70° C)
(all conditions, non-condensing)	Relative Humidity:		5% to 95%
	Shock:		1,500 G/0.5 ms

#### 1TB Turbo Drive G2 TLC Solid State Drive



### Technical Specifications – Hard Disk and Solid State Storage

Unformatted Capacity	1 TB		
Architecture	Solid State Drive with TLC NAND Flash and PCIE interface.  Complies with NVMe Standard  Power Saving Modes: L1 substates support  Multi Queue support		
Interface	PCI-E Gen3 x 4		
Form Factor	M.2 2280		
Height	3.73 mm		
Width	22.00 ± 0.15 mm		
Length	80.00 ± 0.15 mm		
Weight	Up to 8 g		
Bandwidth Performance	Sustained Sequential Read:	Up to 2600 MB/s	
	Sustained Sequential Write:	Up to 1400 MB/s	
Power	Active: Typical 6.1W; Power consumption: Idle: Typical 80mW L1.2: Typical 5mW		J;
Mean Time Between Failure (MTBF)	1,500,000 hours		
Environmental (all conditions, non-condensing)	Operating Temperature:		32° to 158° F (0° to 70° C)
(all conditions, non-condensing)	Relative Humidity:		5% to 95%
	Shock:		1,500 G/0.5 ms

128GB SATA 2.5" Value (Non-SED) Solid State Drive	
Unformatted Capacity	128 GB
Architecture	TLC NAND Flash



#### Technical Specifications – Hard Disk and Solid State Storage

Interface	SATA 3.2 (6.0 Gb/s)			
Form Factor	2.5 inch			
Dimensions (W x H x D)	6.98 x 0.7 x 10.05 cm	6.98 x 0.7 x 10.05 cm		
Weight	31g			
Bandwidth Performance	Sustained Sequential Read:	Up to 510 MB/s		
	Sustained Sequential Write:	Up to 330 MB/s		
	Random Read:	Up to 38K IOPs		
	Random Write:	Up to 70K IOPs		
Power	DC power requirement:	5 VDC 5%-100 mV ri	pple p-p	
	Total power consumption:	50mW (active); 20mW (idle)		
Useful Drive Life	72TB written, up to 40GB/day for 5 years			
Environmental	Operating Temperature:		32° to 158° F (0° to 70° C)	
(all conditions, non-condensing)	Relative Humidity:		5% to 95%	
	Shock:		1,500 G/0.5 ms	

NOTE: "For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software."

256GB SATA 2.5" Value (Non-SED) Solid State Drive		
Unformatted Capacity	256 GB	
Architecture	TLC NAND Flash	
Interface	SATA 3.2 (6.0 Gb/s)	
Form Factor	2.5 inch	
Dimensions (W x H x D)	6.98 x 0.7 x 10.05 cm	



#### Technical Specifications – Hard Disk and Solid State Storage

Weight	31g	31g		
Bandwidth Performance	Sustained Sequential Read:	Up to 510 MB/s		
	Sustained Sequential Write:	Up to 330 MB/s		
	Random Read:	Up to 38K IOPs		
	Random Write:	Up to 70K IOPs		
Power	DC power requirement:	5 VDC 5%-100 mV ripple p-p		
	Total power consumption:	50mW (active); 20mW (idle)		
Useful Drive Life	72TB written, up to 40GB/	72TB written, up to 40GB/day for 5 years		
<b>Environmental</b> (all conditions, non-condensing)	Operating Temperature:	Operating Temperature:		
	Relative Humidity:		5% to 95%	
	Shock:		1,500 G/0.5 ms	

NOTE: "For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software."

256GB SATA 2.5" TLC Solid State Drive		
Formatted Capacity	256 GB	
Architecture	Solid State Drive with SATA interface; ATA 8 Compliant and SATA 2.6 compliant	
Interface	Serial ATA 3 (6.0 Gb/s)	
Form Factor	2.5 inch	
Height	7 mm ± 0.20	
Width	69.85 mm ± 0.25	
Length	100.2 mm ± 0.25	



### Technical Specifications – Hard Disk and Solid State Storage

Weight (typical)	36.5 g (+2)		
Data Transfer Rate (128k Sequential )	Sequential Read	Up to 500 MB/s	
	Sequential Write	Up to 455 MB/s	
Power Watts	Read: 95 mW  Power consumption (avg): Standby: 70 mW  DEVSLP: <7 mW		
Environmental	Operating Temperature:		32° to 158° F (0° to 70° C)
(all conditions, non-condensing)	Relative Humidity:		5% to 95%
	Shock (2 m Sec half-sine):		1500 G peak 0.5ms (operating)

512 GB SATA 2.5" TLC Solid State Drive*			
Formatted Capacity	512 GB	512 GB	
Architecture	Solid State Drive with S	Solid State Drive with SATA interface; ATA 8 Compliant and SATA 2.6 compliant	
Interface	Serial ATA 3 (6.0 Gb/s)	Serial ATA 3 (6.0 Gb/s)	
Form Factor	2.5 inch		
Height	7 mm ± 0.20	7 mm ± 0.20	
Width	69.85 mm ± 0.25	69.85 mm ± 0.25	
Length	100.2 mm ± 0.25	100.2 mm ± 0.25	
Weight (typical)	36.5 g (+2)	36.5 g (+2)	
Data Transfer Rate (128k Sequential )	Sequential Read	Up to 500 MB/s	
(120k Sequential)	Sequential Write	Up to 455 MB/s	
Power Watts		Read: 95 mW	
	Power consumption	Write: 95 mW	
· <del></del>	(avg):	Standby: 70 mW	
		DEVSLP: <7 mW	



## HP ProDesk 400 G3 DM, HP ProDesk 400 G4 MT/SFF and HP ProOne 400 G3 Business Desktops PCs

#### Technical Specifications – Hard Disk and Solid State Storage

Environmental (all conditions, non-condensing)	Operating Temperature:	32° to 158° F (0° to 70° C)
	Relative Humidity:	5% to 95%
	Shock (2 m Sec half-sine):	1500 G peak 0.5ms (operating)

\*NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.



Technical Specifications - Removable Storage

#### **OPTICAL DRIVES**

/400 SFF G4 400 SFF/M	T DVD-Writer	
12.7mm height		
Either horizontal or vertical		
SATA/ATAPI		
Up to 8.5 GB DL or 4.7 GB stan	dard	
5.04 x 0.5 x 5.0 in (128 x 12.7	x 127 mm) without bezel	
0.42 lb (190 g)		
DVD-R DL	Up to 6X	
DVD+R	Up to 8X	
DVD+RW	Up to 8X	
DVD+R DL	Up to 6X	
DVD-R	Up to 8X	
DVD-RW	Up to 6X	
CD-R	Up to 24X	
CD-RW	Up to 24X	
DVD-RW, DVD+RW	Up to 8X	
DVD-R DL, DVD+R DL	Up to 8X	
DVD+R, DVD-R	Up to 8X	
DVD-ROM DL, DVD-ROM	Up to 8X	
CD-ROM, CD-R	Up to 24X	
CD-RW	Up to 24X	
Random	DVD-ROM: 170 ms (typical), CD-ROM: 170 ms (typical)	
Full Stroke	DVD-ROM: 320 ms (typical), CD-ROM: 320 ms (typical)	
Stop Time	6 seconds (typical)	
Source	Slimline SATA DC power receptacle	
DC Power Requirement	5 VDC ± 5%-100 mV ripple p-p	
DC Current	5 VDC (< 1000 mA typical, 1600 mA maximum)	
Temperature	41° to 122° F (5° to 50° C)	
Relative Humidity	10% to 80%	
Maximum Wet Bulb Temperature	84° F (29° C)	
	12.7mm height Either horizontal or vertical SATA/ATAPI Up to 8.5 GB DL or 4.7 GB stan 5.04 x 0.5 x 5.0 in (128 x 12.7 0.42 lb (190 g) DVD-R DL DVD+R DVD+RW DVD+RW DVD-RW CD-R CD-RW DVD-RW, DVD+RW DVD-R DL, DVD+R DL DVD-R, DVD-R DL DVD-ROM DL, DVD-ROM CD-ROM, CD-R CD-RW Random Full Stroke Stop Time Source DC Power Requirement DC Current Temperature Relative Humidity Maximum Wet Bulb	



Technical Specifications - Removable Storage

HP 9.5mm G3 800/600	/400 SFF G4 400 SFF/I	MT DVD-ROM
Height	12.7mm	
Orientation	Either horizontal or vertical	
Interface type	SATA/ATAPI	
<b>Dimensions</b> (W x H x D)	5.04 x 0.5 x 5.0 in (128 x 12.7	7 x 127 mm) without bezel
Weight (max)	Up to 0.37 lb (170 g) without	bezel
	DVD+R/-R/+RW/ -RW/+R DL /-R DL	Up to 8X
Read speeds	DVD-ROM	Up to 8X
·	CD-ROM, CD-R	Up to 24X
	CD-RW	Up to 24X
Access time	Random	DVD-ROM: 170 ms (typical), CD-ROM: 170 ms (typical)
(typical reads, including settling)	Full Stroke	DVD-ROM: 320 ms (typical), CD-ROM: 320 ms (typical)
	Source	Slimline SATA DC power receptacle
Power	DC Power Requirement	5 VDC ± 5%-100 mV ripple p-p
	DC Current	5 VDC - <1000 mA typical, < 1600 mA maximum
<b>Environmental</b> (all conditions non-condensing)	Temperature	41° to 122° F (5° to 50° C)
	Relative Humidity	10% to 80%
	Maximum Wet Bulb Temperature (operating)	84° F (29° C)



## HP ProDesk 400 G3 DM, HP ProDesk 400 G4 MT/SFF and HP ProOne 400 G3 Business Desktops PCs

Technical Specifications – Networking

#### SYSTEM MEMORY SUPPORT

The HP ProDesk 400 Business PC supports the 6<sup>th</sup> &7<sup>th</sup> generation Intel® Core™ processor family. Based on a new PC microarchitecture, the processor is designed for a two-chip platform consisting of a processor and Platform Controller Hub (PCH). The 6<sup>th</sup> generation Intel® Core™ processor includes an Integrated Memory Controller (IMC). The IMC supports DDR4 protocols with two independent, 64-bit wide channels each accessing one or two DIMMs.

- Two channels of non-ECC DDR4 unbuffered dual in-line memory modules (DIMM) or DDR4 unbuffered small outline dual in-line memory modules (SO-DIMM) with a maximum of two DIMMs per channel
- Single-channel and dual-channel memory organization modes
- Data burst length of eight for all memory organization modes
- Memory data transfer rates of up to 2400 MT/s; actual supported data transfer rate determined by the configured processor.
- 64-bit wide channels
- DDR4 system memory I/O voltage of 1.2V

#### **Platform Memory Support**

- The Microtower (MT) and Small Form Factor (SFF) platform supports up to two (2) industry-standard DDR4-SDRAM DIMMs.
- The DM platform supports up to two (2) industry-standard DDR4-SDRAM SO-DIMMs.

**CAUTION:** You must shut down the computer and disconnect the power cord before adding or removing memory modules. Regardless of the power-on state, voltage is always supplied to the memory modules as long as the computer is plugged in to an active AC outlet. Adding or removing memory modules while voltage is present may cause irreparable damage to the memory modules or system board.

**NOTE:** For systems configured with more than 3 GB of memory and a 32-bit operating system, all memory may not be available due to system resource requirements. Addressing memory above 4 GB requires a 64-bit operating system.



Technical Specifications – Networking

#### **NETWORKING**

Realtek R1	L8111HSH-CG	GbE
10/100/1000 NIC	Ethernet Features	10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14) 100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40) Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s IEEE 802.1p QoS (Quality of Service) Support IEEE 802.1q VLAN support IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable) IEEE 802.3az EEE (Energy Efficient Ethernet) Jumbo Frame 9K Auto MDI/MDIX Crossover cable detection
	Power Management	ACPI compliant – multiple power modes Situation-sensitive features reduce power consumption Advanced link down power saving for reducing link down power consumption
	Performance Features	TCP/IP/UDP Checksum Offload (configurable) Protocol Offload (ARP & NS) Large send offload and Giant send offload Receiving Side Scaling
	Manageability	Wake-on-LAN from standby and hibernation (Magic Packet and Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only) PXE 2.1 Remote Boot Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30)) Comprehensive diagnostic and configuration software suite Virtual Cable Doctor for Ethernet cable status
	Interface	PCI Express 1.1 x1 to fully support ASPM LOs/L1 and CLKREQ
	NIC Device Driver Name	PCIe GBE Ethernet Family Controller

Intel® Ethernet I210-T1 Gigabit Network Adapter		
Connector	Connector RJ-45	
System Interface	PCI Express x1	
Controller	Intel® I210 Gigabit Ethernet Controller	
Memory	Integrated Dual 48K configurable transmit receive FIFO Buffers	



Data rates supported	10/100/1000 Mbps		
IEEE Compliance	802.1P 802.1Q 802.2 802.3 802.3AB 802.3u 802.3x flow control		
Bus architecture	PCI-E 2.1		
Data path width	X1, 250 MB/s, Bi-directional inter	face	
Data transfer mode	Bus-master DMA		
Hardware certifications	FCC, B, CE, TUV-c, TUVus Mark Ca	nada and United States, TUV-GS Mark for European Union	
Power requirement	Aux 3.3 V, 3.0 Watts in 1000 base	e-T and 1.0 Watts in 100 Base-T	
Boot ROM support	Yes 10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps		
	10BASE-T (half-duplex) 10 Mbps		
Network transfer rate	10BASE-T (full-duplex) 20 Mbps  100BASE-TX (half-duplex) 100 Mbps		
	100BASE-TX (full-duplex) 200 Mbps		
	1000BASE-T (full-duplex) 2000 Mbps (actual rate limited by PCI bus)		
Familian	Operating Temperature:	32° to 132° F (0° to 55° C)	
Environmental	Operating Humidity:	85% at 131° F (55° C)	
Management	WOL, PXE, DMI, WFM 2.0		

Intel® 7265 802.11ac 2x2 DualBand Combo PCIe x1 Card			
Wireless LAN Standards	Wireless LAN Standards IEEE 802.11a		
	IEEE 802.11b		
	IEEE 802.11g		
	IEEE 802.11n		
	IEEE 802.11ac		
Interoperability	Wi-Fi certified		
Frequency Band			



		• 2.402 – 2.482 GHz
		Note:
		The FCC has declared as of January 1, 2015 products that utilize
		passive scanning on channel 12/13 and are capable of
		transmitting must fully comply with requirements of 15.247 or
		otherwise disable those channels.
		802.11a/n
		• 4.9 – 4.95 GHz (Japan)
		• 5.15 – 5.25 GHz
		• 5.25 – 5.35 GHz
		• 5.47 – 5.725 GHz
		• 5.825 – 5.850 GHz
		Note: Indonesia no support this band)
	Data Rates	• 802.11b: 1, 2, 5.5, 11 Mbps
		• 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
		• 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
		802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)
		802.111i. MCS 0 ~ MCS 15, (20MHz, 411d 40MHz)     802.11ac : MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz,
		, , , , , , , , , , , , , , , , , , , ,
	Modulation	and 80MHz)
	Piodulation	Direct Sequence Spread Spectrum
	Cocumitant	BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM
	Security <sup>1</sup>	IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g
		mode only
		AES-CCMP: 128 bit in hardware
		802.1x authentication
		WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.
		WPA2 certification
		• IEEE 802.11i
		Cisco Certified Extensions, all versions through CCX4 and CCX
		Lite
		• WAPI
	Network Architecture	Ad-hoc (Peer to Peer)
	Models	Infrastructure (Access Point Required)
	Roaming	IEEE 802.11 compliant roaming between access points
	Output Power <sup>2</sup>	802.11b : +16dBm minimum
		802.11g : +14dBm minimum
		802.11a: +14dBm minimum
		802.11n HT20(2.4GHz): +13dBm minimum
		802.11n HT40(2.4GHz): +13dBm minimum
		802.11n HT20(5GHz): +12dBm minimum
		• 802.11n HT40(5GHz): +12dBm minimum
		802.11ac 80MHz(5GHz): +11dBm minimum
	Power Consumption	Transmit: 2.0 W (max)
	. ower consumption	Receive: 1.6 W (max)
		Idle mode (PSP): 180 mW (WLAN Associated)
		Idle mode: 60 mW (WLAN unassociated)
		Radio disabled: 30 mW
	Power Management	ACPI and PCI Express compliant power management
	i owei management	802.11 compliant power saving mode
	Receiver Sensitivity <sup>3</sup>	802.11b, 1Mbps : -94dBm maximum
	Receiver Sensitivity	· · · ·
		802.11b, 11Mbps : -86dBm maximum
i e	ĺ	802.11g, 6Mbps : -88dBm maximum



#### Technical Specifications – Networking

- Hetworking				
	802.11g, 54Mbps :	: -74dBm maximum		
	802.11a, 6Mbps : -	802.11a, 6Mbps : -86dBm maximum		
		: -72dBm maximum		
	802.11n, MCS07 : -69dBm maximum			
	-	-66dBm maximum		
		S-0 : -86dBm maximum		
		S-9 : -61dBm maximum		
		S-0:-83dBm maximum		
		S-9 : -58dBm maximum		
Antenna type		enna with spatial diversity, mounted in the		
	display enclosure			
		al band 2.4/5 GHz antennas are provided to the		
		LAN MIMO communications and Bluetooth®		
	communications			
Form Factor	PCI-Express M.2 M			
Dimensions	Type 2230 : 2.3 x 2	22.0 x 30.0 mm		
	Or			
	Type 1630 : 2.3 x 1	16.0 x 30.0 mm		
Weight	Type 2230 : 2.8g			
	Or			
On evention Heltone	Type 1630: 2g			
Operating Voltage	3.3v +/- 9%			
Temperature	Operating	14° to 158° F (-10° to 70° C)		
Humidity	Non-operating Operating	-40° to 176° F (-40° to 80° C) 10% to 90% (non-condensing)		
numuity	Non-operating	5% to 95% (non-condensing)		
Altitude	Operating	0 to 10,000 ft (3,048 m)		
Attitude	Non-operating	0 to 50,000 ft (15,240 m)		
LED Activity	LED Amber – Radio OFF; LED White – Radio ON			
•		s on supported security features.		
2. Maximum output power ma				
		or rate of 8% for 802.11b (CKK modulation) and		
	a packet error rate of 10% for 802.11a/g (OFDM modulation).			
UB 1				

a packet error rate of 10%	a packet error rate of 10% for 802.11a/g (OFDM modulation).			
HP Integrated Module with Blueto	oth® 4.2 Wireless Te	chnology		
Bluetooth® Specification	4.2 Compliant			
Frequency Band	2402 to 2480 MHz			
Number of Available Channels	79 (1 MHz) availab	le channels		
Data Rates and Throughput	3 Mbps data rate; throughput up to 2.17 Mbps			
	Synchronous Connection Oriented links up to 3, 64 kbps, voice channels			
	Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric or 1306.9 kbps symmetric			
Transmit Power	The Bluetooth® component shall operate as a Class II Bluetooth® device with a maximum transmit power of +4 dBm for BR and EDR.			
Receiver Sensitivity	Modulation	0.01% BER	0.001% BER	
	GFSK	-80 dBm	-70 dBm	
	π/4-DQPSK -80 dBm -70 dBm			
	8DPSK -80 dBm -70 dBm			
Power Consumption	Peak (Tx) 330 mW			
	Peak (Rx) 230 mW	1		
	Selective Suspend	17 mW		



Range

Up to 33 ft (10 m)

Electrical Interface	USB 2.0 compliant		
Bluetooth® Software Supported Link Topology	Microsoft Windows Bluetooth® Software		
Electrical Interface	Point to Point, Multipoint Pico Nets up to 7 slaves		
Bluetooth® Software Supported Security	Full support of Bluetooth® Security Provisions		
Power Management	Microsoft Windows ACPI, and USB Bus Support		
Power Management Certifications	Self-configurable to optimize power conservation in all operating modes, including Standby, Hold, Park, and Sniff		
Security	All necessary regulatory approvals for supported countries, including:		
Certifications Bluetooth® Profiles Supported	FCC (47 CFR) Part 15C, Section 15.247 & 15.249		
Power Management	ETS 300 328, ETS 300 826		
Certifications	Low Voltage Directive IEC950		
Certifications Bluetooth® Profiles Supported	UL, CSA, and CE Mark  Serial Port Profile (SPP) <sup>1</sup> Service Discovery Application Profile (SDAP)  Dial-Up Networking (DUN) <sup>1,2</sup> Generic Object Exchange Profile (GOEP) <sup>1,2</sup> Object Push Profile (OPP) <sup>1,2</sup> File Transfer Profile (FTP)  Synchronization Profile (SYNC)  Hard Copy Cable Replacement (HCRP) <sup>1,2</sup> Personal Area Networking Profile (PAN) <sup>1,2</sup> Human Interface Device Profile (HID) <sup>1,2</sup> FAX Profile (FAX)  Basic Imaging Profile (BIP) <sup>2</sup> Headset Profile (HSP)  Hands Free Profile (HFP)  Advanced Audio Distribution Profile (A2DP)		

Intel® 3168 802.11ac with PCIe x1 WLAN/ Bluetooth® Combo*			
Wireless LAN Standards	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac	IEEE 802.11b IEEE 802.11g IEEE 802.11n	
Interoperability	Wi-Fi certification	Wi-Fi certification	
	802.11b/g/n	2.402 – 2.482 GHz	



Frequency Bands		Note: The FCC has declared as of January 1, 2015 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.	
	802.11a/n	4.9 – 4.95 GHz (Japan) 5.15 – 5.25 GHz 5.25 – 5.35 GHz 5.47 – 5.725 GHz 5.825 – 5.850 GHz Note: Indonesia only supports 5.725 - 5.825 GHz (CH149 - CH161)	
Data Rates	<ul> <li>802.11b: 1, 2, 5.5, 11 Mbps</li> <li>802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps</li> <li>802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps</li> <li>802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)</li> <li>802.11ac: MCS0 ~ MCS7, (1SS) (20MHz, 40MHz, and 80MHz)</li> </ul>		
Modulation	Direct Sequence Spread Spectrum  BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM		
Security <sup>1</sup>	<ul> <li>AES-CCM</li> <li>802.1x a</li> <li>WPA, WI</li> <li>WPA2 ce</li> <li>IEEE 802</li> </ul>	d WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only MP: 128 bit in hardware authentication PA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. ertification 2.11i rtified Extensions, all versions through CCX4 and CCX Lite	
	<sup>1</sup> Check latest sof	ftware/driver release for updates on supported security features.	
Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)		
Roaming	802.11r Fast Roaming		
Output Power²	<ul> <li>802.11g</li> <li>802.11a</li> <li>802.11n</li> <li>802.11n</li> <li>802.11n</li> </ul>	o : +16dBm minimum g : +14dBm minimum n : +14dBm minimum n HT20(2.4GHz) : +14dBm minimum n HT40(2.4GHz) : +12dBm minimum n HT40(5GHz) : +12dBm minimum	



Humidity	Operating: Non-operating:	10% to 90% (non-condensing) 5% to 95% (non-condensing)	
Temperature	Operating: Non-operating:	14° to 158° F (-10° to 70° C) -40° to 176° F (-40° to 80° C)	
Operating Voltage	3.3v +/- 9%		
Weight	Type 2230: 2.8g Or Type 1630: 2g		
Dimensions	Type 2230: 2.3 x 22.0 x 30.0 mm Or Type 1630: 2.3 x 16.0 x 30.0 mm		
Form Factors	PCI-Express M.2 MiniCard		
Antenna type	High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth® communications		
	<sup>3</sup> Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation and a packet error rate of 10% for 802.11a/g (OFDM modulation).		
Receiver Sensitivity <sup>3</sup>	802.11b, 11Mbps: -86dBm max 802.11g, 6Mbps: -88dBm max 802.11g, 54Mbps: -74dBm max 802.11a, 6Mbps: -88dBm max 802.11a, 54Mbps: -74dBm max 802.11n, MCS07: -69dBm max 802.11n, MCS15: -66dBm max 802.11ac, 1SS, MCS-0: -86dBn 802.11ac, 1SS, MCS-0: -83dBn 802.11ac, 2SS, MCS-9: -58dBn	ximum mum ximum mum ximum ximum imum imu	
Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode  802.11b, 1Mbps : -94dBm maximum		
Power Consumption	Transmit: 2.0 W (max) Receive: 1.6 W (max) Idle mode (PSP): 180 mW (WLAN Associated) Idle mode: 50 mW (WLAN unassociated) Connect Standby: 10 mW (WLAN+BT) Radio disabled: 5 mW		
	<sup>2</sup> Maximum output power may	vary by country according to local regulations.	
	• 802.11ac 80MHz(5GH:	r) : +11dBm minimum	



Altitude	Operating: Non-operating:		0 to 10,000 ft (3,000 to 50,000 ft (15	
LED Activity	LED Amber – Radio OFF; LED White – Radio ON			
* Wireless access point and Inte	ernet service required a	nd not included. A	vailability of public w	vireless access points limited.
HP Integrated Module with Bl	luetooth® 4.0/4.1/4.2	Wireless Technolo	gy	
Bluetooth® Specification	4.0/4.1/4.2 Complia	nt		
Frequency Band	2402 to 2480 MHz			
Number of Available Channels	Legacy : 0~79 (1 MHz/CH) BLE : 0~39 (2 MHz/CH)			
Data Rates and Throughput	Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps  BLE: 1 Mbps data rate; throughput up to 0.2 Mbps Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels			
				khns voice channels
			up 10 0, 0 .	Rops, voice chamicis
	Legacy : Asynchrono 864 kbps symmetrio		•	177.1 kbps asymmetric (3-DH5) or
Transmit Power	864 kbps symmetric	: (3-EV5) iponent shall opera	s links 2178.1 kbps/ te as a Class II Bluet	
	864 kbps symmetric	: (3-EV5) iponent shall opera	s links 2178.1 kbps/ te as a Class II Bluet	177.1 kbps asymmetric (3-DH5) or
Receiver Sensitivity	864 kbps symmetric  The Bluetooth® comtransmit power of +  Modulation GFSK	ponent shall opera 4 dBm for BR and I 0.01% BER -80 dBm	te as a Class II Bluet DR.  0.001% BER -70 dBm	177.1 kbps asymmetric (3-DH5) or
Receiver Sensitivity	864 kbps symmetric  The Bluetooth® comtransmit power of +  Modulation  GFSK  π/4-DQPSK	ponent shall opera 4 dBm for BR and I 0.01% BER -80 dBm -80 dBm	te as a Class II Bluet DR.  0.001% BER -70 dBm -70 dBm	177.1 kbps asymmetric (3-DH5) or
Receiver Sensitivity	864 kbps symmetric  The Bluetooth® comtransmit power of +  Modulation GFSK	ponent shall opera 4 dBm for BR and I 0.01% BER -80 dBm	te as a Class II Bluet DR.  0.001% BER -70 dBm	177.1 kbps asymmetric (3-DH5) or
Receiver Sensitivity Legacy	864 kbps symmetric  The Bluetooth® comtransmit power of +  Modulation  GFSK π/4-DQPSK 8DPSK	ponent shall opera 4 dBm for BR and I 0.01% BER -80 dBm -80 dBm	te as a Class II Bluet DR.  0.001% BER -70 dBm -70 dBm	177.1 kbps asymmetric (3-DH5) or
Receiver Sensitivity Legacy	864 kbps symmetric  The Bluetooth® comtransmit power of +  Modulation GFSK π/4-DQPSK 8DPSK  Peak (Tx) 330 mW	ponent shall opera 4 dBm for BR and I 0.01% BER -80 dBm -80 dBm	te as a Class II Bluet DR.  0.001% BER -70 dBm -70 dBm	177.1 kbps asymmetric (3-DH5) or
Receiver Sensitivity Legacy	864 kbps symmetric  The Bluetooth® comtransmit power of +  Modulation  GFSK π/4-DQPSK 8DPSK	oponent shall opera 4 dBm for BR and B 0.01% BER -80 dBm -80 dBm -80 dBm	te as a Class II Bluet DR.  0.001% BER -70 dBm -70 dBm	177.1 kbps asymmetric (3-DH5) or
Receiver Sensitivity Legacy Power Consumption	864 kbps symmetric  The Bluetooth® comtransmit power of +  Modulation GFSK π/4-DQPSK 8DPSK  Peak (Tx) 330 mW Peak (Rx) 230 mW	(3-EV5)  aponent shall opera 4 dBm for BR and B  0.01% BER  -80 dBm  -80 dBm  -80 dBm	te as a Class II Bluet DR.  0.001% BER -70 dBm -70 dBm	177.1 kbps asymmetric (3-DH5) or
Receiver Sensitivity Legacy Power Consumption Range	864 kbps symmetric  The Bluetooth® come transmit power of +  Modulation  GFSK π/4-DQPSK 8DPSK  Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend 1  Legacy Up to 33 ft (2)	(3-EV5)  aponent shall opera 4 dBm for BR and B  0.01% BER  -80 dBm  -80 dBm  -80 dBm	te as a Class II Bluet DR.  0.001% BER -70 dBm -70 dBm	177.1 kbps asymmetric (3-DH5) or
Transmit Power  Receiver Sensitivity Legacy  Power Consumption  Range  Electrical Interface  Bluetooth® Software Supported Link Topology	The Bluetooth® come transmit power of +  Modulation  GFSK π/4-DQPSK  8DPSK  Peak (Tx) 330 mW  Peak (Rx) 230 mW  Selective Suspend 1  Legacy Up to 33 ft (7 BLE Up to 99 ft (30 m)	oponent shall opera 4 dBm for BR and B O.01% BER -80 dBm -80 dBm -80 dBm	te as a Class II Bluet DR.  O.001% BER  -70 dBm  -70 dBm  -70 dBm	177.1 kbps asymmetric (3-DH5) or



Bluetooth® Software Supported Security	
	Full support of Bluetooth® Security Provisions
Power Management Certifications	Microsoft Windows ACPI, and USB Bus Support
	Self-configurable to optimize power conservation in all operating modes, including Standby, Hold, Park, and Sniff
Security	All necessary regulatory approvals for supported countries, including:
Certifications Bluetooth® Profiles Supported	FCC (47 CFR) Part 15C, Section 15.247 & 15.249
Power Management Certifications	ETS 300 328, ETS 300 826
	Low Voltage Directive IEC950
Certifications	UL, CSA, and CE Mark
Bluetooth® Profiles Supported	Serial Port Profile (SPP) <sup>1</sup> Service Discovery Application Profile (SDAP) Dial-Up Networking (DUN) <sup>1,2</sup> Generic Object Exchange Profile (GOEP) <sup>1,2</sup> Object Push Profile (OPP) <sup>1,2</sup> Hard Copy Cable Replacement (HCRP) <sup>1,2</sup> Personal Area Networking Profile (PAN) <sup>1,2</sup> Human Interface Device Profile (HID) <sup>1,2</sup> Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP)
Bluetooth® V4.1/V4.2 support feature	V4.1: ESR5/6/7 compliant  V4.2: ESR8 compliant, LE Secure Connection – Basic.



HP ProDesk 400 G3 DM, HP ProDesk 400 G4 MT/SFF and HP ProOne 400 G3 Business Desktops PCs

Technical Specifications – Audio

#### **AUDIO**

#### High Definition Audio - MT/SFF/DM

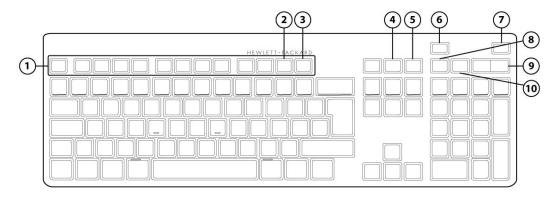
_			
Туре	Integrated		
HD Stereo Codec	Conexant CX20632		
Audio I/O Ports	Headset connector supports a CTIA style headset and is re-taskable as a Line-in, Line-out, Microphone-in or Headphone-out port		
	Rear Line-Out		
	Front Headphone-Out		
	All ports are 3.5mm and support stereo ( see above tables for system configurations)		
Internal Speaker Amplifier	2W class D mono amplifier for the internal speaker only. External speakers must be powered externally.		
Multi-streaming Capable	Playback multi-streaming can be enabled in the audio control panel to allow independent audio streams to be sent to/from the front and rear jacks or integrated speaker.		
Sampling	Independent sampling rates for DAC's and ADC's; supports resolutions from 16 to 24-bit; 44.1 kHz to 192 kHz for DAC and 44.1 kHz to 96 kHz for ADC		
Wavetable Syntheses	Yes – Uses OS soft wavetable		
Analog Audio	Yes		
# of Channels on Line-Out	Stereo (Left & Right channels)		
Internal Mono Speaker	Yes		



Technical Specifications – Input/Output Devices

#### **INPUT/OUTPUT DEVICES**

#### **HP Conferencing Keyboard**



1.	Function Keys		6.	End/Decline a Call
2.	F11 Lync or Skype for Business Contact list *		7.	Answer a Call
3.	F12 Lync or Skype for Busine	ess Calendar **	8.	Microphone Mute
4.	Share Screen		9.	Volume Up/Down
5.	Stop Webcam		10.	Audio Mute
*M	icrosoft Lync 2013, or Skype f	or Business, or Microsoft Outlook 2013	Conta	nct list
**M	icrosoft Lync 2013, or Skype f	or Business, or Microsoft Outlook 2013	Calen	dar
<b>Dimensions (H x L x W)</b> 0.85 x 17.34 x 6.10 in (2.16 x 44.		0.85 x 17.34 x 6.10 in (2.16 x 44.05 x	(15.50	O cm)
Weight 24.69 oz. ( 700 g)				
Connectivity USB cable				
Keys 110 (US) Layout, 111 (EU) Layout – depending upon country		ling upon country		
Feature Summary  Full-size ultra-quiet keyboard with One-touch simplicity for Microsoft I light indicators			cal pad and 12 function keys Skype for Business calls with dedicated keys and LED	
Illuminated keys  Incoming Call – Blinks Green Call in progress – Green Microphone Mute – Orange Audio Mute – Orange				

Technical S	pecifications	-Input/(	לוומלוו(	Devices
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	Screen Sharing — Orange Stop Webcam — Orange		
Other Call control keys	S End/Decline Call Volume up and down rocker key		
Microsoft Lync/Outlook	Fn+F12 – Lync or Skype for Business Calendar will open. If Lync or Skype for Business is not available will bring Outlook Calendar * Fn+F11 – Lync or Skype for Business Contact will open. If Lync or Skype for Business is not available will bring Outlook Contact list *  * Fn+11 and Fn+12 function keys are not supported in Microsoft Windows 8.x Metro mode		
	"FITT I dilu Fitt 12 function keys die not supported in Pilcrosoft Windows 6.5 Pietro mode		
Functions Keys	Fn+F10 – System Settings Fn+F9 – Devices Fn+F8 – Search Fn+F7 – Blank Fn+F6 – Up Brightness Adjustment Fn+F5 – Down Brightness Adjustment Fn+F4 – Display Options Fn+F3 – File Explorer Fn+F2 – System Lock Fn+F1 – System Sleep		
System requirements	Available USB port Windows 7, Windows 8.x, and Windows 10 Server: Microsoft Lync Server 2010 or 2013 and Skype for Business Server 2015 Client: Microsoft Lync 2013 version 15.0.46xx or newer or Skype for Business Notes:  Limited support for Microsoft Lync 2010, Microsoft Lync 2013 Basic and Microsoft Metro Mode Screen brightness functions supported in select HP systems		
Approvals EMC Product Safety	FCC; CE; ACA(C-tick); EAC UL, CE Mark		

HP USB PS/2 Washable Keyboard		
Physical Characteristics	Keys	104 (US) Layout, 105 (EU) layout – depending upon country
	Dimensions (L x W x H)	17.67x 6.62 x 1.38 in (449 x 168 x 35 mm)
	Weight	1.7 lb (0.77 kg) minimum
Electrical	Operating voltage	+ 5VDC ±5%
	Power consumption	50-mA maximum (with three LEDs ON)



	System interface	USB Type A plug connector
	ESD	CE level 4, 15-kV air discharge
	EMI - RFI	Conforms to FCC rules for a Class B computing device
	Microsoft PC 99 - 2001	Functionally compliant
	Keycaps	Stepped -profile design
	Switch actuation	55-g nominal peak force with tactile feedback
	Switch life 20 million keystrokes	
	Switch type Contamination-resistant switch membrane	
Mechanical	Key-leveling mechanisms	For all double-wide and greater-length keys
	Cable length	7 ft (2.2 m)
	Microsoft PC 99 - 2001	Mechanically compliant
	Acoustics	43-dBA maximum sound pressure level
	Operating temperature	50° to 122° F (10° to 50° C)
	Non-operating temperature	4° to 149° F (-20° to 65° C)
	Operating humidity	10% to 95% (non-condensing at ambient)
	, , ,	
	Non-operating humidity	0% to 95% (non-condensing at ambient)
Environmental	Operating shock	40 g, six surfaces
	Non-operating shock 80 g, six surfaces	
	Operating vibration 2-g peak acceleration	
	Non-operating vibration 4-g peak acceleration	
	Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence
	Drop (in box)	42 in (107 cm) on concrete, 16-drop sequence
Operating system support	Windows® 7, Windows Vista, Wi	indows XP Professional
Approvals	UL, cUL, FCC, CE, TUV GS, VCCI, E IP66/NEMA4X	BSMI, C-Tick, KCC, USB-IF, WHQL, EN/IEC 60601-1,
Ergonomic compliance	ANSI HFS 100, ISO 9241-4, and	TUVGS
IP USB Business Slim S	martcard Keyboard	
	Keys	104, 105, 109 layout
	D'	(depending upon country
hysical Characteristics	Dimensions (H x W x D)	17.34 x 5.68 x 0.78 in (440.6 x 14.45 x 1.98 cm)
	Weight	1.32 lb (0.6± 0.1 kg)
	Operating voltage	5V
	Power consumption	200 mA
lectrical	System interface	USB Interface
iscosi icut	ESD Air 12.5kV / Contact 8kV	
	EMI - RFI under 3dB	
	Microsoft PC 99 - 2001	Conforms to FCC rules for a Class B computing device



Keys	104, 105, 106, 107, 109	layout (depending upon country	
n Keyboard			
Keyboard, I/O Security and Docum	nentation CD, warranty card		
ISO 9241-410, TUV GS			
CE Marking; TUV; EAC; FCC; cULus/CSAus; ICES; RCM; VCCI; KCC; BSMI			
Liecti o-magnetic stanuarus	USA	USAFCC part 15	
•		2004/108/EC	
	·		
Interface modes		יים ויים, יים ווואפונוטוו ניינופא	
Landing mechanism		Up to 100,000 insertion cycles	
Landing mechanism	-	Friction contact	
Communication		12 Mbps (USB transfer speed)	
· · · · · · · · · · · · · · · · · · ·		9600 bps to 330,000 bps	
Power consumption			
		t with ISO7816 and EMV (5V, 60	
		protects smart card and reader)	
Power	USB Port		
Standard APIs supported	PC/SC, EMV2000, CT-API		
Chipset	IDENTIVE CLOUD 2190 F		
	and microprocessor sm	art cards (T=0, T=1)	
Interface	Reads from and writes to all ISO7816-1, 2, 3, 4 mem		
Support	All ISO 7816 smart cards		
Drop (in box)	30 in (76.2 cm) on concrete, 16-drop sequence		
(out of box)			
		civ-drop coguenco	
	_		
		ensing at ambient)	
	10% to 90% (non-condensing at ambient)		
	50° to 122° F (10° to 50° C)		
	43-dBA maximum sound pressure level		
	For all double-wide and	l greater-length keys	
Switch type	Contamination-resistant switch membrane		
Switch life	10 million keystrokes (Life tester)		
Switch actuation	60±15g nominal peak force with tactile feedback		
	Switch life Switch type Key-leveling mechanisms Cable length Acoustics Operating temperature Non-operating temperature Operating humidity Non-operating shock Non-operating shock Operating vibration Non-operating vibration Drop (out of box) Drop (in box) Support Interface Chipset Standard APIs supported Power  Power consumption Communication  Landing mechanism  Interface modes Reader performance interface Electro-magnetic standards  CE Marking; TUV; EAC; FCC; cULus/ ISO 9241-410, TUV GS Keyboard	Switch actuation  Switch life  Switch life  Switch type  Contamination-resistar  Key-leveling mechanisms  Cable length  Acoustics  Operating temperature  Operating humidity  Operating humidity  Operating shock  Non-operating shock  Non-operating vibration  Drop  (out of box)  Support  Interface  Chipset  Chipset  Chipset  Chipset  Chipset  Characa  Chipset  Characa  Chipset  Chi	



	Dimensions (L x W x H)	171.97 x 68.35 x 8.27 in (436.8± 1.5 x 137.6± 1.0 x 21.0± 1.0 cm)	
	Weight	1.32 lb (0.6± 0.08 kg)	
	Operating voltage	+ 4.4 – 5.25VDC	
	Power consumption	50-mA maximum (with 5 VDC power supplied and three LEDs ON)	
	System interface	USB Type A plug connector	
Electrical	ESD	Contact Discharge: 2, 4,6,8KV Air Discharge: 2, 4, 8,10,12.5KV	
	EMI - RFI	Conforms to FCC rules for a Class B computing device	
	Microsoft® PC 99 - 2001	Functionally compliant	
	Keycaps	Low-profile design	
	Switch actuation	60±12.5g nominal peak force with tactile feedback	
	Switch life	10 million keystrokes (Life tester)	
Mechanical	Switch type	Contamination-resistant switch membrane	
	Key-leveling mechanisms	For all double-wide and greater-length keys	
	Cable length	6 ft (1.8 m)	
	Microsoft PC 99 - 2001	Mechanically compliant	
	Acoustics	43-dBA maximum sound pressure level	
	Operating temperature	50° to 122° F (10° to 50° C)	
	Non-operating temperature	-22° to 140° F (-30° to 60° C)	
Environmental	Operating humidity	10% to 90% (non-condensing at ambient)	
	Non-operating humidity	20% to 80% (non-condensing at ambient)	
	Operating shock	40 g, six surfaces	
	Non-operating shock	80 g, six surfaces	



	Operating vibration	2-g peak acceleration	
	Non-operating vibration	4-g peak acceleration	
	Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence	
	Drop (in box)	30 in (76.2 cm) on concrete, 16-drop sequence	
Approvals	UL, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, KC		
Ergonomic compliance	ANSI HFS 100, ISO 9241-4, and TUVGS		
Kit contents	Keyboard	Installation Guide	
	Warranty Card	Safety and Comfort Guide	
HP PS/2 Business Slim I	Keyboard		
	Keys	104, 105, 106, 107, 109 layout (depending upon country)	
Physical Characteristics	Dimensions (L x W x H)	171.97 x 68.35 x 8.27 in (436.8± 1.5 x 137.6± 1.0 x 21.0± 1.0 cm)	
	Weight	1.32 lb (600± 80 g)	
	Operating voltage	+ 4.4 – 5.25VDC	
	Power consumption	50-mA maximum (with 5 VDC power supplied and three LEDs ON)	
	System interface	PS/2 6-pin mini din connector	
	ESD	Contact Discharge: 2, 4,6,8KV Air Discharge: 2, 4, 8,10,12.5KV	
Electrical	EMI - RFI	Conforms to FCC rules for a Class B computing device	
	Microsoft PC 99 - 2001	Functionally compliant	
	Keycaps	Low-profile design	
	Switch actuation	60±12.5g nominal peak force with tactile feedback	
	Switch life	10 million keystrokes (Life tester)	
	Switch type	Contamination-resistant switch membrane	



### Technical Specifications – Input/Output Devices

	Key-leveling mechanisms	For all double-wide and greater-length keys	
	Cable length	6 ft (1.8 m)	
	Microsoft PC 99 - 2001	Mechanically compliant	
	Acoustics	43-dBA maximum sound pressure level	
	Operating temperature	50° to 122° F (10° to 50° C)	
	Non-operating temperature	-22° to 140° F (-30° to 60° C)	
	Operating humidity	10% to 90% (non-condensing at ambient)	
	Non-operating humidity	20% to 80% (non-condensing at ambient)	
Environmental	Operating shock	N/A	
	Non-operating shock	65 inch 2.9 ms, six surface; 30g 266 inch/second; 50g 266 inch/second six surface	
	Operating vibration	2-g peak acceleration	
	Non-operating vibration	Starting at 5 Hz, vary the frequency of vibration from 5 to 500 Hz and back to 5 Hz at a Logarithmic sweep rate of 1 octave per minute.	
	Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence	
	Drop (in box)	29.93 in (76 cm) on concrete, 16-drop sequence	
Approvals	UL, FCC, CE Mark, TUV, TUV GS,	UL, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, KC	
Ergonomic compliance	ANSI HFS 100, ISO 9241-4, and TUVGS		

### **HP USB (Grey) Business Slim Keyboard**

Physical characteristics	Keys	104, 105, 106, 107, 109 layout (depending upon country)
	Dimensions (L x W x H)	17.19 x 5.41 x 0.82 in (43.68±1.5 x 13.76±1.0 x 2.1 ±1.0 cm)
	Weight	1.32 lb (0.6± 0.08 kg)
Electrical	Operating voltage	+ 4.4 – 5.25VDC
	Power consumption	100-mA maximum (with 5 VDC power supplied and three LEDs ON)
	System interface	USB Type A plug connector
	ESD	Contact Discharge: 4, 6, 8 KV
	EMI – RFI	Air Discharge: 8, 10, 12 KV / 15 KV
	Microsoft PC 99 – 2001	Conforms to FCC rules for a Class B computing device; Functionally compliant
Mechanical	Keycaps	Low-profile design



### Technical Specifications – Input/Output Devices

	Switch actuation	Rubber dome + membrane	
	Switch life	10 million	
	Switch type	Rubber dome	
	Key-leveling mechanisms	Link bar	
	Cable length	For all double-wide and greater-length keys	
	Microsoft PC 99 – 2001	Yes	
Environmental	Acoustics	55-dBA maximum sound pressure level	
	Operating temperature	10°C to 50°	
	Non-operating temperature	-30°C to 90°	
	Operating humidity	10% to 90% (non-condensing at ambient)	
	Non-operating humidity	60% to 80% (non-condensing at ambient)	
	Operating shock	40 g, six surfaces	
	Non-operating shock	80 g, six surfaces	
	Operating vibration	2-g peak acceleration	
	Non-operating vibration	4-g peak acceleration	
	Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence	
	Drop (in box)	30 in (76.2 cm) on concrete, 16-drop sequence	
Approvals	FCC; CE; VCCI; BSMI; KC; EAC; RCM; TUV-GS; UL; RoHS; WEEE		
Ergonomic compliance	ANSI HFS 100; ISO 9241-4; and TUVGS		

### **HP Wireless Business Slim Keyboard and Mouse**

	•					
Keyboard	Dimensions ( L x W x H)	171.97 x 68.35 x 8.27 in (436.8± 1.5 x 137.6± 1.0 x 21.0± 1.0 cm)				
	Weight – Without Two AA Alkaline Batteries	1.23 lb (560± 80 g)				
	Dimensions (H x L x W)	1.46 x 4.53 x 2.47 in (37 x 115 x 62.9 mm)				
Mouse	Weight – Without Two AA Alkaline Batteries	0.15 lb (67 g)				
	Dimensions (H x L x W)	0.33x 1.79 x 0.72 in (8.4 x 45.5 x 18.4 mm)				
Receiver	Weight	0.21 oz (5.9 g)				
Receiver	Cable Length – Minimum	6 ft (1.8 m)				
	Range	32.8 ft (10 m)				
System Requirements	Available USB port for the receiver  CD-ROM Drive  *This system may require upgraded and/or separately purchased hardware and/or a drive to install the Windows 7 software and take full advantage of Windows 7 function See http://www.microsoft.com/windows/windows-7/ for details.					
Approvals	Product Safety	UL; CSA /TUV (Europe only); CE Mark; CB Report				
Approvals	Ergonomics	ANSI; ISO (Europe only); GS Mark (Germany only)				



	EMC	FCC; CE; ACA (-tick); BSMI; KC ; VCCI			
	CE Mark	EN 55022:2010; EN 55024; EN 301489-1; EN 61000			
	Design Guidelines for PCs	PC 99 – connector overmold colors; PC 2001 – full functionality			
	Telecom	All local telecom requirements and approvals for intended markets			
	USA	FCC Title 47 CFR, Par 15, Subpart C; other local requirements			
	Country Support	US, Belgium, Switzerland, Spain, Denmark, Netherlands, France, Germany, Italy, Portugal, Sweden, Norway, Finland, UK, Poland, Czech Republic, Turkey, Greece, Austria, Bulgaria, Cyprus, Estonia, Hungary, Ireland, Latvia, Lithuania, Luxemburg, Malta, Romania, Slovakia, Slovenia, Vietnam, HK, Australia, NZ, Malaysia, Singapore, Indonesia, Philippines, Thailand, Canada, China, Japan, Korea, Taiwan, India, Venezuela, Ecuador, Russia, Ukraine, Israel, Croatia, United Arab Emirates, Peru, Brazil, Chile, Argentina, Mexico, South Africa, and up to 193 countries worldwide.			
Environmental	Keyboard contains 25% post-cons	ard contains 25% post-consumer recycled plastic material.			

HP PS/2 Mouse							
Dimensions (H x L x W)	1.46 x 2.48 x 4.53 in (3.70 x 6.2	1.46 x 2.48 x 4.53 in (3.70 x 6.29 x 11.50 cm)					
Weight	3.53 oz (100g; +10g/- 5 g)	3.53 oz (100g; +10g/- 5 g)					
	Operating temperature	-32° to 104°F (0° to 40° C)					
	Non-operating temperature	-4° to 140°F (-20° to 60° C)					
	Operating humidity	10% to 90% (non condensing at ambient)					
Environmental	Non-operating humidity	10% to 90% (non condensing at ambient)					
	Operating shock	40 g, 6 surfaces					
	Non-operating shock	80 g, 6 surfaces					
	Operating vibration	2 g peak acceleration					
	Non-operating vibration	4 g peak acceleration					
	Drop (out of box)	80 cm height onto asphalt tile over concrete or equivalent, 5-drop in 5 direction except the cable face					
	Operating voltage	5 VDC ± 10%					
Electrical	Power consumption	100mA					
	System consumption	PS/2 mini-din connector					



	ESD	CE level 4, 15 kV air discharge				
	EMI-RFI	Conforms to FCC rules for a Class B computing device				
	Microsoft PC99 - 2001	Functionally compliant				
	Resolution	800 DPI				
	Tracking speed	10 in/s (25.4 cm/s) maximum				
	Acceleration	±15%				
	Switch actuation	65±20 gf				
Mechanical	Switch life	3,000,000 operations (using Hasco modified tester)				
	Switch type	Low force micro-switches				
	Tracking mechanism life	80 km				
	Cable length	6 ft (1.8 m)				
	Microsoft PC99 - 2001	Mechanically compliant				
	Width	6 mm				
	Diameter	22.5 ± 0.2 mm				
6	Maximum rotation force	50 gf-cm				
Scroll wheel	Switch type	Light force micro-switch				
	Switch life	1 million operations				
	Mechanical life	Minimum 200,000 revolutions				
Regulatory Approvals UL/cUL, FCC, CE Mark, TUV/GS,		5, VCCI, KCC, BSMI, C-Tick				
HP USB 1000dpi L	aser Mouse					
Dimensions (H x L x W)	1.47 x 4.53 x 2.47 in (37.3 x 1	14.97 x 62.86 mm)				
Weight	3.360 oz (102g)					
Cable length	70.9 in (180 cm)					
System requirements	Available USB port					
Environmental	Operating Temperature	32° to 104° F (0° to 40° C)				
	Non-operating Temperature	-4° to 140° F (-20° to 60° C)				
	Operating Humidity	10% to 90% (non-condensing at ambient)				
Mechanical	Resolution	1000dpi				
	Tracking Speed	45 cm/sec				
	Cable Length	70.9 in (180 cm)				
HP USB PS/2 Wash	nable Mouse	·				
Dimensions (H x L x W)	1.56 x 2.44 x 4.61 in (3.95 x 6.21 x	11.7 cm)				
Weight	<b>ht</b> 4.44 oz (126 g)					
Environmental	Operating temperature —32° to 104°F (0° to 40° C)					



	Non-operating temperature	-4° to 140°F (-20° to 60° C)
	Operating humidity	10% to 90% (non-condensing at ambient)
	Non-operating humidity	10% to 90% (non condensing at ambient)
	Operating shock	40 g, 6 surfaces
	Non-operating shock	80 g, 6 surfaces
	Operating vibration	2 g peak acceleration
	Non-operating vibration	4 g peak acceleration
	Drop (out of box)	80 cm height onto asphalt tile over concrete or equivalent, 5-drop in 5 direction except the cable face
Electrical	Operating voltage	5 VDC ± 10%
	Power consumption	100mA
	System consumption	PS/2 mini-din connector
	ESD	CE level 4, 15 kV air discharge
	EMI-RFI	Conforms to FCC rules for a Class B computing device
	Microsoft® PC99 – 2001	Functionally compliant
Mechanical	Resolution	400 ± 20% DPI
	Tracking speed	10 in/s (25.4 cm/s) maximum
	Acceleration	100 in/s/s (2.54 m/s/s)
	Switch actuation	61 g nominal peak force
	Switch life	3,000,000 operations (using Hasco modified tester)
	Switch type	Low force micro-switches
	Tracking mechanism life	155 mi (250 km) at average speed of 10 in/s
	Cable length	6 ft (1.8 m)
	Microsoft PC99 – 2001	Mechanically compliant
Scroll wheel	Width	8 mm
	Diameter	1.01 in (25.6 mm)
	Maximum rotation speed	48 rats/sec
	Switch type	Light force micro-switch
	Switch life	1 million operations
	Mechanical life	Minimum 200,000 revolutions
Regulatory approvals	Compliant	UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, MIC

HP USB Hardened Mouse		
Mouse Type	Wired optical mouse	
Interface	USB 2.0	



Under nominal 5 VDC power supplied, max current consumption is 100mA

Dimensions (H x L x W)	114.97 x 62.92 x 37.3 mn (11.49 x 6.29 x 1.46 in)	114.97 x 62.92 x 37.3 mm (+/-0.3 mm) (11.49 x 6.29 x 1.46 in)				
Weight	92 g (+/-10 g) (3.2 oz)					
Cable length	1.8 M					
Tracking X-Y	X-Y Positioning	X-Y Wheel Resolution	1000 DPI			
		Tracking Speed	Up to 30 in/sec in either X or Y direction			
	Z Axis Wheel	Z Wheel Revolution	24 counts per revolution			
		Tracking Speed	0 ~ 120 rpm			
Environmental	Operating temperature	0° - 40°C				
	Non-operating temperature	-40° - 65°C				
	Operating humidity	90%				
	Agency Approvals	CE FCC				

RCM VCCI EMC EAC BSMI UL

KCC TUV/GS

Windows 10, Windows 8.1 32/64bit, Windows 7 32/64bit

Input Voltage & Current

**Power Consumption** 

Black

ICES-003 Class B

4.4 ~ 5.25 VDC / 100 mA

with tracking speed up to 30 in/sec

HP Grey V2 Mouse						
Dimensions (H x L x W)	1.46 x 4.53 x 2.48 in (3.72 x 11	1.46 x 4.53 x 2.48 in (3.72 x 11.5 x 6.29 cm) ±1 mm				
Weight	3.53 oz (100g; +10g/- 5 g)	3.53 oz (100g; +10g/- 5 g)				
	Operating temperature	50° to 122°F (10° to 50° C)				
	Non-operating temperature	-22° to 140°F (-30° to 60° C)				
Environmental	Operating humidity	10% to 90% (non condensing at ambient)				
	Non-operating humidity	20% to 80% (non condensing at ambient)				
	Operating shock	40 g, 6 surfaces				



Electrical

System requirements

Color

	Non-operating shock	80 g, 6 surfaces			
	Operating vibration	2 g peak acceleration			
	Non-operating vibration	4 g peak acceleration			
Floatuical	Operating voltage	4.75~5.25 Vdc			
Electrical	Power consumption (typical)	10mA			
	Connector	USB 2.0			
	Туре	3D mouse (3 keys and wheel)			
	Resolution	800 DPI			
Mechanical	Sensor	PixArt vendor Optical USB mouse sensor. DIP			
	Tracking speed	30 inch/sec (max)			
	Tracking acceleration	8G(max), 1G=9.8m/s2			
	Cable length	6 ft (1.8 m)			
Color	Grey	Grey			
Regulatory Approvals	FCC, CE, ICES, C-TICK, VCCI, KCC, BSMI, ISO9241, Part 4, Computer Work Station Ergonomics compliance, IEC 801-2, IEC 1000-4-2, EN 55024:1998 + A1:2001 + A2:2003, European Standard EN 55022: 2006 Class B, CE Mark				

HP USB Mouse						
Dimensions (H x L x W)	2.5 x 4.5 x 1.5 in (63.5	2.5 x 4.5 x 1.5 in (63.5 x 114.3 x 38.1 mm)				
Weight	0.22 lb (99.79 g)	0.22 lb (99.79 g)				
Color	Black	Black				
Connector	USB					
Mechanical	Resolution	800 DPI sensitivity				
	Buttons	Buttons Two primary buttons and clickable scroll wheel				



Technical Specifications – Miscellaneous Features

#### MISCELLANEOUS FEATURES

#### **Management Features**

- Advanced Configuration and Power Management Interface (ACPI). Allows the system to wake from a low power mode.
   Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.
- Intel® Wired for Management support; industry wide initiative to make Intel® architecture based PCs, servers and mobile computers more inherently manageable out-of-the-box and over the network
- Dual State Power Button; acts as both an on/off button and a suspend-to-sleep button

#### **Serviceability Features**

- Dual colored power LED on front of computer to indicate either normal or fault condition
- Diagnostic LED Explanation Table:
  - Power LED will blink red 2 to 5 times, then blink white 2 or more times, then repeat (with beep tones for each blink initially):
    - 2 red + 2 white User must provide file for BIOS recovery (USB storage typically)
    - 2 red + 3 white User must enter a key sequence to proceed with recovery by policy
    - 2 red + 4 white BIOS recovery is in progress
    - 3 red + 2 white Memory could not be initialized
    - 3 red + 3 white Graphics adapter could not be found
    - 3 red + 4 white Power supply failure / not connected
    - 3 red + 5 white Processor not installed
    - 3 red + 6 white Current processor does not support an enabled feature
    - 4 red + 2 white Processor has exceeded its temperature threshold / system thermal shutdown
    - 4 red + 3 white System internal temperature has exceeded its threshold
    - 5 red + 2 white System controller firmware is not valid
    - 5 red + 3 white System controller detected BIOS is not executing
    - 5 red + 4 white BIOS could not complete initialization / PCA failure
    - 5 red + 5 white
       System controller rebooted the system after a health or recovery timer triggered
- HP PC Hardware Diagnostics UEFI:
  - This utility enables hardware level testing outside the operating system on many components. The diagnostics can be invoked by pressing F2 at POST, and is available as a download from http://hp.com/go/techcenter/pcdiags
- System/Emergency ROM
- Flash ROM
- CMOS Battery Holder for easy replacement
- BIOS recovery files are maintained on the local OS drive when updating with HP BIOS Update and Recovery utility (HPBIOSUPDREC)
- 5 Aux Power LED on System PCA
- Processor ZIF Socket for easy Upgrade
- Over-Temp Warning on Screen (Requires IM Agents)
- Clear Password Jumper
- DIMM Connectors for easy Upgrade
- Clear CMOS Button
- NIC LEDs (integrated) (Green & Amber)
- Dual Color Power and HD LED To Indicate Normal Operations and Fault Conditions
- Color coordinated cables and connectors
- Front power switch
- System memory can be upgraded without removing the system board or any internal components
- CD & Diskette Removal



Technical Specifications – Miscellaneous Features

Tool icon for easy Identification

#### ADDITIONAL FEATURES

#### Description

**Drive Lock** 

Implementation of the industry standard ATA Security feature set. When enabled, it prevents software access to user data on the drive until one or two user-defined passwords are provided.

**Boot Sectors Protection** 

MBR or GPT boot sectors of the hard drive are critical to securely starting the operating system. By saving the MBR or GPT data (depending on the how the OS was installed), the BIOS will be able to monitor for changes and allow the user to override them with the backup copy at boot-up.

DPS Access through F10 Setup during Boot

A diagnostic hard drive self-test. It scans critical physical components and every sector of the hard drive for physical faults and then reports any faults to the user Running independently of the operating system, it can be accessed through a Windows-based diagnostics utility or through the computer's setup procedure. It produces an evaluation on whether the hard drive is the source of the problem and needs to be replaced

Drive Protection System

The system expands on the Self-Monitoring, Analysis, and Reporting Technology (SMART), a continuously running systems diagnostic that alerts the user to certain types of failures

SMART Technology (Self-Monitoring, Analysis and Reporting Technology) Allows hard drives to monitor their own health and to raise flags if imminent failures were predicted

**SMART I - Drive Failure Prediction** 

Predicts failures before they occur. Tracks fault prediction and failure indication parameters such as re-allocated sector count, spin retry count, calibration retry count By avoiding actual hard drive failures, SMART hard drives act as "insurance" against

SMART II - Off-Line Data Collection

unplanned user downtime and potential data loss from hard drive failure

SMART III - Off-Line Read Scanning with Defect Reallocation **IOEDC: I/O Error Detection Circuitry** 

Defect Realtocation

Detects errors in Read/Write buffers on HDD cache RAM

SMART IV - End-to-End CRC for hard drives

Interface in F10 setup provides confirmation of SMART IV support.



After-Market Options (availability may vary by region)

iness Monitors (sample list)*	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT	Part Numbe
HP ProDisplay P240va 23.8-inch Monitor	X	Х	Х	Х	Х	N3H14AA
HP ProDisplay P232 23-inch Monitor	Х	Х	Х	Х	Х	K7X31AA
HP ProDisplay P222c 21.5-inch Video Conferencing Monitor	Х	Х	х	Х	Х	L4J08AA
*Additional models are available.						
munication Devices	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT	Part Numbe
Intel® Ethernet I210 - T1 Gbe NIC			X	X	Х	E0X95AA
Intel® 7265 802.11ac 2x2 DualBand Combo PCIe x1 Card			X	X	Х	N4G85AA
phics Solutions	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT	Part Numbe
NVIDIA® GeForce® GT 730 2GB DP PCIe x8 Card			Х	Х	Х	Z9H51AA
AMD® Radeon™ R7 450 4GB PCIe x16 Card				X	Х	Z9H52AA
HP UHD USB Graphics Adapter	X	Х	X	Х	X	N2U81AA
HP DisplayPort™ 1.2 Cable Kit	X	X	X	X	X	VN567AA
HP DisplayPort™ 1.2 To DVI-D Adapter	X	X	X	X	X	FH973AA
HP DisplayPort™ 1.2 To VGA Adapter	X	X	X	Х	X	AS615AA
HP DisplayPort™ 1.2 To HDMI 4k Adapter	X	X	X	X	Х	K2K92AA
HP DVI to DVI Cable	X		X	X	X	DC198A
HP (Bulk) 700mm DisplayPort™ 1.2 Cable Kit	X		X	X	X	V8Y77A6
a Storage Drives	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT	Part Numbe
HP 500GB 7200PRM SATA 6.0Gb/s 3.5" Hard Drive			X	X	X	QK554AA
HP 1TB 7200rpm SATA 6Gb/s 3.5" Hard Drive			X	X	X	QK555AA
HP 256GB SATA TLC Solid State Drive	X	X	X	X	X	P1N68AA
HP 512GB Turbo Drive G2 TLC M.2 SSD Drive	X	X				X8U75AA
HP Turbo Drive G2 TLC 512GB PCIe Drive			X	X	X	Z4L70AA
HP 9.5mm Slim Removable SATA 500GB			Х	Х	X	T7G14AA
HP 256GB SATA Non-SED Solid State Drive	X	X	X	Х	X	W0U55AA
HP 9.5mm G3 8/4 SFF G4 400 SFF/MT DVD- Writer			X	Х	X	1CA53AA
ıt Devices	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT	Part Numbe
HP Conferencing Keyboard	X	X	X	X	X	K8P74AA
HP USB Business Slim Keyboard	X	X	X	X	X	N3R87AA
HP PS/2 Business Slim Keyboard	X	X	X	Х	X	N3R86AA
HP Wireless Business Slim Keyboard and Mouse**	X	Х	Х	Х	Х	QY449AA
HP USB Business Slim Grey Keyboard (EMEA only)	X	X	X	X	Х	Z9H49AA
HP USB Business Slim Smart Card CCID Keyboard	Х	Х	Х	Х	Х	Z9H48AA



After-Market Options (availability may vary by region)

HP USB PS/2 Washable Keyboard and Mouse Kit**	Х	Х	Х	Х	Х	BU207AA
HP USB Grey V2 Mouse (EMEA only)	X	Х	Х	Х	Х	Z9H74AA
HP USB Business Slim Keyboard and Mouse (China Only)	Х	X	Х	Х	Х	Z9H50AA
HP USB Hardened Mouse	X	Х	Х	Х	Х	P1N77AA
HP PS/2 Mouse (Expansion module required for use with DM)	X	х	Х	Х	Х	QY775AA
HP USB Mouse	Х	Х	Х	х	Х	QY777AA
HP USB 1000dpi Laser Mouse	X	Х	Х	X	Х	QY778AA

<sup>\*\*</sup> Keyboard contains 25% post-consumer recycled plastic material

Desktop Mini Accessories	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT	Part Number
HP Desktop Mini DVD Super Multi-Writer ODD Expansion Module	Х					K9Q83AA
HP Desktop Mini 500GB HDD/ I/O Expansion Module	Х					K9Q82AA
HP Desktop Mini Rack Mount Tray Kit	х					G1K21AA
HP Desktop Mini Security/Dual VESA Sleeve	Х					G1K22AA
HP Desktop Mini 65W Power Supply Kit	Х					L2X04AA
HP Desktop Mini 90W Power Supply Kit	Х					L4R65AA
HP Desktop Mini Vertical Chassis Stand	Х					G1K23AA
HP Desktop Mini Port Cover Kit	Х					1ZE52AA
HP Desktop Mini I/O Expansion Module	Х					K9Q84AA
HP Integrated Work Center Desktop Mini/Thin Clients	Х					G1V61AA
HP Single Monitor Arm	Х					BT861AA
HP Quick Release Bracket	х					EM870AA
HP PC Mounting Bracket for Monitors	X					N6N00AT

System	n Memory	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT	Part Number
H	P 4GB DDR4-2400 DIMM			Х	Х	Х	Z9H59AA
H	P 8GB DDR4-2400 DIMM			Х	Х	Х	Z9H60AA
H	P 16GB DDR4-2400 DIMM			Х	Х	X	Z9H57AA
H	P 4GB DDR4-2400 SODIMM	Х	Х				Z9H55AA
H	P 8GB DDR4-2400 SODIMM	Х	Х				Z9H56AA
H	P 16GB DDR4-2400 SODIMM	Х	Х				Z9H53AA

Mult	imedia Devices	400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT	Part Number
	HP Business Headset v2	X	X	X	X	X	T4E61AA
	HP USB Business Speakers v2	X		X	X	X	N3R89AA

Security Devices		400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT	<b>Part Number</b>
	HP Business PC Security Lock v2 Kit			Х	X	Х	N3R93AA
	HP Keyed Cable Lock 10mm Kit	Х	Х	Х	X	х	T1A62AA
	HP Dual Head Keyed Cable Lock Kit	Х	Х	Х	Х	Х	T1A64AA



After-Market Options (availability may vary by region)

Stands and Accessories		400 G3 DM	400 G3 AiO	400 G4 SFF	400 G4 MT	480 G4 MT	Part Number
	HP (10) 400 G4 600/800 G3 SFF G4 MT Bezel			Х	Х		Z9H64A6
	Support Kit						
	HP Single Monitor Arm	X		Х	X	X	BT861AA
	HP ProOne 400 G3 Adjustable Height Stand		Х				2GU07AA

#### LANDesk Software (E-Delivery)\*

\*Optional and sold separately.



## HP ProDesk 400 G3 DM, HP ProDesk 400 G4 MT/SFF and HP ProOne 400 G3 Business Desktops PCs

After-Market Options (availability may vary by region)

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Change Log

Date of change:	Version History:	Action	Description of change:
January 25, 2017	Version 1 to 2	Launch	QS launched
February 13, 2017	Version 2 to 3	Update	Graphics Section updated
March 2, 2017	Version 3 to 4	Update	Accessories Section updated (added accessory), Environmental
		opuate .	Section updated (added Environmental data)
March 6, 2017	Version 4 to 5	Update	Storage section updated
March 9, 2017	Version 5 to 6	Update	After market section updated (added accessory)
March 21, 2017	Version 6 to 7	Update	Environmental Section updated
April 5, 2017	Version 7 to 8	Update	Dimensions nomenclature updated (W x D x H)
April 17, 2017	Version 8 to 9	Deleted	I/O devices from Features section
April 20, 2017	Version 9 to 10	Update	Slots section updated
April 27, 2017	Version 10 to 11	Update	Graphics section updated
May 9, 2017	Version 11 to 12	Update	Network/Communications updated (Intel® 3168 802.11AC 1x1 Wi-Fi +Bluetooth • M.2 Combo Card non-VPro)
May 24, 2017	Version 12 to 13	Update	Integrated Graphics table updated (replaced by PM request)
June 9, 2017	Version 13 to 14	Update	Integrated Graphics table updated (replaced by PM request)
July 10, 2017	Version 14 to 15	Update	Added AiO form factor
July 17, 2017	Version 15 to 16	Update	Desktop Mini Accessories updated: P3R65AA deleted and replaced by 1ZE52AA
July 28, 2017	Version 16 to 17	Update	Webcam & mic resolution spec updated
July 31, 2017	Version 17 to 18	Update	Wireless Card "Realtek RTL8723BE 802.11bgn 1x1 Wi-Fi + BT4.0 Combo Adapter" added to 400 G3 DM.
August 2, 2017	Version 18 to 19	Update	Fix on 400 G4 MT overview on the PCIe express x16 instead of x1 updated
August 9, 2017	Version 19 to 20	Update	Weight & Dimensions section update
August 10, 2017	Version 20 to 21	Update	Slots section on HP Prodesk 400 G4 SFF Business PC Updated
August 11, 2017	Version 21 to 22	Update	Foot note number 5 on 400 QS/TS saying Linux is NOT available for all regions/countries added
August 21, 2017	Version 22 to 23	Update	HP ProDesk 400 G4 and 480 G4* Microtower Business PC Overview note updated
August 31, 2017	Version 23 to 24	Update	"HP Pro 40 g3/g4" and "remote configuration, remote control" removed from Key features of the HP Bios
September 13, 2017	Version 24 to 25	Update	"HP EliteDesk 400 G4 Small Form Factor Business PC" added as a title on top of the Environment & industry table
September 25, 2017	Version 25 to 26	Update	Response time added to standards features and configurable components
September 28, 2017	Version 26 to 27	Update	Power Supply Section Updated
October 5, 2017	Version 27 to 28	Update	80 plus platinum row removed from Power supply table and DisplayPort ™ version updated
October 16, 2017	Version 28 to 29	Update	"Multi-unit packaging" and "Shipping weight" added to Weights and dimensions table
October 18, 2017	Version 29 to 30	Update	Environmental Data tables for 400 G3 Non-touch AiO Business PC and HP ProOne 400 G3 Touch AiO Business PC added / (5 Gbit/s data speed) added to each USB 3.1 Gen1 Port in all call outs
November 7, 2017	Version 30 to 31	Update	Power Supply section updated
November 27, 2017	Version 31 to 32	Update	HP PCIe x1 Parallel Port Card Row added to I/O Ports – Optional chart and Internal SATA storage connector(s) on 400 G3 AiO switched to 2.



# HP ProDesk 400 G3 DM, HP ProDesk 400 G4 MT/SFF and HP ProOne 400 G3 Business Desktops PCs

#### Change Log

November 29, 2017	Version 32 to 33	Update	Typo correction on Intel-Core-i3-7300T-Processor
•		-	<u> </u>
December 7, 2017	Version 33 to 34	Update	New chipset added (only for 480 G4 MT)
December 11, 2017	Version 34 to 35	Update	Audio rear port mentions removed
December 18, 2017	Version 35 to 36	Update	128GB PCIE NVME TLC Solid State Drive added, PCIe NMVe SSD
			Drives updated
January 2, 2018	Version 36 to 37	Update	Serial port updated on 400 G3 AiO
January 3, 2018	Version 37 to 38	Update	Power factor information table replaced
January 4, 2018	Version 38 to 39	Update	Slot PCI Express x16 specified to to be designed on MT
			HP Turbo Drive G2 TLC 512GB PCIe Drive added to Data Storage
			Drives section for MT´s and SFF
January 5, 2018	Version 39 to 40	Update	2 <sup>nd</sup> graphic cards removed from 400 G4 SFF
			HP ProOne 400 G3 All-in-One Business PC Call outs picture updated
January 18, 2018	Version 40 to 41	Update	Environmental data for 400 G3 DM added
January 24, 2018	Version 41 to 42	Update	HP Desktop Mini Lock Box removed from the Accessories section
			and memory speed for GT 730 1GB and 2Gb GDDR5 corrected to
			1.25Ghz.
February 7, 2018	Version 42 to 43	Update	PCI Express x 4 (v3.0) row added to Slots section
February 12, 2018	Version 43 to 44	Update	HP ProOne 400 G3 All-in-One Business PC call out reference added
			to side view image.
			And warranty replaced with a new one on Service and support
			section
April 16, 2018	Version 44 to 45	Update	AMD Radeon™ R7 430 2GB LP 2DP PCIe x16 GF card specs added to
			MT and SFF
April 18, 2018	Version 45 to 46	Update	AMD Radeon™ R7 430 2GB LP 2DP PCIe x16 GF card specs updated
September 24, 2018	Version 46 to 47	Update	Weights and dimensions for 400 G4 SFF corrected

